

7th Workshop on Memory-Centric Computing Processing-Using-Memory in Real DRAM Chips

İsmail Emir Yüksel

ICS 2026

6 July 2026

SAFARI

ETH zürich

Brief Self Introduction

- **Ismail Emir Yuksel**

- Researcher @ SAFARI Research Group since September 2022
 - PhD @ ETH Zurich (Feb 2024 – ongoing)
- ismail.yuksel@safari.ethz.ch

- **Research interests:**

- Computer architecture
- Processing-in-Memory (specifically Processing-using-DRAM)
- DRAM Safety, Security and Reliability
- Hardware security, safety, reliability, performance, availability, fairness, energy efficiency
- ...

Computing is Bottlenecked by Data

Data is Key for AI, ML, Genomics, ...

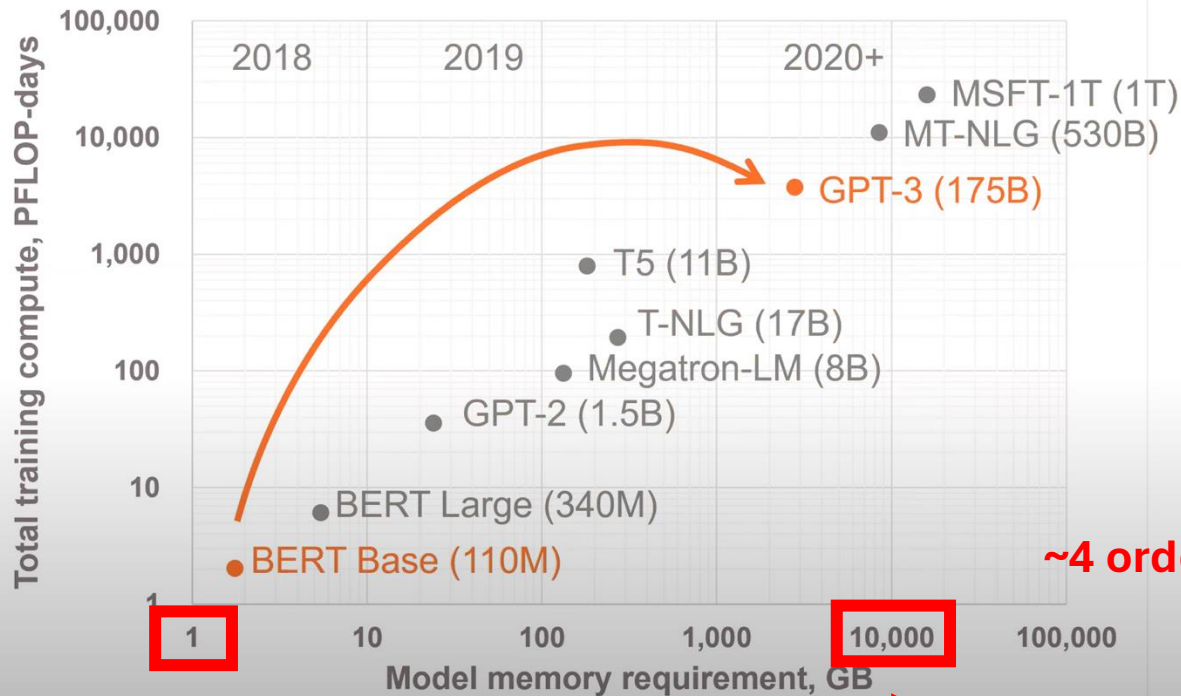
- Important workloads are all data intensive
- They require rapid and efficient processing of large amounts of data
- Data is increasing
 - We can generate more than we can process
 - We need to perform more sophisticated analyses on more data

Huge Demand for Performance & Efficiency

Exponential Growth of Neural Networks



Memory and compute requirements

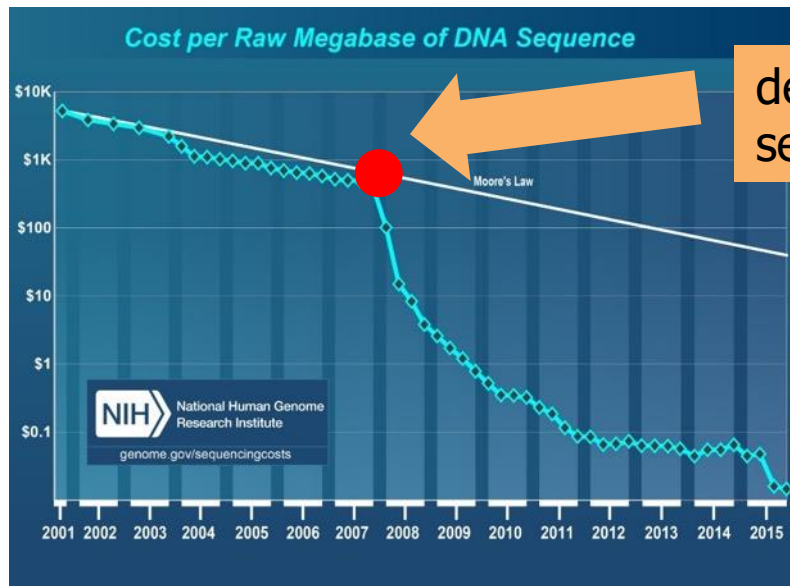


1800x more compute
In just 2 years

Tomorrow, **multi-trillion**
parameter models

**~4 orders of magnitude increase in
memory requirement
in just a few years!**

Huge Demand for Performance & Efficiency

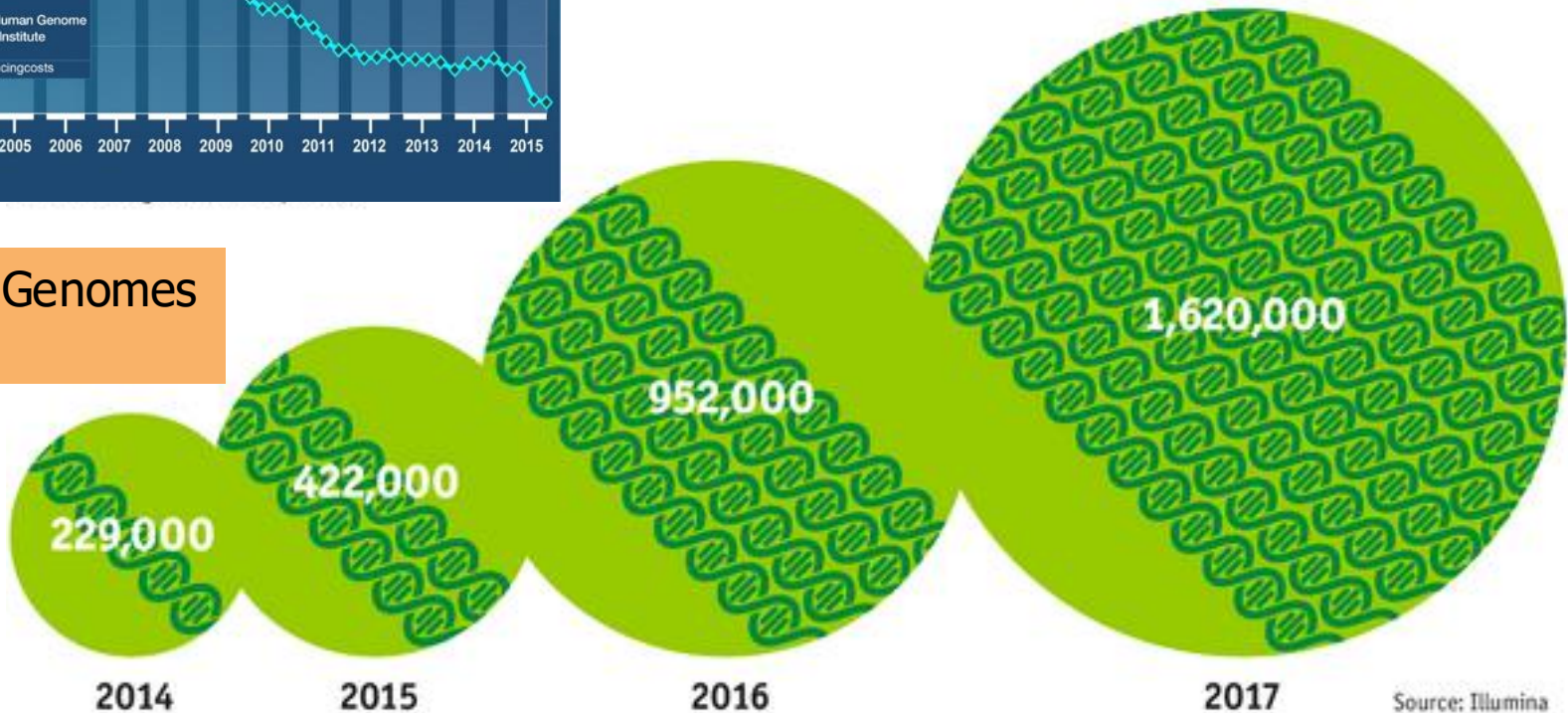


development of new sequencing technologies



Oxford Nanopore MinION

Number of Genomes Sequenced



The Economist

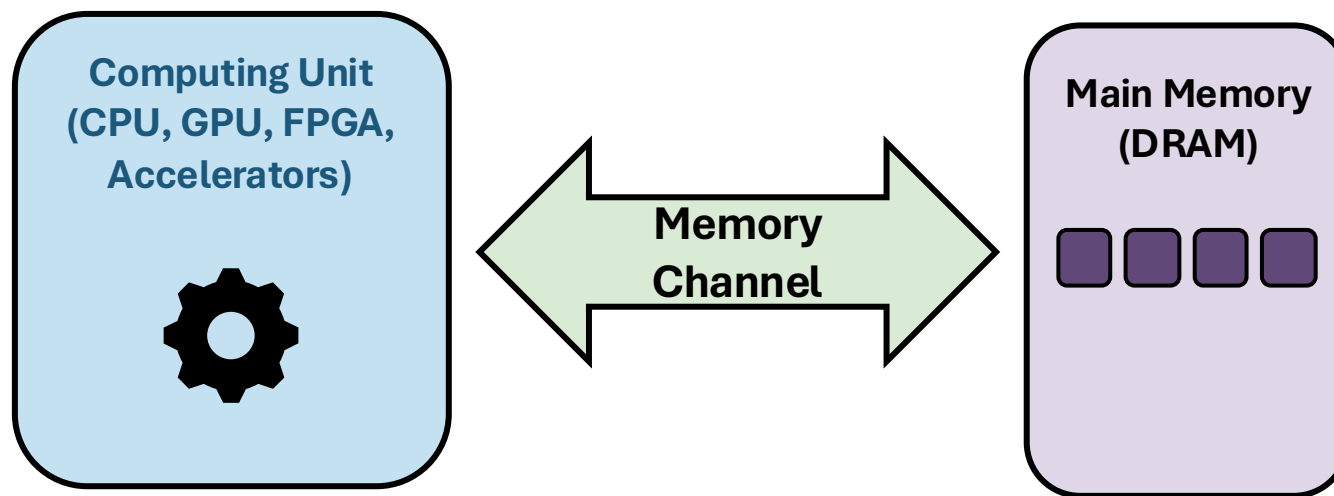
The Problem

Data access is the major performance and energy bottleneck

Our current
design principles
cause great energy waste
(and great performance loss)

Data Movement Bottleneck

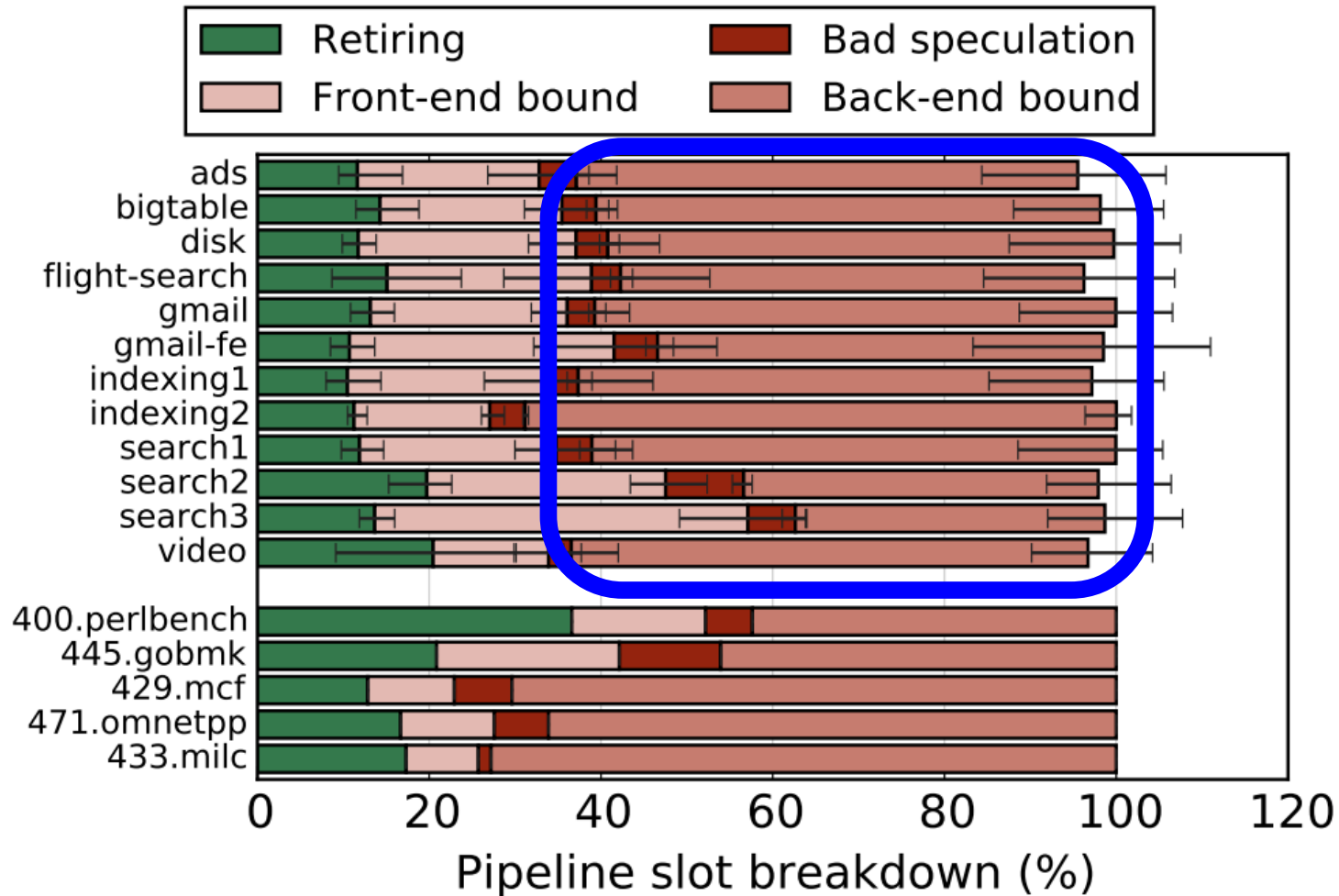
- Today's computing systems are processor centric
- All data is processed in the processor → **at great system cost**



More than 60% of the total system energy is spent on data movement¹

Processor-Centric System Performance

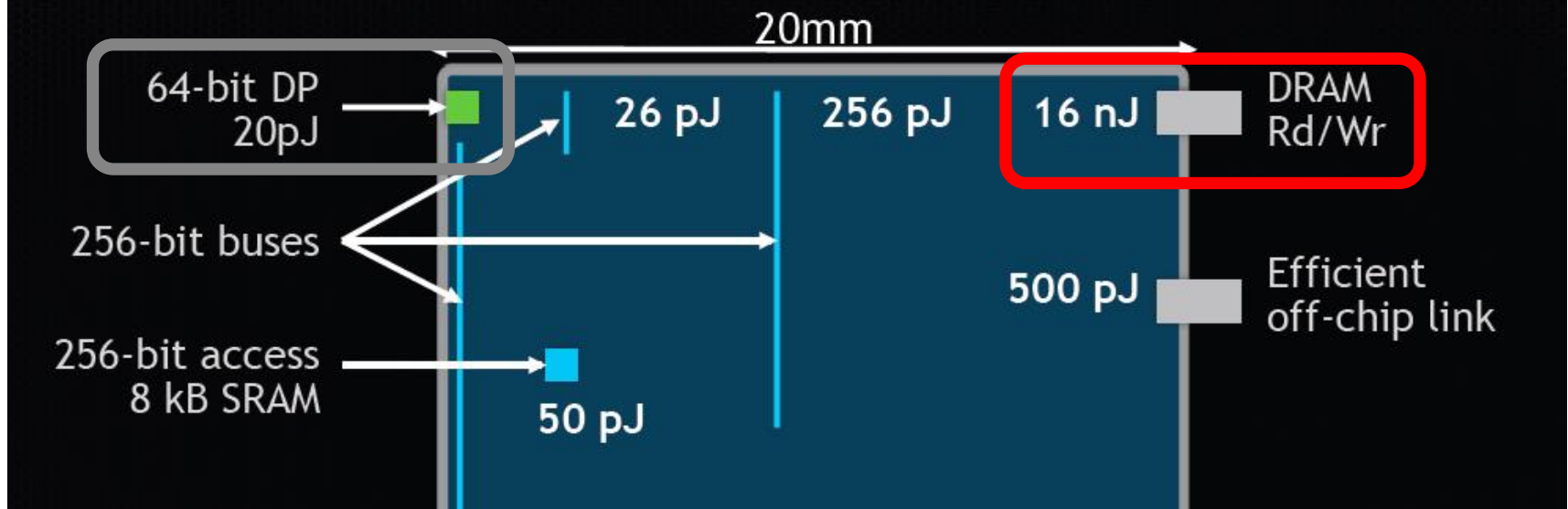
- All of Google's Data Center Workloads (2015):



Data Movement vs. Computation Energy

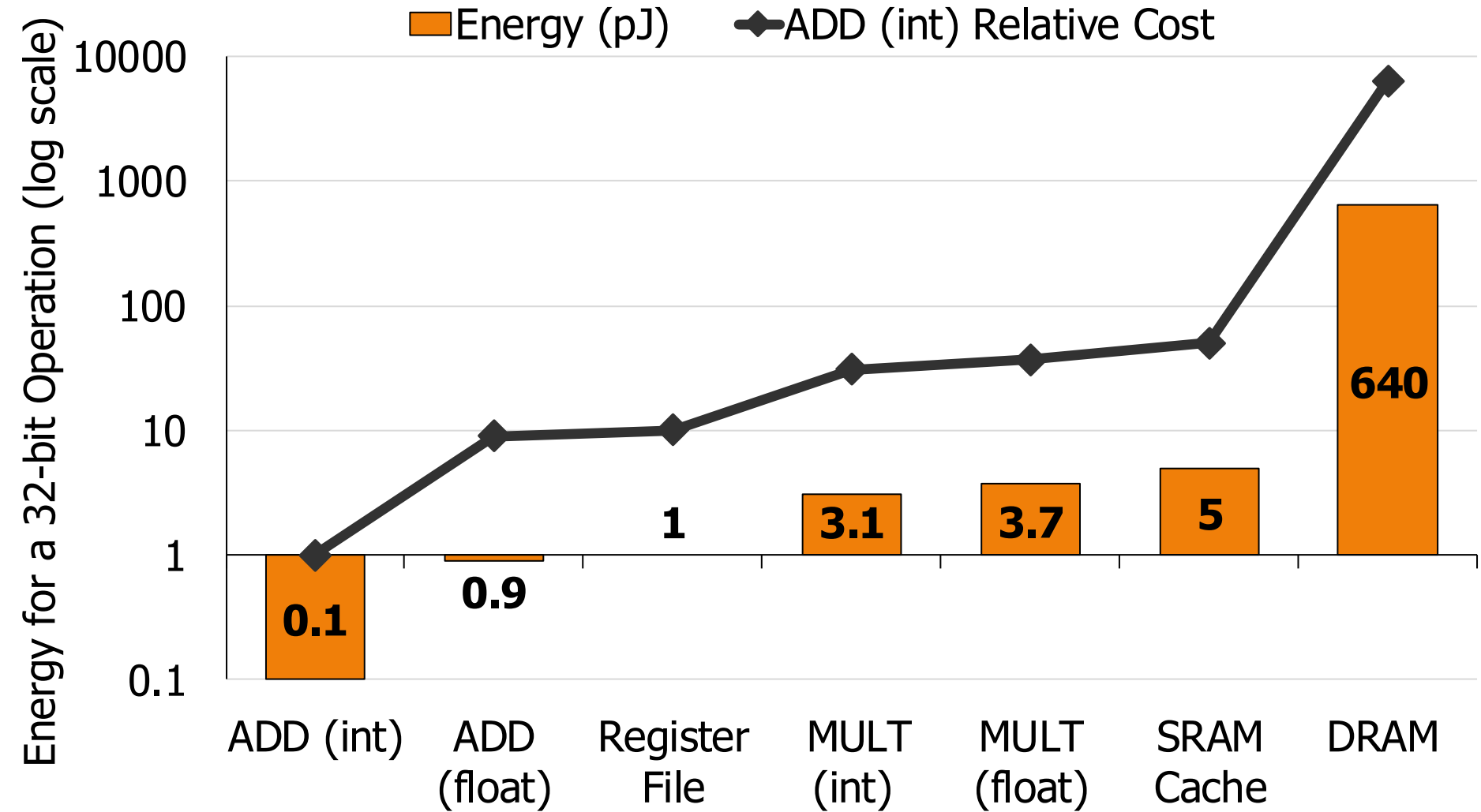
Communication Dominates Arithmetic

Dally, HiPEAC 2015

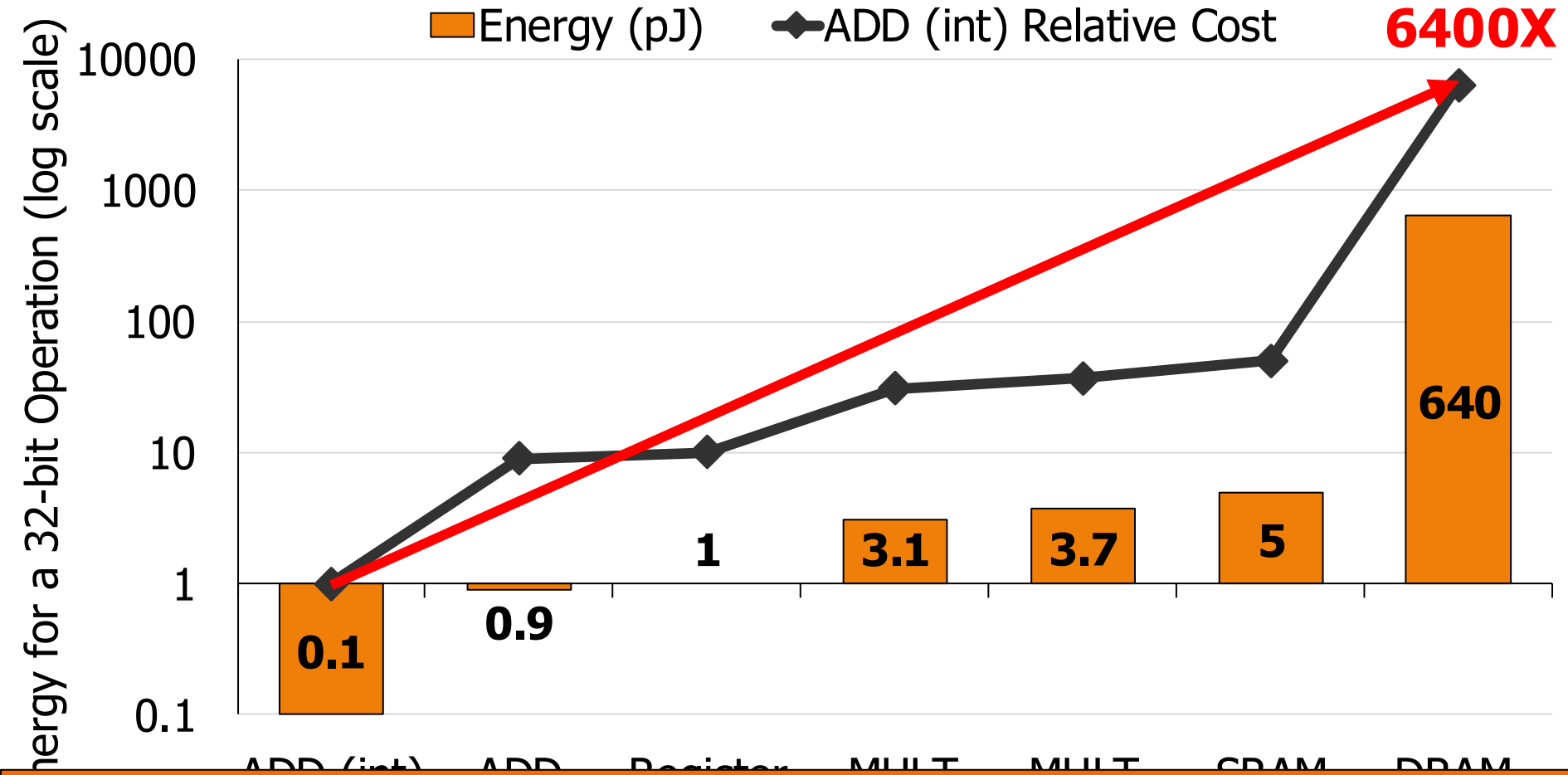


A memory access consumes ~100-1000X the energy of a complex addition

Data Movement vs. Computation Energy



Data Movement vs. Computation Energy



A memory access consumes 6400X
the energy of a simple integer addition

Energy Waste in Accelerators

- Amirali Boroumand, Saugata Ghose, Youngsok Kim, Rachata Ausavarungnirun, Eric Shiu, Rahul Thakur, Daehyun Kim, Aki Kuusela, Allan Knies, Parthasarathy Ranganathan, and Onur Mutlu,

["Google Workloads for Consumer Devices: Mitigating Data Movement Bottlenecks"](#)

Proceedings of the 23rd International Conference on Architectural Support for Programming Languages and Operating Systems (ASPLOS), Williamsburg, VA, USA, March 2018.

62.7% of the total system energy
is spent on **data movement**

Google Workloads for Consumer Devices: Mitigating Data Movement Bottlenecks

Amirali Boroumand¹

Saugata Ghose¹

Youngsok Kim²

Rachata Ausavarungnirun¹

Eric Shiu³

Rahul Thakur³

Daehyun Kim^{4,3}

Aki Kuusela³

Allan Knies³

Parthasarathy Ranganathan³

Onur Mutlu^{5,1}

Energy Waste in Accelerators

- Amirali Boroumand, Saugata Ghose, Berkin Akin, Ravi Narayanaswami, Geraldo F. Oliveira, Xiaoyu Ma, Eric Shiu, and Onur Mutlu,
["Google Neural Network Models for Edge Devices: Analyzing and Mitigating Machine Learning Inference Bottlenecks"](#)
Proceedings of the 30th International Conference on Parallel Architectures and Compilation Techniques (PACT), Virtual, September 2021.
[[Slides \(pptx\)](#) ([pdf](#))]
[[Talk Video](#) (14 minutes)]

**> 90% of the total system energy
is spent on **memory** in large ML models**

Google Neural Network Models for Edge Devices: Analyzing and Mitigating Machine Learning Inference Bottlenecks

Amirali Boroumand^{†◇}
Geraldo F. Oliveira^{*}

Saugata Ghose[‡]
Xiaoyu Ma[§]

Berkin Akin[§]
Eric Shiu[§]

Ravi Narayanaswami[§]
Onur Mutlu^{*†}

[†]*Carnegie Mellon Univ.*

[◇]*Stanford Univ.*

[‡]*Univ. of Illinois Urbana-Champaign*

[§]*Google*

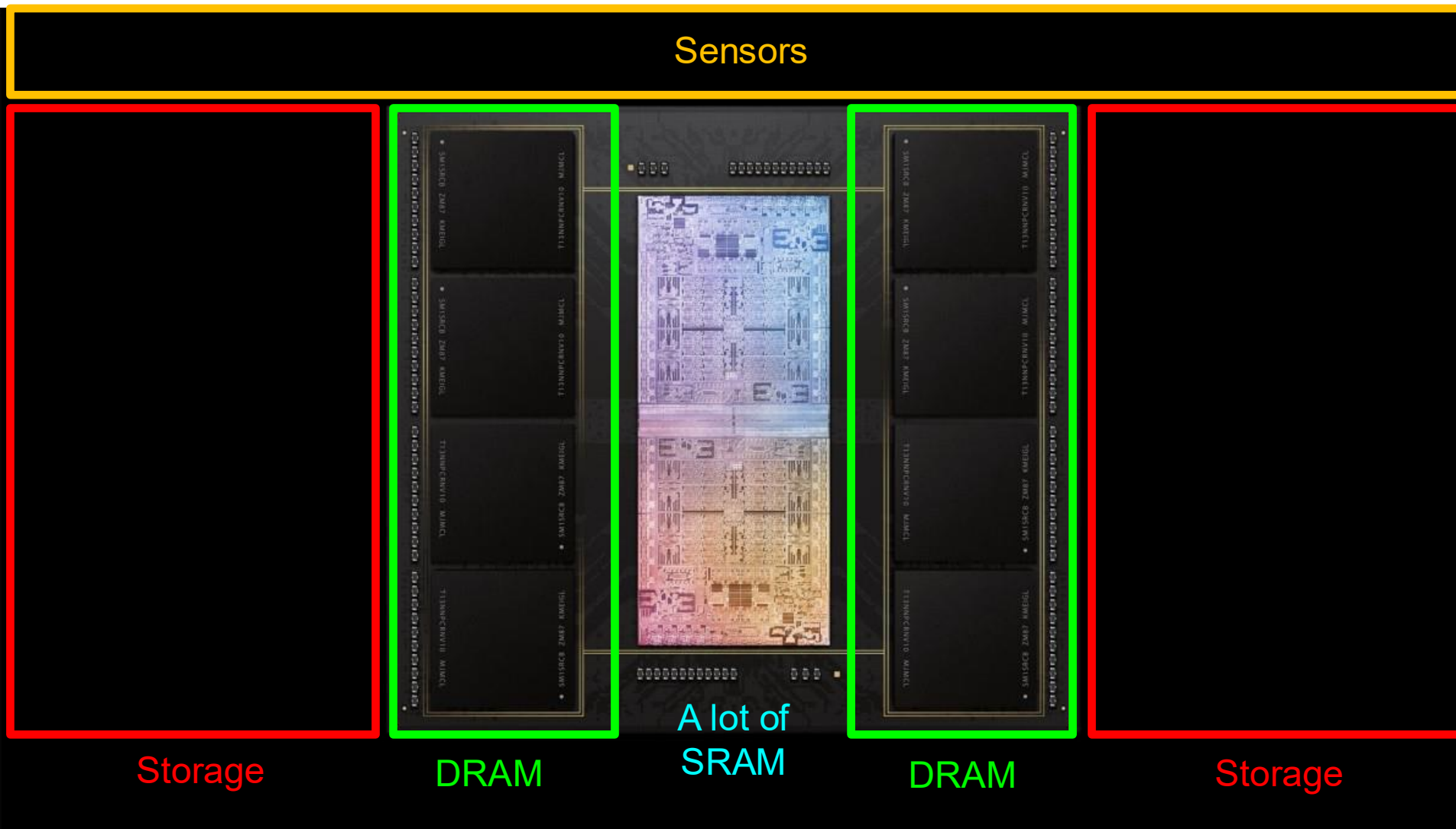
^{*}*ETH Zürich*

Processing of data
is performed
far away from the data

We Need A Paradigm Shift To ...

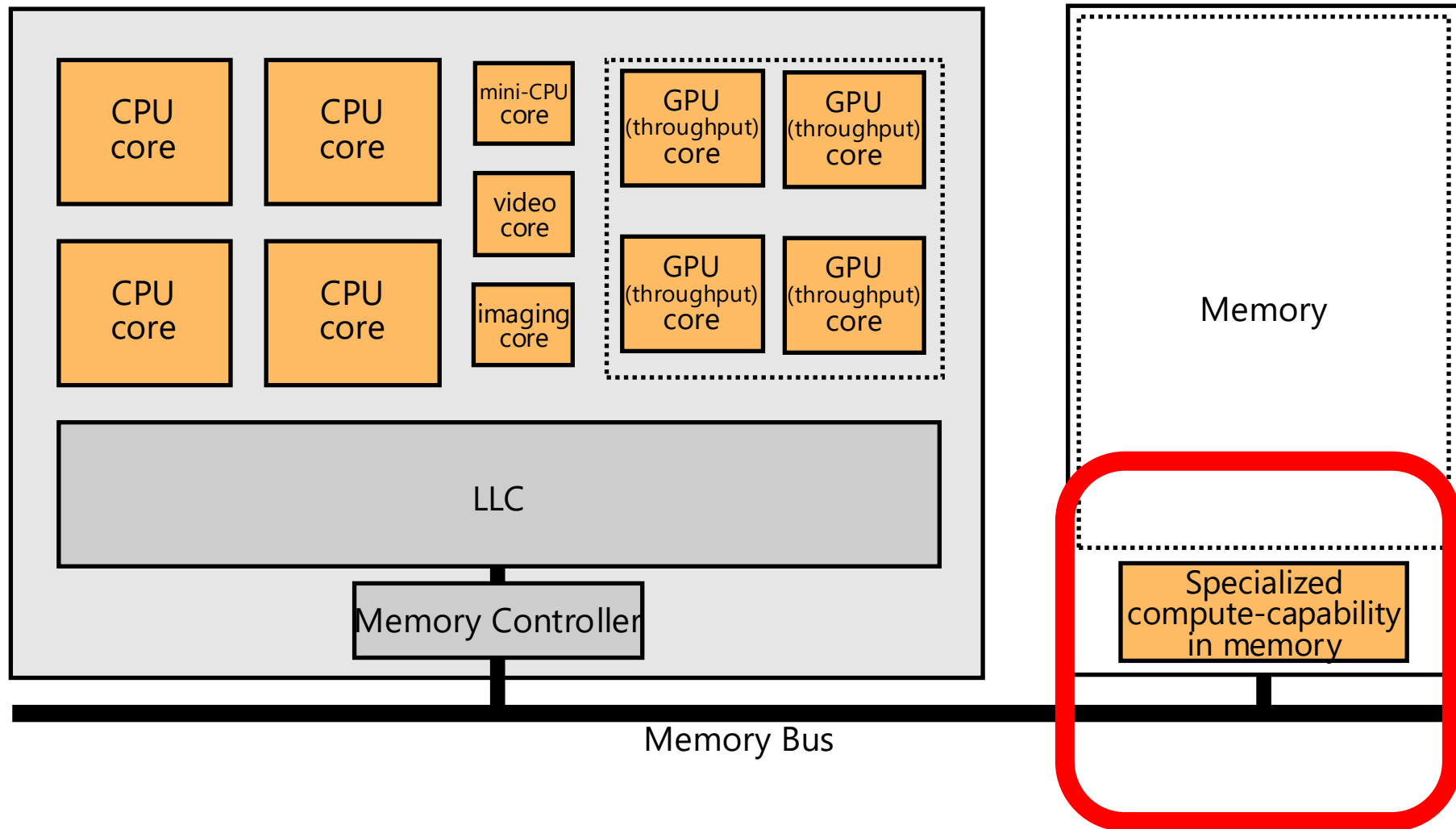
- Enable computation with minimal data movement
- Compute where it makes sense (where data resides)
- Make computing architectures more data-centric

Process Data Where It Makes Sense



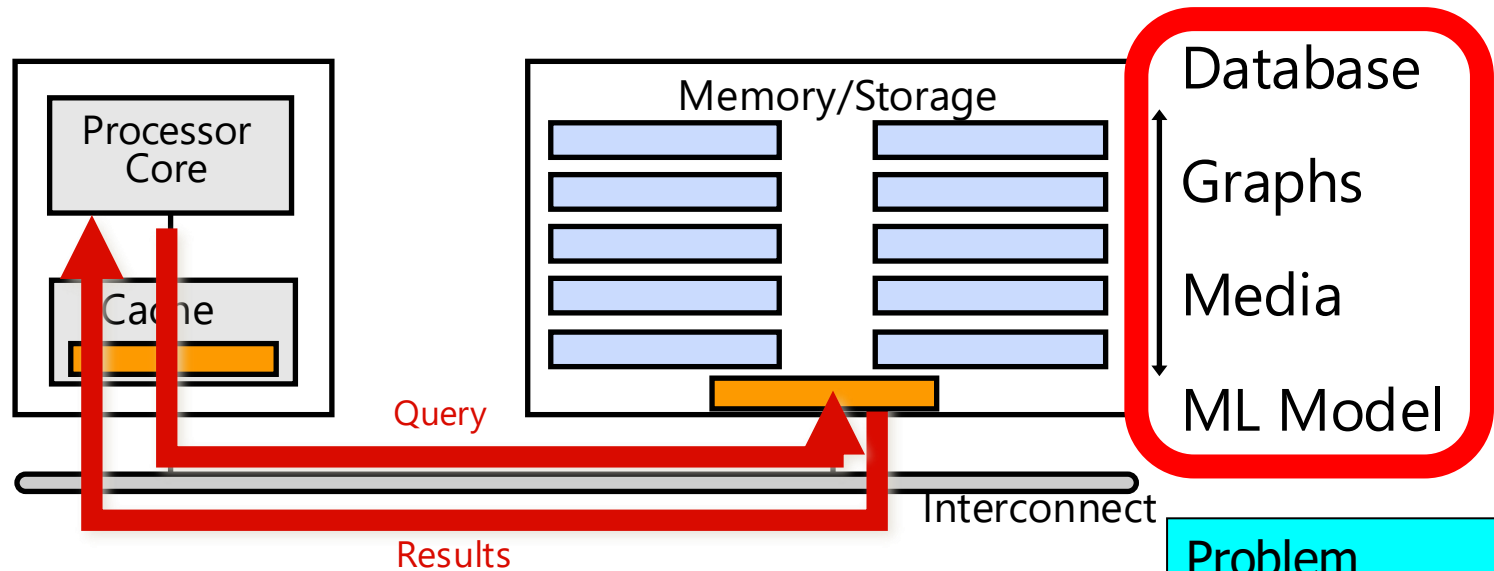
Apple M1 Ultra System (2022)

Memory as an Accelerator

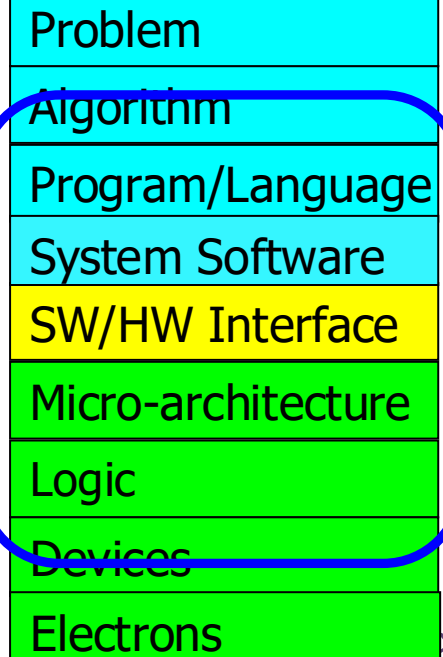


Memory similar to a “conventional” accelerator

Goal: Processing Inside Memory/Storage



- Many questions ... How do we design the:
 - compute-capable memory & controllers?
 - processors & communication units?
 - software & hardware interfaces?
 - system software, compilers, languages?
 - algorithms & theoretical foundations?



Processing in/near Memory: An Old Idea

- Kautz, “Cellular Logic-in-Memory Arrays”, IEEE TC 1969.

IEEE TRANSACTIONS ON COMPUTERS, VOL. C-18, NO. 8, AUGUST 1969

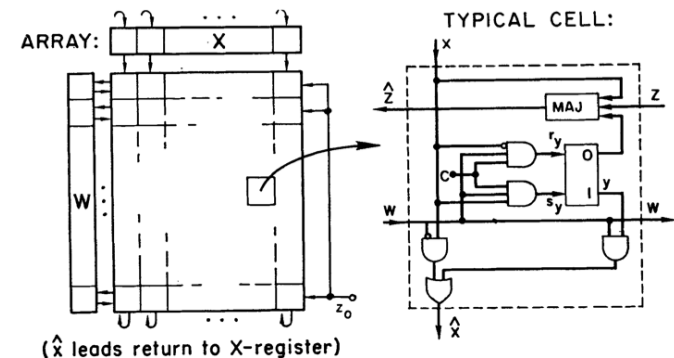
Cellular Logic-in-Memory Arrays

WILLIAM H. KAUTZ, MEMBER, IEEE

Abstract—As a direct consequence of large-scale integration, many advantages in the design, fabrication, testing, and use of digital circuitry can be achieved if the circuits can be arranged in a two-dimensional iterative, or cellular, array of identical elementary networks, or cells. When a small amount of storage is included in each cell, the same array may be regarded either as a logically enhanced memory array, or as a logic array whose elementary gates and connections can be “programmed” to realize a desired logical behavior.

In this paper the specific engineering features of such cellular logic-in-memory (CLIM) arrays are discussed, and one such special-purpose array, a cellular sorting array, is described in detail to illustrate how these features may be achieved in a particular design. It is shown how the cellular sorting array can be employed as a single-address, multiword memory that keeps in order all words stored within it. It can also be used as a content-addressed memory, a pushdown memory, a buffer memory, and (with a lower logical efficiency) a programmable array for the realization of arbitrary switching functions. A second version of a sorting array, operating on a different sorting principle, is also described.

Index Terms—Cellular logic, large-scale integration, logic arrays logic in memory, push-down memory, sorting, switching functions.



$$\begin{aligned}\hat{x} &= \bar{w}x + wy \\ s_y &= wcx, r_y = wc\bar{x} \\ \hat{z} &= M(x, \bar{y}, z) = x\bar{y} + z(x + \bar{y})\end{aligned}$$

Fig. 1. Cellular sorting array I.

Processing in/near Memory: An Old Idea

- Stone, “A Logic-in-Memory Computer,” IEEE TC 1970.

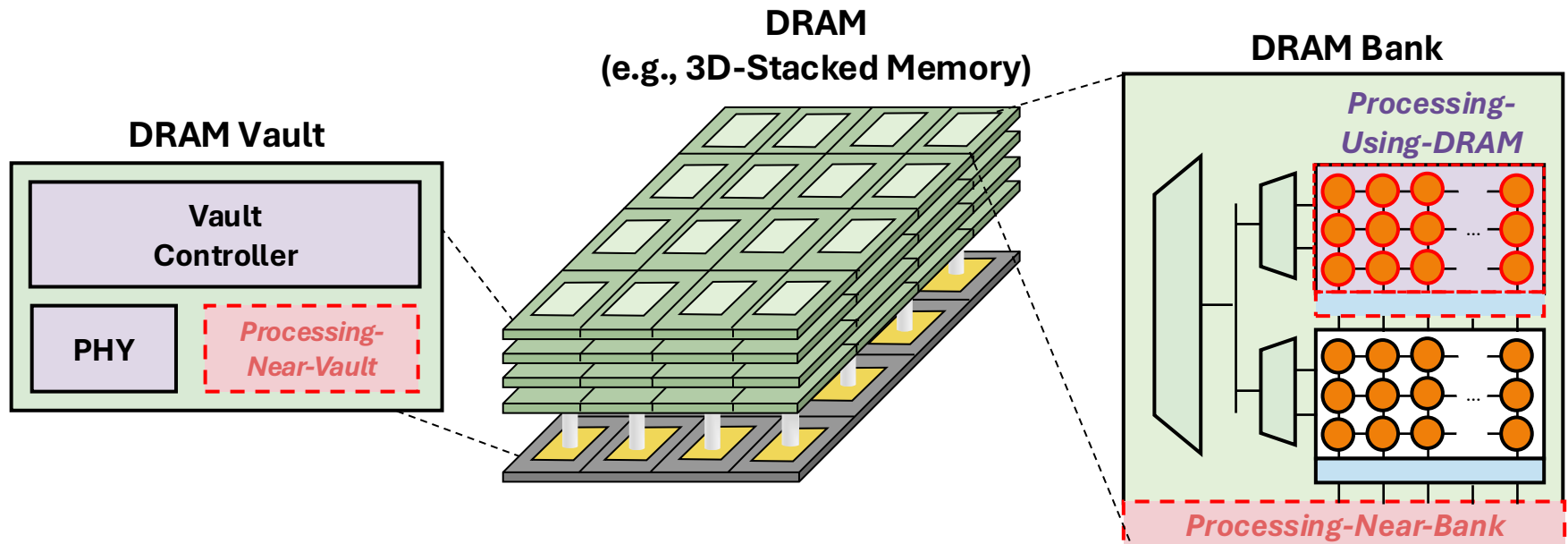
A Logic-in-Memory Computer

HAROLD S. STONE

Abstract—If, as presently projected, the cost of microelectronic arrays in the future will tend to reflect the number of pins on the array rather than the number of gates, the logic-in-memory array is an extremely attractive computer component. Such an array is essentially a microelectronic memory with some combinational logic associated with each storage element.

Processing-in-Memory: Two Types

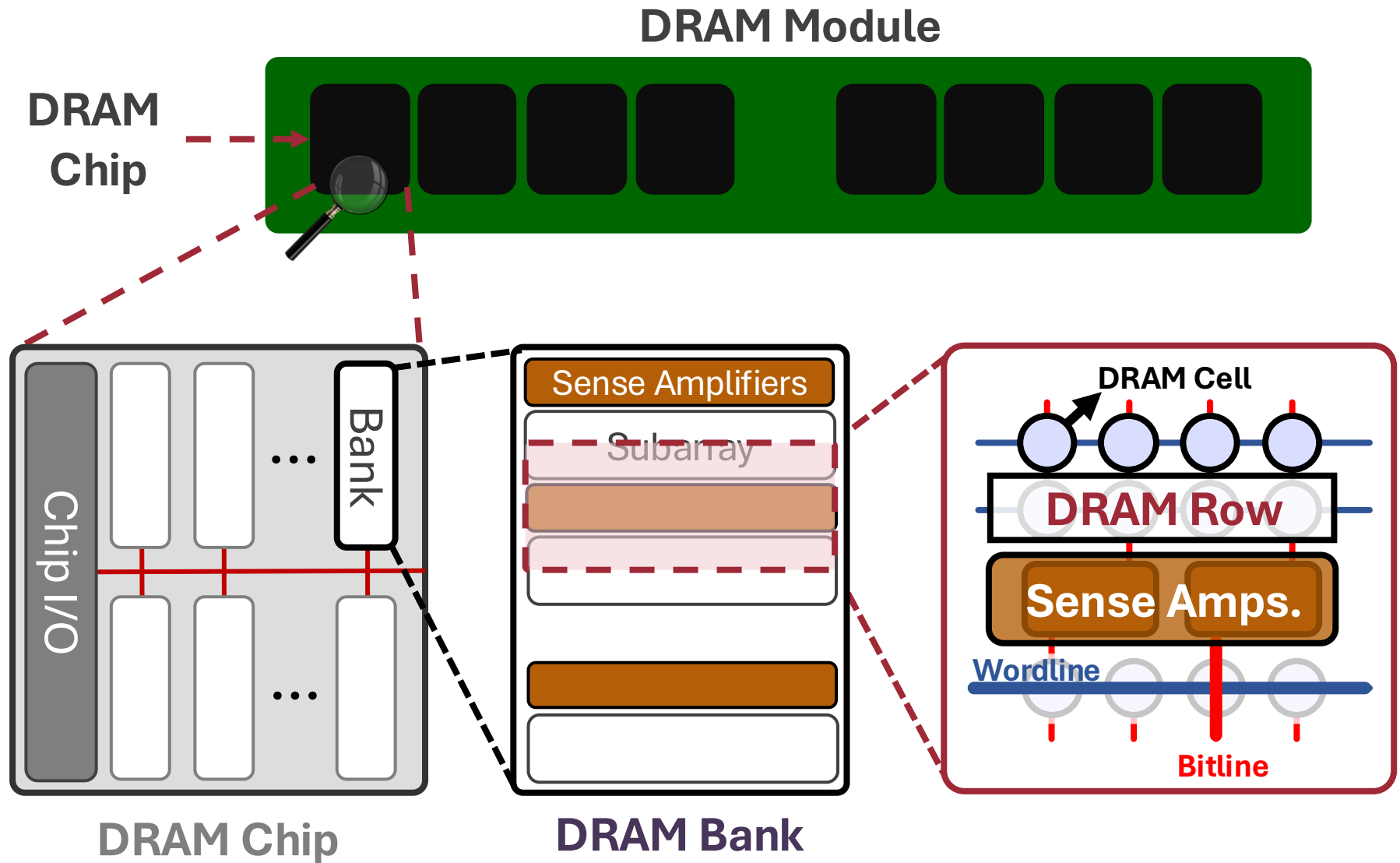
- 1 Processing-Near-Memory:** Computation logic is added to the same die as memory or to the logic layer of 3D-stacked memory
- 2 Processing-Using-Memory:** uses the operational principles of memory cells & circuitry to perform computation



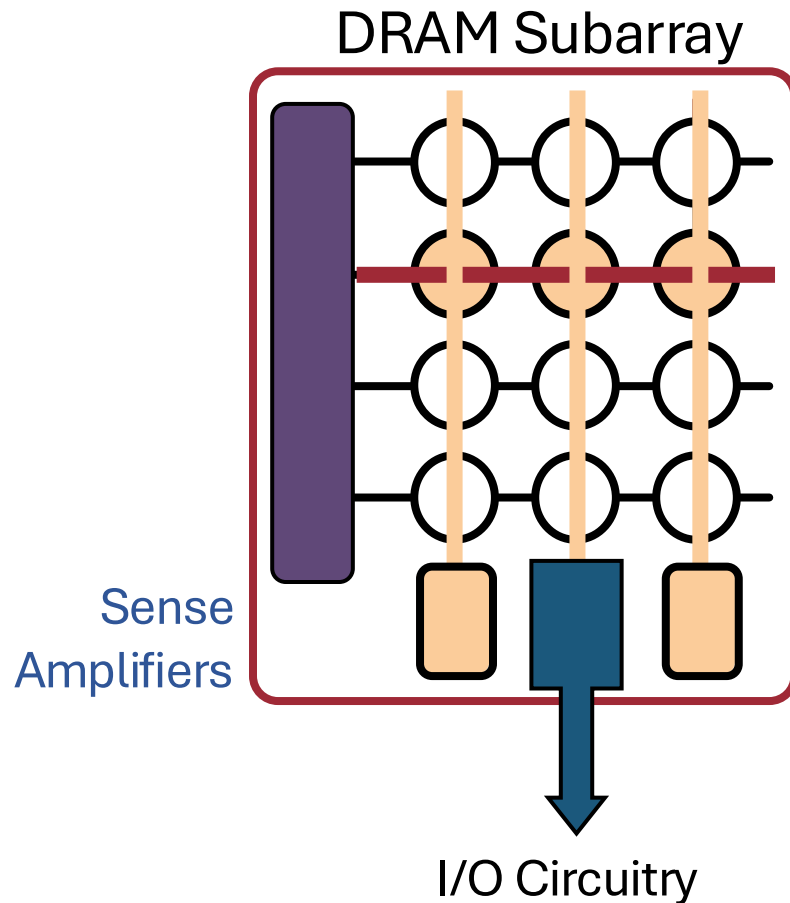
Focus: Processing-using-DRAM

- We can natively support
 - Bulk bitwise COPY and INIT/ZERO
 - Bulk bitwise AND, OR, NOT, MAJ, NOR, NAND
 - True Random Number Generation; Physical Unclonable Functions
 - More complex computation using Lookup Tables
- At low cost
- Using analog computation capability of DRAM
 - Idea: activating (multiple) rows performs computation
 - Even in commodity off-the-shelf DRAM chips!
- 30X-257X performance and energy improvements
 - Seshadri+, “RowClone: Fast and Efficient In-DRAM Copy and Initialization of Bulk Data,” MICRO 2013.
 - Seshadri+, “Fast Bulk Bitwise AND and OR in DRAM,” IEEE CAL 2015.
 - Seshadri+, “Ambit: In-Memory Accelerator for Bulk Bitwise Operations Using Commodity DRAM Technology,” MICRO 2017.
 - Hajinazar+, “SIMDRAM: A Framework for Bit-Serial SIMD Processing using DRAM,” ASPLOS 2021.
 - Oliveira+, “MIMDRAM: An End-to-End Processing-Using-DRAM System for High-Throughput, Energy-Efficient and Programmer-Transparent Multiple-Instruction Multiple-Data Processing,” HPCA 2024.

DRAM Organization

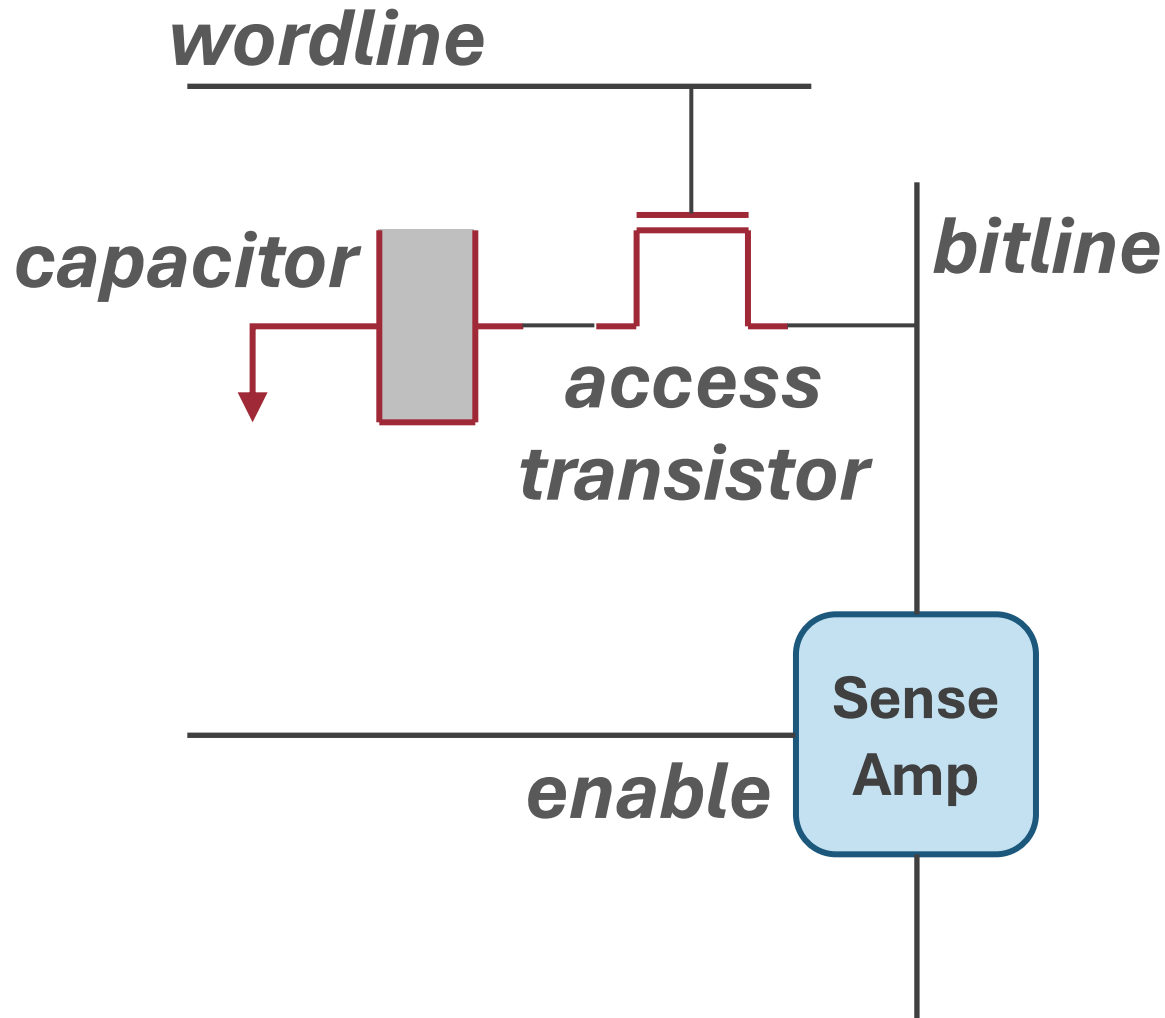


Major DRAM Operations

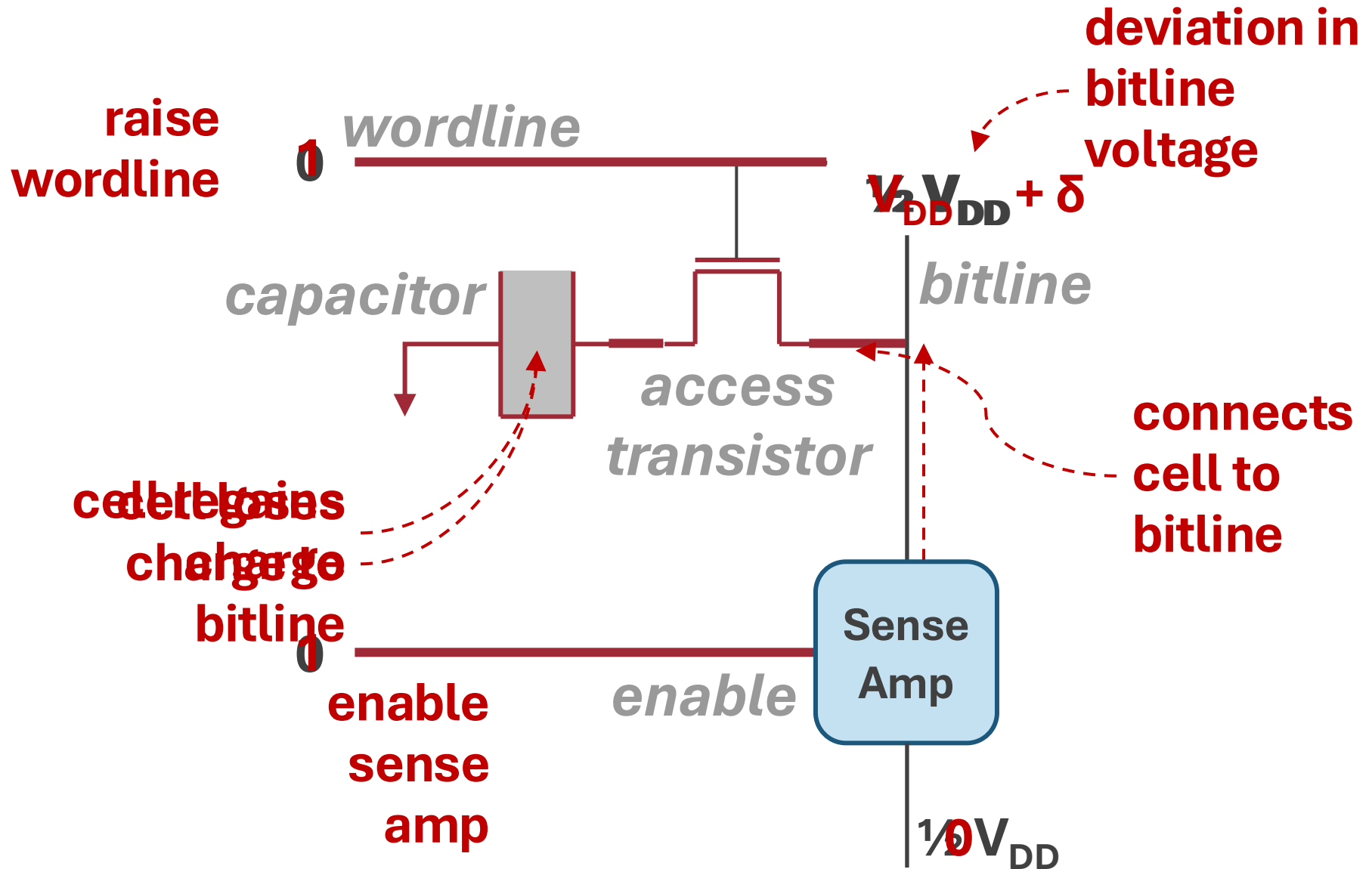


- 1 ACTIVATE (ACT):**
Fetch the row's content into the **sense amplifiers**
- 2 Column Access (RD/WR):**
Read/Write the target column and drive to I/O
- 3 PRECHARGE (PRE):**
Prepare the bank for a new ACTIVATE

Closer Look to a DRAM Cell

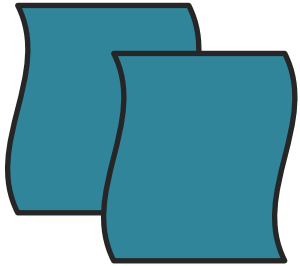


DRAM Cell Operation upon ACT

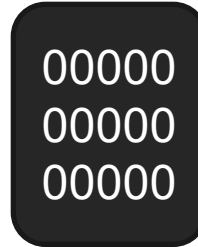


Starting Simple: Data Copy and Initialization

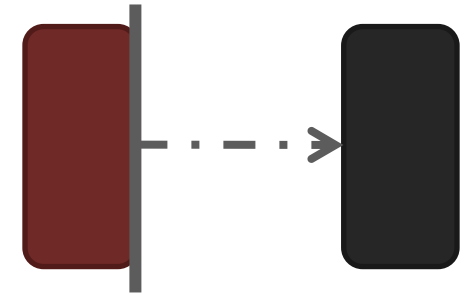
memmove & memcpy: 5% cycles in Google's datacenter [Kanev+ ISCA'15]



Forking



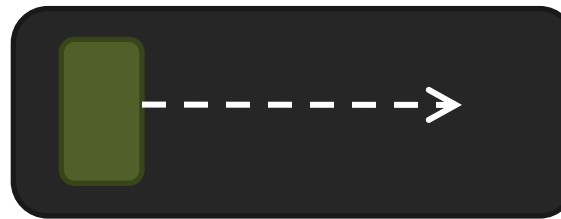
**Zero initialization
(e.g., security)**



Checkpointing



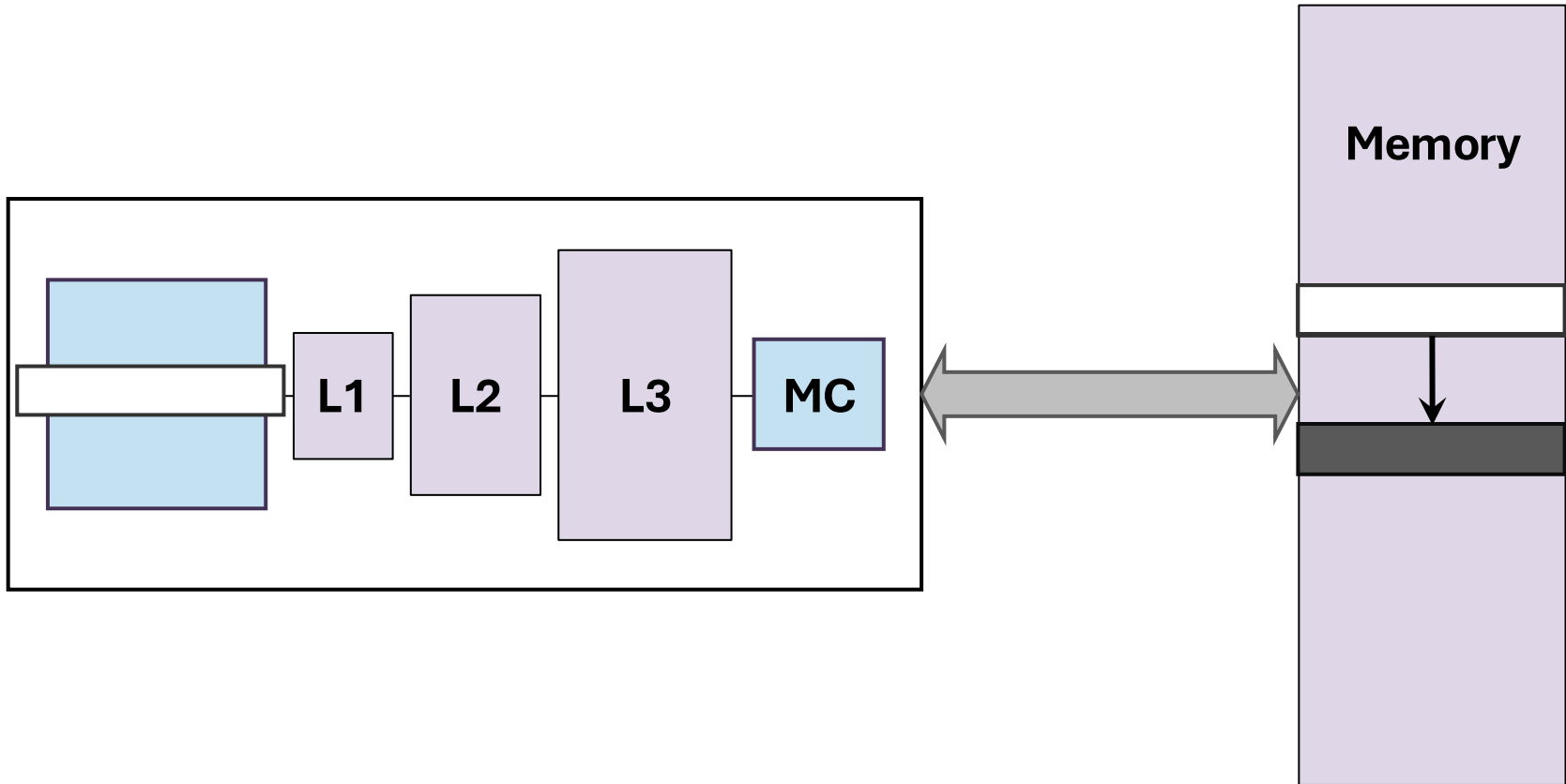
**VM Cloning
Deduplication**



Page Migration

...
Many more

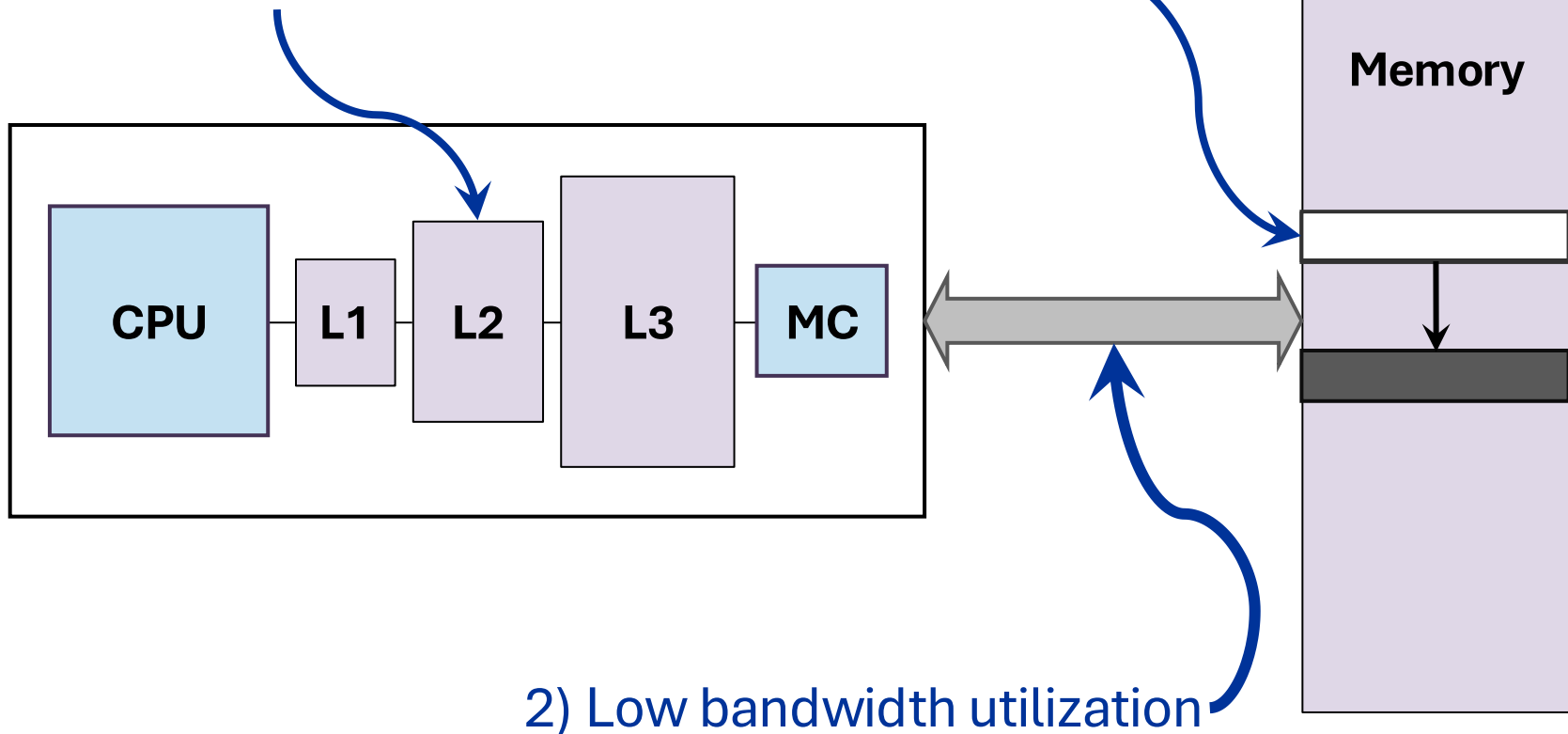
Current Systems: Data Copy



Future Systems: In-Memory Copy

3) No cache pollution

1) Low latency

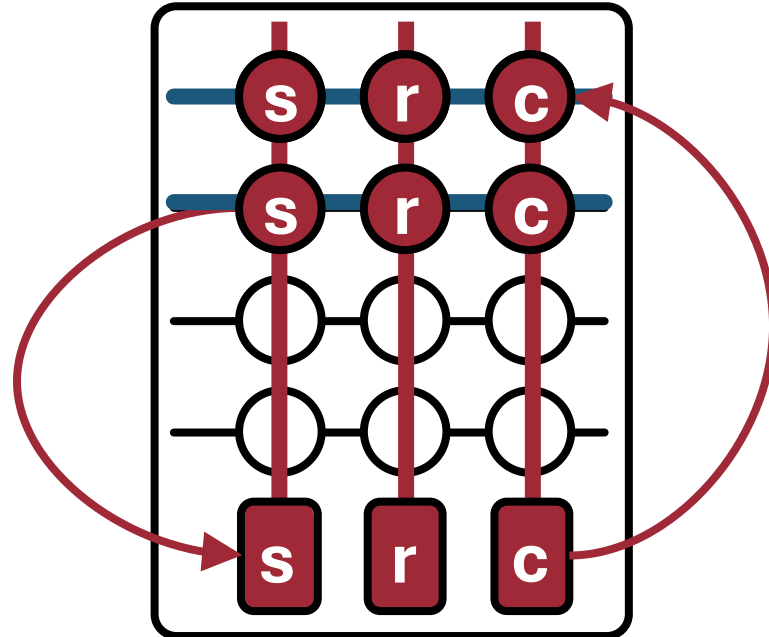


4) No unwanted data movement

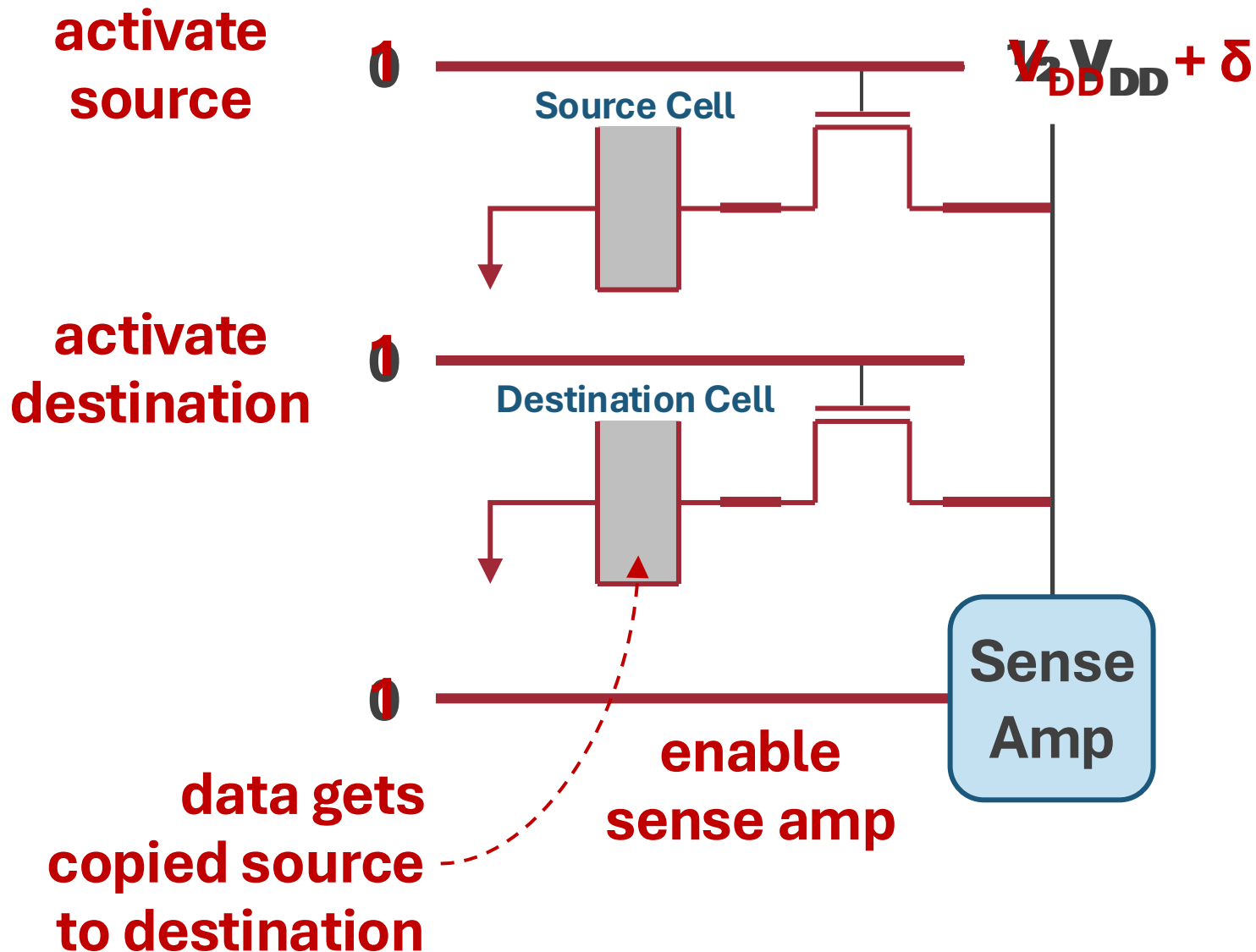
1046ns, 3.6uJ → 90ns, 0.04uJ

In-DRAM Row-Copy (RowClone)

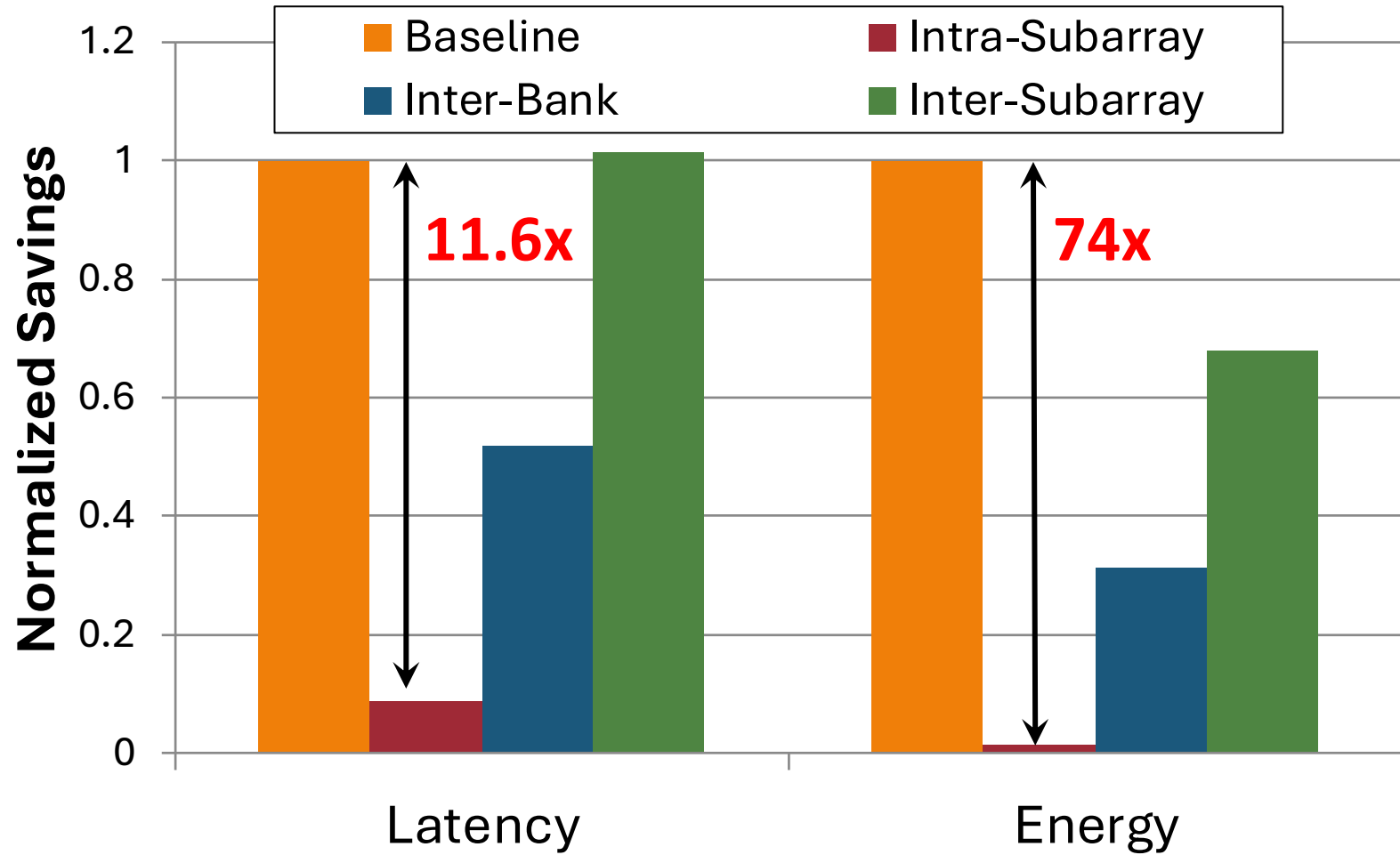
Copying the source (src) row's content to the destination (dst) row



RowClone: In-DRAM Bulk Data Copy



RowClone: Latency and Energy Savings



Seshadri et al., “RowClone: Fast and Efficient

In-DRAM Copy and Initialization of Bulk Data,” MICRO 2013

More on RowClone

- Vivek Seshadri, Yoongu Kim, Chris Fallin, Donghyuk Lee, Rachata Ausavarungnirun, Gennady Pekhimenko, Yixin Luo, Onur Mutlu, Michael A. Kozuch, Phillip B. Gibbons, and Todd C. Mowry,
["RowClone: Fast and Energy-Efficient In-DRAM Bulk Data Copy and Initialization"](#)
Proceedings of the [46th International Symposium on Microarchitecture \(MICRO\)](#), Davis, CA, December 2013.
[\[Slides \(pptx\) \(pdf\)\]](#) [\[Lightning Session Slides \(pptx\) \(pdf\)\]](#) [\[Poster \(pptx\) \(pdf\)\]](#)

RowClone: Fast and Energy-Efficient In-DRAM Bulk Data Copy and Initialization

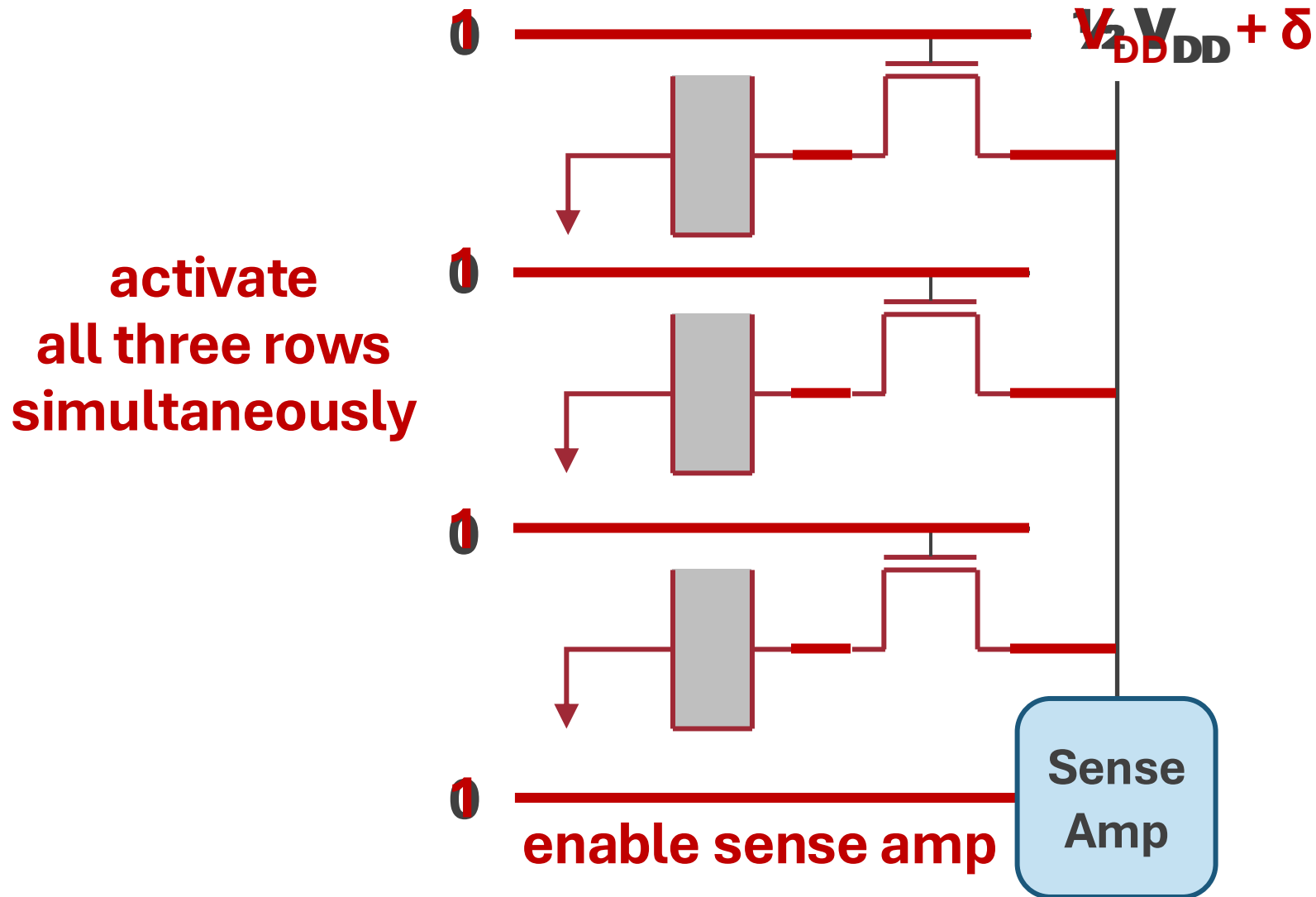
Vivek Seshadri	Yoongu Kim	Chris Fallin*	Donghyuk Lee
vseshadr@cs.cmu.edu	yoongukim@cmu.edu	cfallin@c1f.net	donghyuk1@cmu.edu

Rachata Ausavarungnirun	Gennady Pekhimenko	Yixin Luo
rachata@cmu.edu	gpekhime@cs.cmu.edu	yixinluo@andrew.cmu.edu

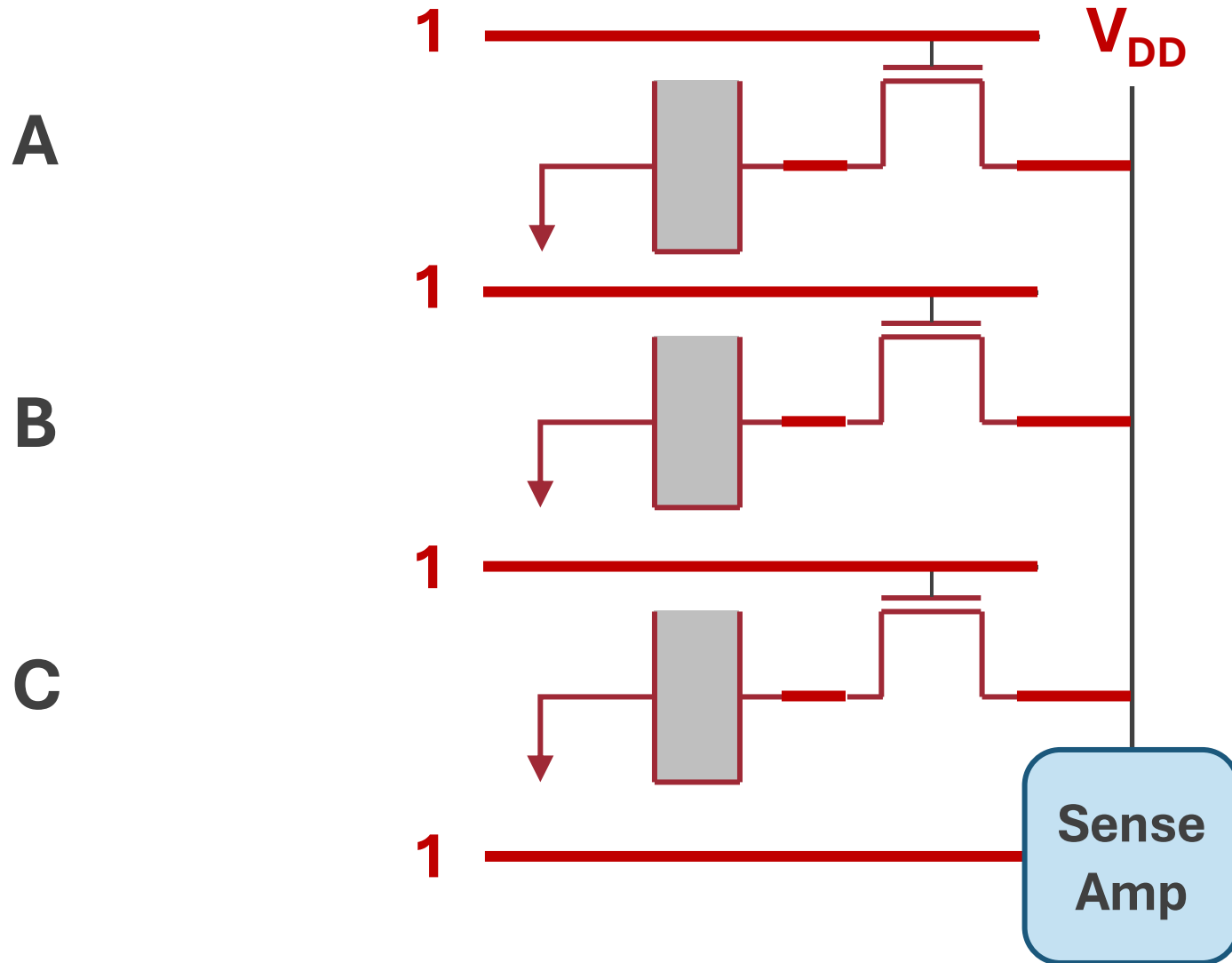
Onur Mutlu	Phillip B. Gibbons [†]	Michael A. Kozuch [†]	Todd C. Mowry
onur@cmu.edu	phillip.b.gibbons@intel.com	michael.a.kozuch@intel.com	tcm@cs.cmu.edu

Carnegie Mellon University [†]Intel Pittsburgh

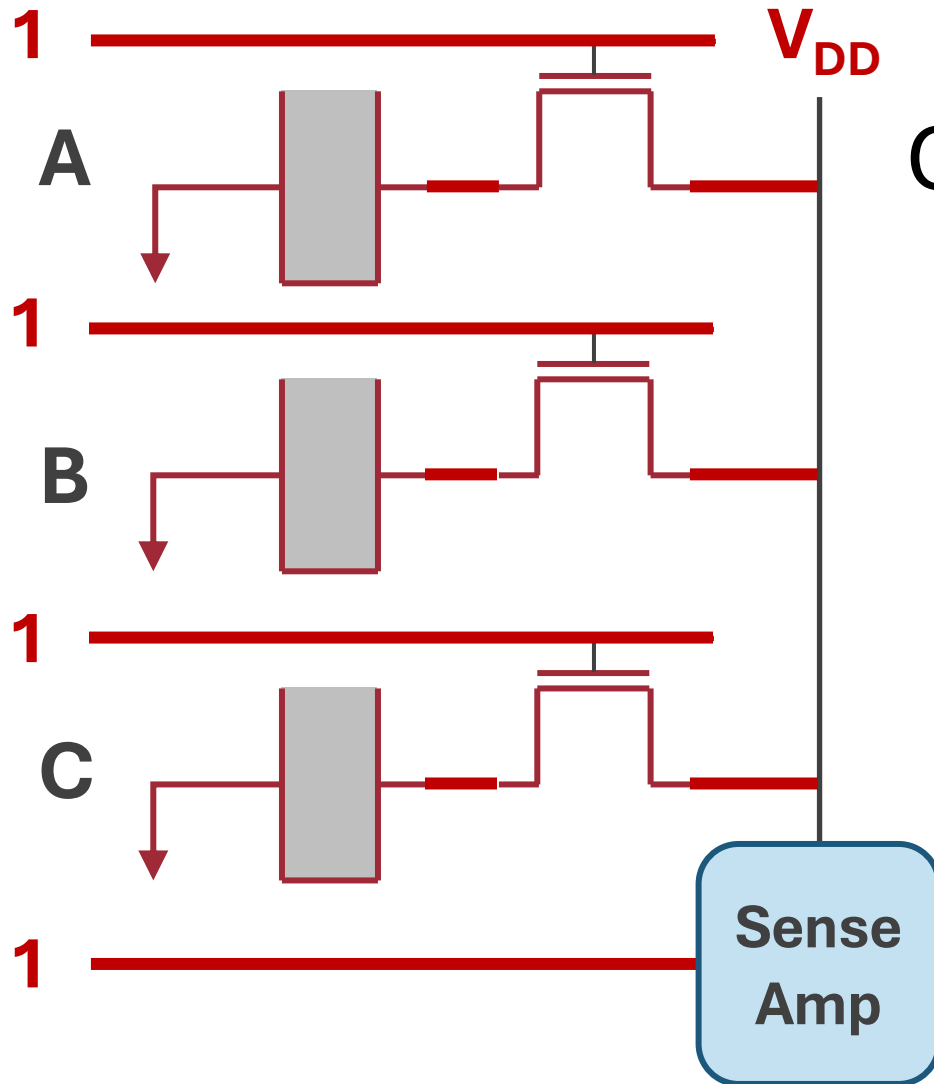
Triple-Row Activation: Majority Function



Bitwise AND/OR Using Triple-Row Activation



Bitwise AND/OR Using Triple-Row Activation



$$\begin{aligned}\text{Output} &= \text{MAJ}(A, B, C) \\ &= C (A \text{ OR } B) + \\ &\quad \sim C (A \text{ AND } B)\end{aligned}$$

Control the value of C
to perform
bitwise OR or AND

In-DRAM Acceleration of Database Queries

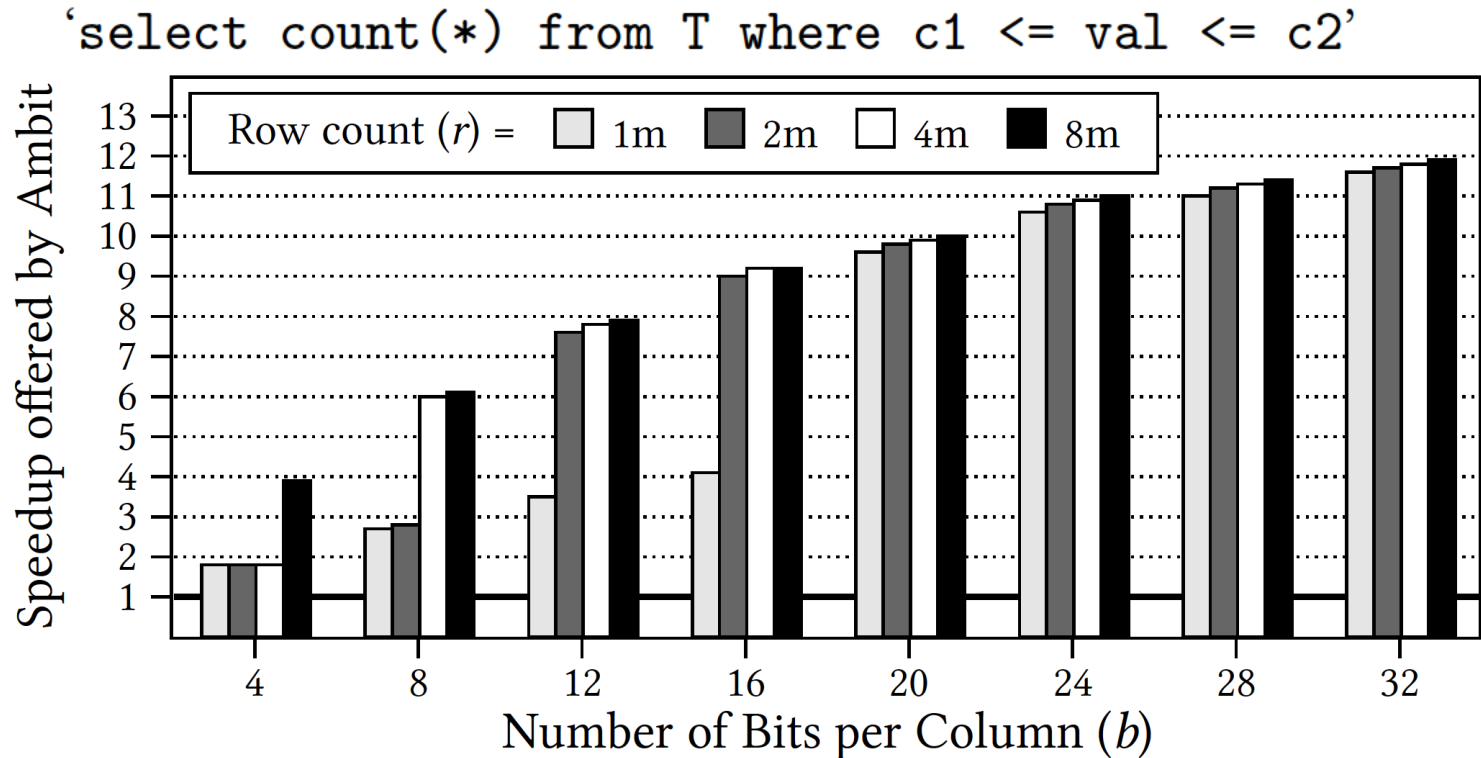


Figure 11: Speedup offered by Ambit over baseline CPU with SIMD for BitWeaving

>4-12X Performance Improvement

More on Ambit

- Vivek Seshadri, Donghyuk Lee, Thomas Mullins, Hasan Hassan, Amirali Boroumand, Jeremie Kim, Michael A. Kozuch, Onur Mutlu, Phillip B. Gibbons, and Todd C. Mowry, ["Ambit: In-Memory Accelerator for Bulk Bitwise Operations Using Commodity DRAM Technology"](#)
Proceedings of the 50th International Symposium on Microarchitecture (MICRO), Boston, MA, USA, October 2017.
[\[Slides \(pptx\) \(pdf\)\]](#) [\[Lightning Session Slides \(pptx\) \(pdf\)\]](#) [\[Poster \(pptx\) \(pdf\)\]](#)

Ambit: In-Memory Accelerator for Bulk Bitwise Operations Using Commodity DRAM Technology

Vivek Seshadri^{1,5} Donghyuk Lee^{2,5} Thomas Mullins^{3,5} Hasan Hassan⁴ Amirali Boroumand⁵
Jeremie Kim^{4,5} Michael A. Kozuch³ Onur Mutlu^{4,5} Phillip B. Gibbons⁵ Todd C. Mowry⁵

¹Microsoft Research India ²NVIDIA Research ³Intel ⁴ETH Zürich ⁵Carnegie Mellon University

SIMDRAM Framework

- Nastaran Hajinazar, Geraldo F. Oliveira, Sven Gregorio, Joao Dinis Ferreira, Nika Mansouri Ghiasi, Minesh Patel, Mohammed Alser, Saugata Ghose, Juan Gomez-Luna, and Onur Mutlu,
["SIMDRAM: An End-to-End Framework for Bit-Serial SIMD Computing in DRAM"](#)
Proceedings of the 26th International Conference on Architectural Support for Programming Languages and Operating Systems (ASPLOS), Virtual, March-April 2021.
[[2-page Extended Abstract](#)]
[[Short Talk Slides \(pptx\) \(pdf\)](#)]
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[[Short Talk Video](#) (5 mins)]
[[Full Talk Video](#) (27 mins)]

SIMDRAM: A Framework for Bit-Serial SIMD Processing using DRAM

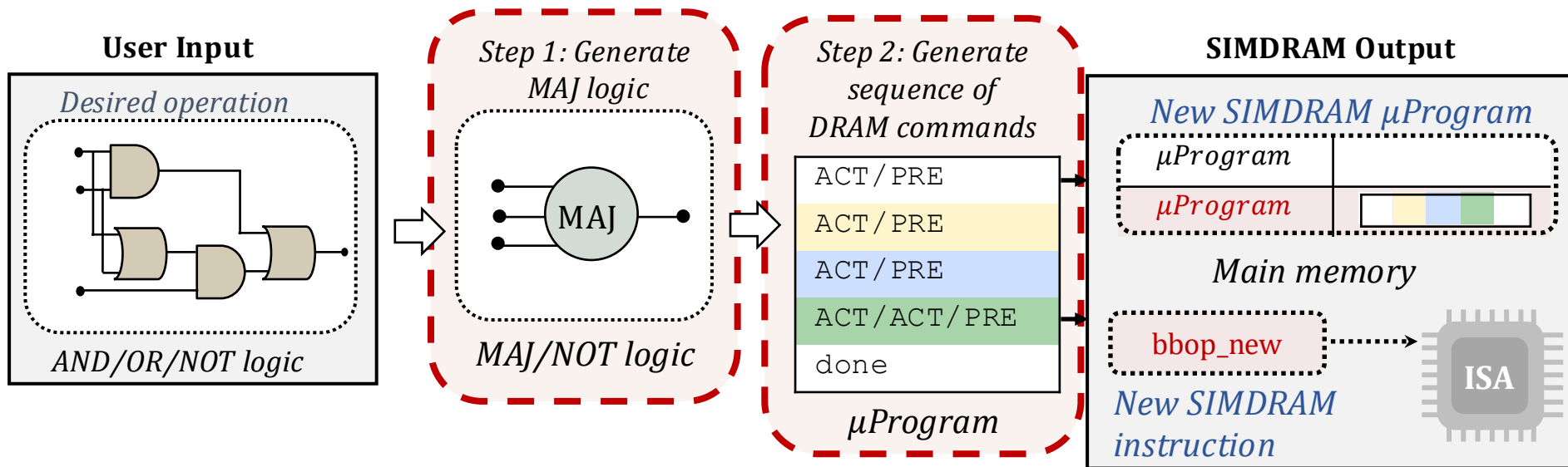
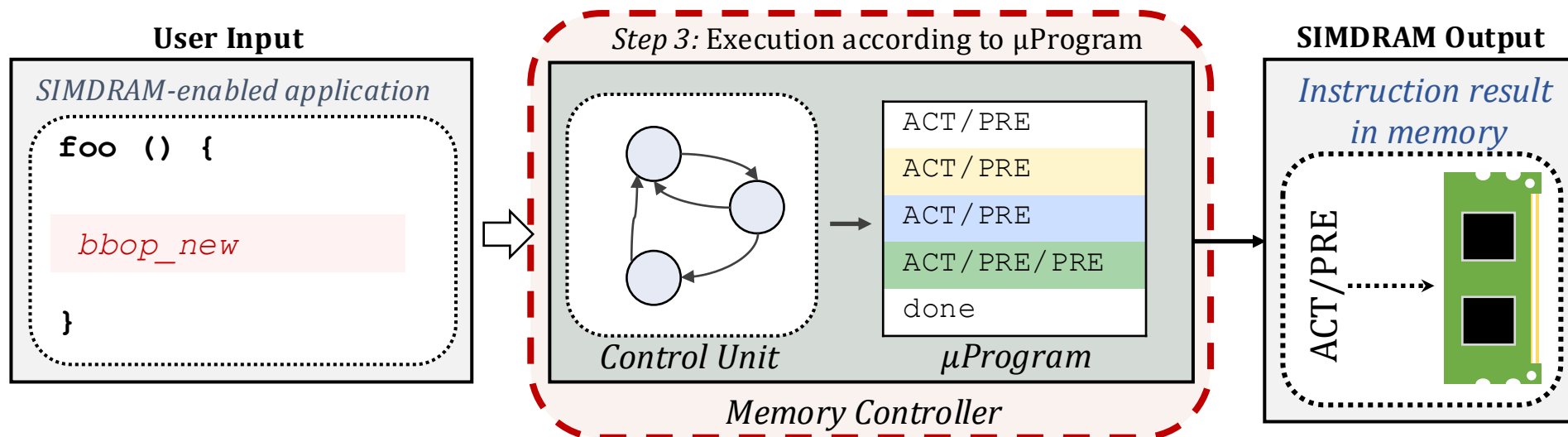
*Nastaran Hajinazar ^{1,2}	*Geraldo F. Oliveira ¹	Sven Gregorio ¹	João Dinis Ferreira ¹
Nika Mansouri Ghiasi ¹	Minesh Patel ¹	Mohammed Alser ¹	Saugata Ghose ³
	Juan Gómez-Luna ¹	Onur Mutlu ¹	

¹ETH Zürich

²Simon Fraser University

³University of Illinois at Urbana-Champaign

SIMDRAM Framework: Overview



SIMDRAM Key Results

Large improvements over **CPU** & **high-end GPU**:

Throughput: 88× and 5.8×

(16 complex operations)

Energy: 257× and 31×

(16 complex operations)

Application Performance: 21× and 2.1×

(seven common real-world applications)

More on SIMD RAM

- Nastaran Hajinazar, Geraldo F. Oliveira, Sven Gregorio, Joao Dinis Ferreira, Nika Mansouri Ghiasi, Minesh Patel, Mohammed Alser, Saugata Ghose, Juan Gomez-Luna, and Onur Mutlu,
["SIMDRAM: An End-to-End Framework for Bit-Serial SIMD Computing in DRAM"](#)
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SIMDRAM: A Framework for Bit-Serial SIMD Processing using DRAM

*Nastaran Hajinazar ^{1,2}	*Geraldo F. Oliveira ¹	Sven Gregorio ¹	João Dinis Ferreira ¹
Nika Mansouri Ghiasi ¹	Minesh Patel ¹	Mohammed Alser ¹	Saugata Ghose ³
	Juan Gómez-Luna ¹	Onur Mutlu ¹	

¹ETH Zürich

²Simon Fraser University

³University of Illinois at Urbana–Champaign

MIMDRAM: More Flexible Processing using DRAM

- Appears at HPCA 2024

MIMDRAM: An End-to-End Processing-Using-DRAM System for High-Throughput, Energy-Efficient and Programmer-Transparent Multiple-Instruction Multiple-Data Computing

Geraldo F. Oliveira[†] Ataberk Olgun[†] Abdullah Giray Yağlıkçı[†] F. Nisa Bostancı[†]
Juan Gómez-Luna[†] Saugata Ghose[‡] Onur Mutlu[†]

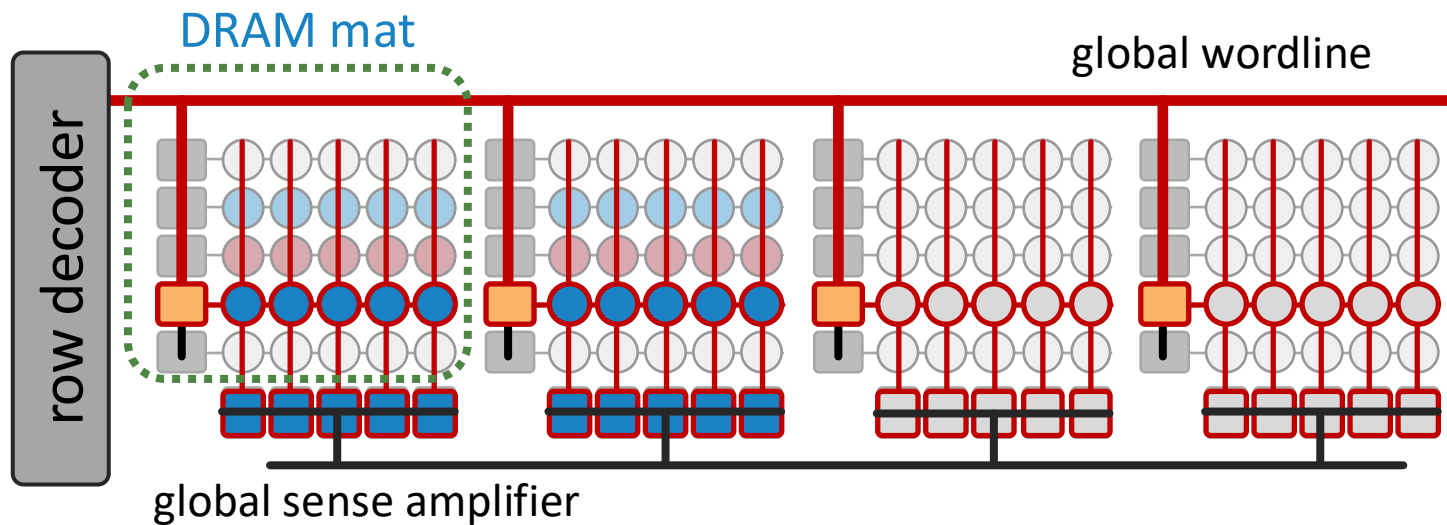
[†] *ETH Zürich*

[‡] *Univ. of Illinois Urbana-Champaign*

Our goal is to design a flexible PUD system that overcomes the limitations caused by the large and rigid granularity of PUD. To this end, we propose MIMDRAM, a hardware/software co-designed PUD system that introduces new mechanisms to allocate and control only the necessary resources for a given PUD operation. The key idea of MIMDRAM is to leverage fine-grained DRAM (i.e., the ability to independently access smaller segments of a large DRAM row) for PUD computation. MIMDRAM exploits this key idea to enable a multiple-instruction multiple-data (MIMD) execution model in each DRAM subarray (and SIMD execution within each DRAM row segment).

MIMDRAM: Key Idea (I)

Enable narrower-width operations than a DRAM row



Key Issue:

on a DRAM access, the global wordline propagates across all DRAM mats

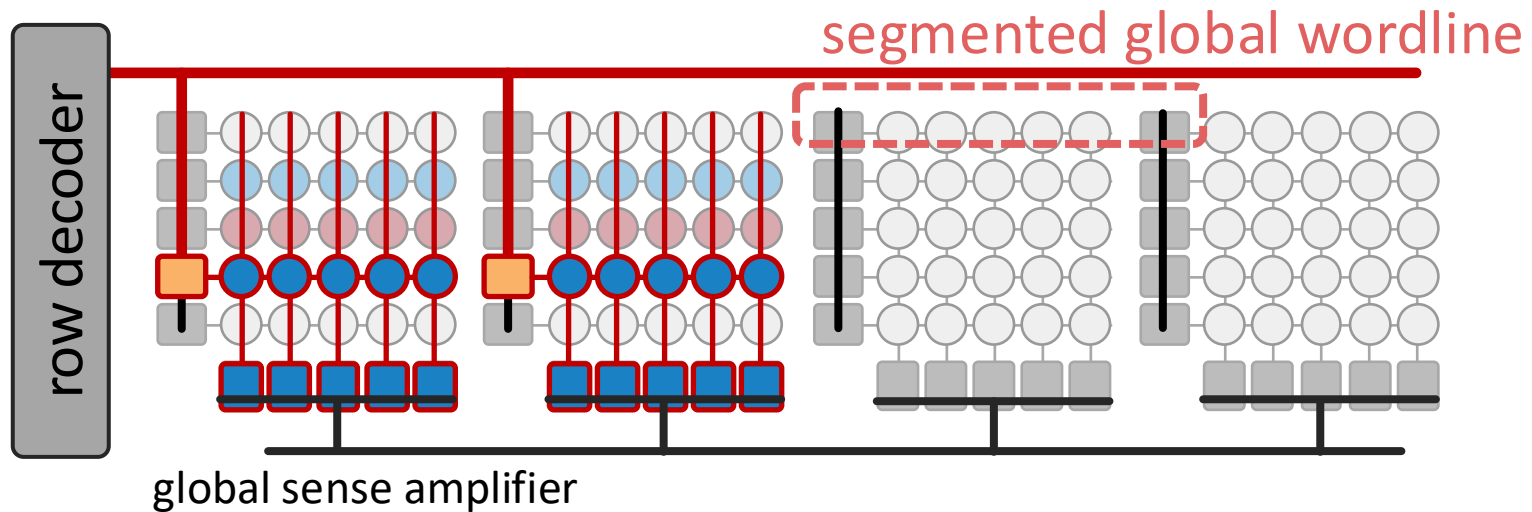


Fine-Grained DRAM:

segment the global wordline to access **individual** DRAM mats

MIMDRAM: Key Idea (II)

Fine-Grained DRAM:
segment the global wordline to access individual DRAM mats



Fine-grained DRAM for energy-efficient DRAM access:

[Cooper-Balis+, 2010]: Fine-Grained Activation for Power Reduction in DRAM

[Udipi+, 2010]: Rethinking DRAM Design and Organization for Energy-Constrained Multi-Cores

[Zhang+, 2014]: Half-DRAM

[Ha+, 2016]: Improving Energy Efficiency of DRAM by Exploiting Half Page Row Access

[O'Connor+, 2017]: Fine-Grained DRAM

[Olgun+, 2024]: Sectored DRAM

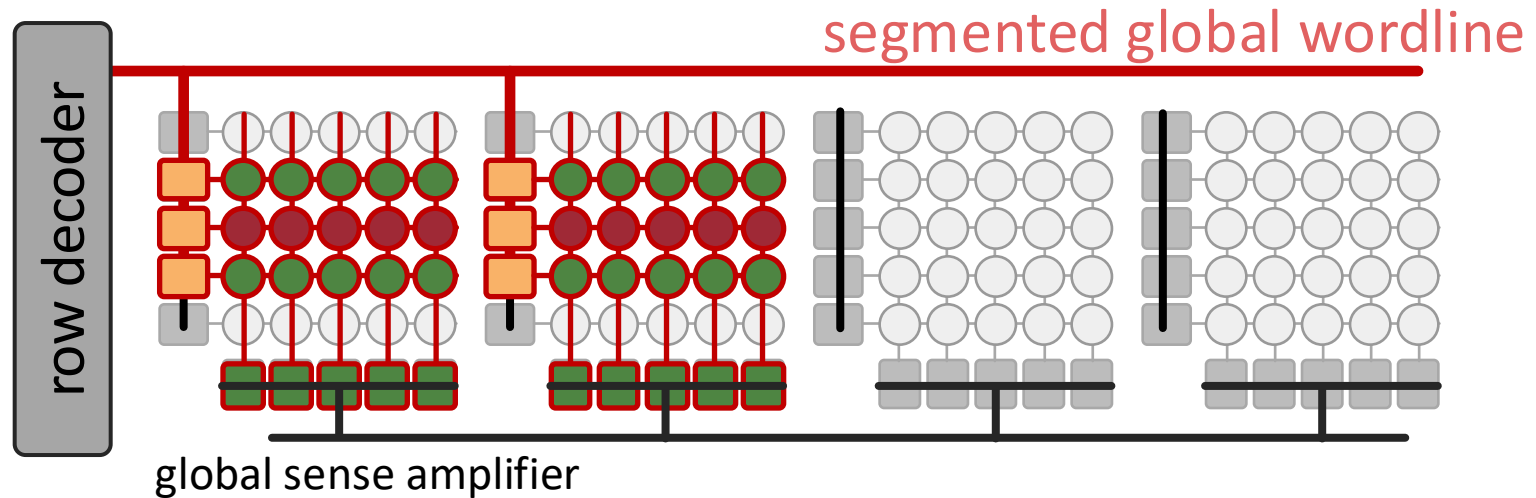
Sectored DRAM

- Ataberk Olgun, F. Nisa Bostanci, Geraldo F. Oliveira, Yahya Can Tugrul, Rahul Bera, A. Giray Yaglikci, Hasan Hassan, Oguz Ergin, and Onur Mutlu,
"Sectored DRAM: A Practical Energy-Efficient and High-Performance Fine-Grained DRAM Architecture"
ACM Transactions on Architecture and Code Optimization (TACO), [online]
June 2024.
[[arXiv version](#)]
[[ACM Digital Library version](#)]

Sectored DRAM: A Practical Energy-Efficient and High-Performance Fine-Grained DRAM Architecture

Ataberk Olgun[§] F. Nisa Bostanci^{§†} Geraldo F. Oliveira[§] Yahya Can Tuğrul^{§†} Rahul Bera[§]
A. Giray Yağlıkcı[§] Hasan Hassan[§] Oğuz Ergin[†] Onur Mutlu[§]

MIMDRAM: Key Idea (III)

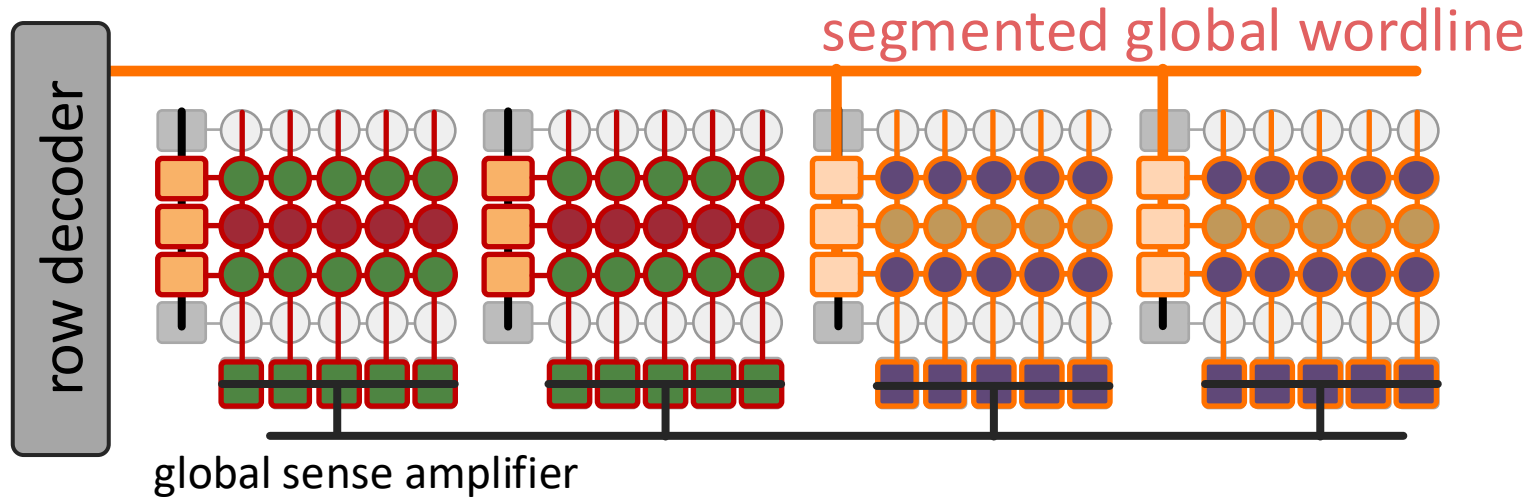


Use fine-grained DRAM for processing-using-DRAM:

1 Improves SIMD utilization

- for a single PUD operation, only access the DRAM mats with target data

MIMDRAM: Key Idea (III)

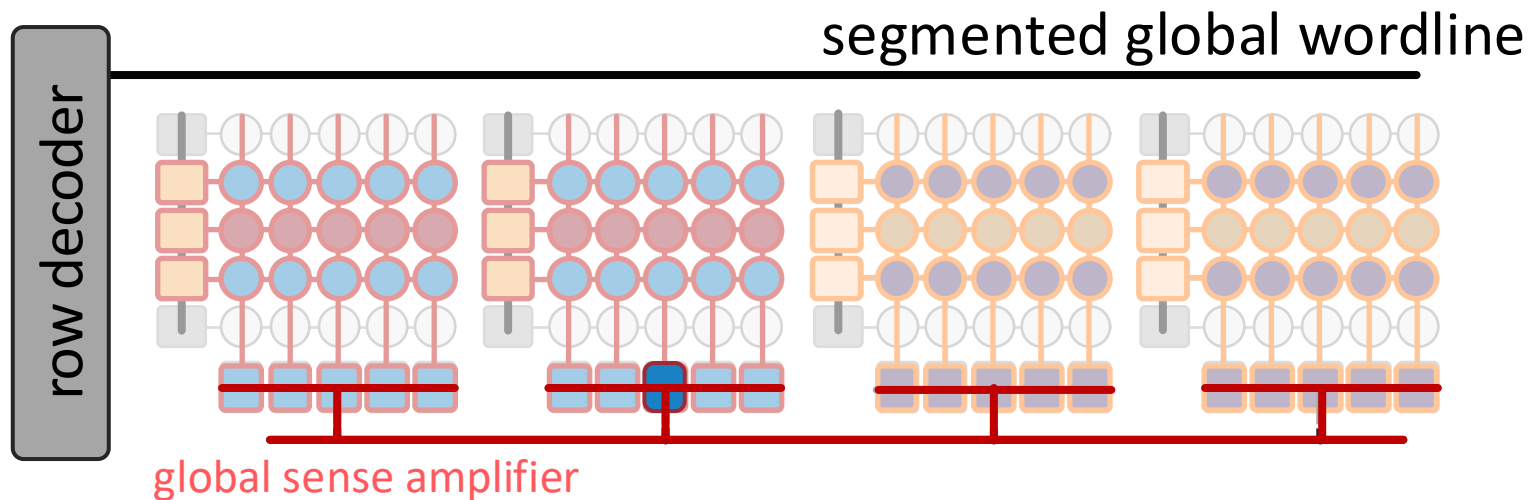


Use fine-grained DRAM for processing-using-DRAM:

1 Improves SIMD utilization

- for a single PUD operation, only access the DRAM mats with target data
- for multiple PUD operations, execute independent operations concurrently
→ **multiple instruction, multiple data (MIMD) execution model**

MIMDRAM: Key Idea (III)



Use fine-grained DRAM for processing-using-DRAM:

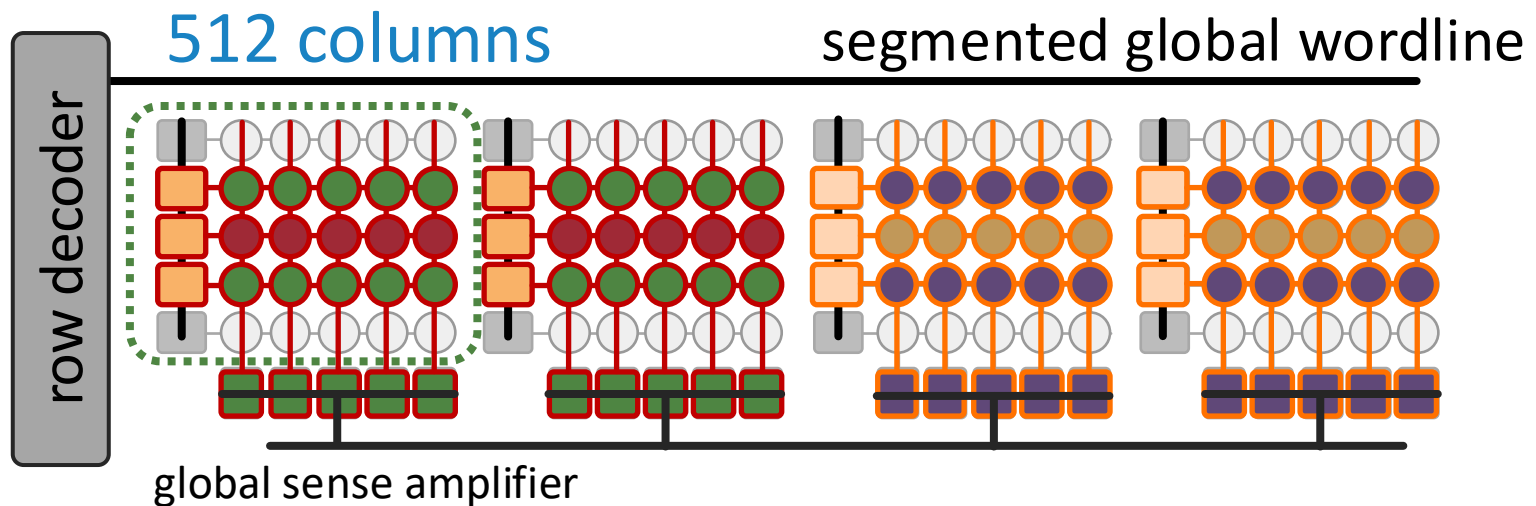
1 Improves SIMD utilization

- for a single PUD operation, only access the DRAM mats with target data
- for multiple PUD operations, execute independent operations concurrently
→ multiple instruction, multiple data (MIMD) execution model

2 Enables low-cost interconnects for vector reduction

- global and local data buses can be used for inter-/intra-mat communication

MIMDRAM: Key Idea (III)



Use fine-grained DRAM for processing-using-DRAM:

1 Improves SIMD utilization

- for a single PUD operation, only access the DRAM mats with target data
- for multiple PUD operations, execute independent operations concurrently
→ multiple instruction, multiple data (MIMD) execution model

2 Enables low-cost interconnects for vector reduction

- global and local data buses can be used for inter-/intra-mat communication

3 Eases programmability

- SIMD parallelism in a DRAM mat is on par with vector ISAs' SIMD width

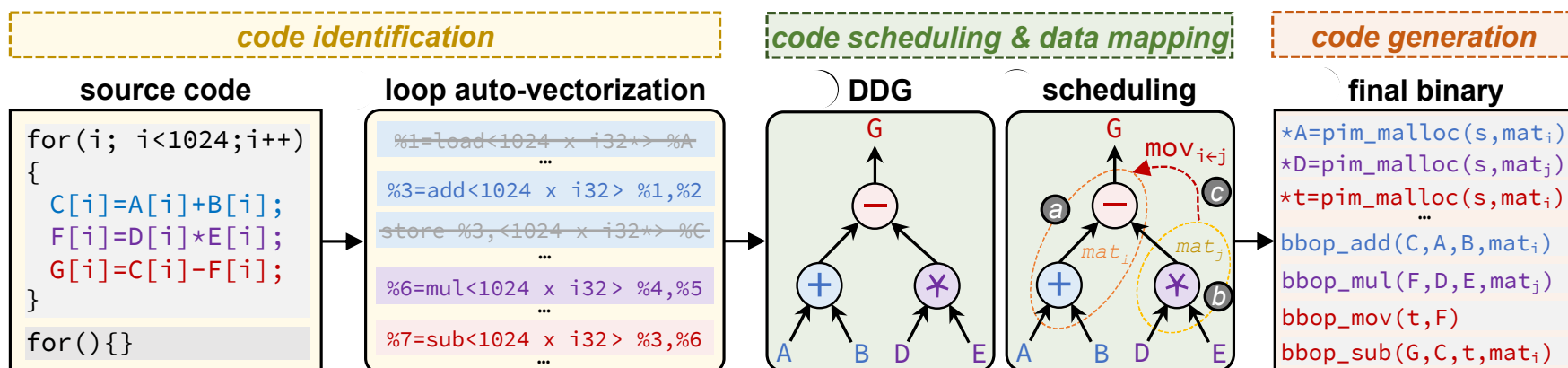
MIMDRAM: Compiler Support

Goal

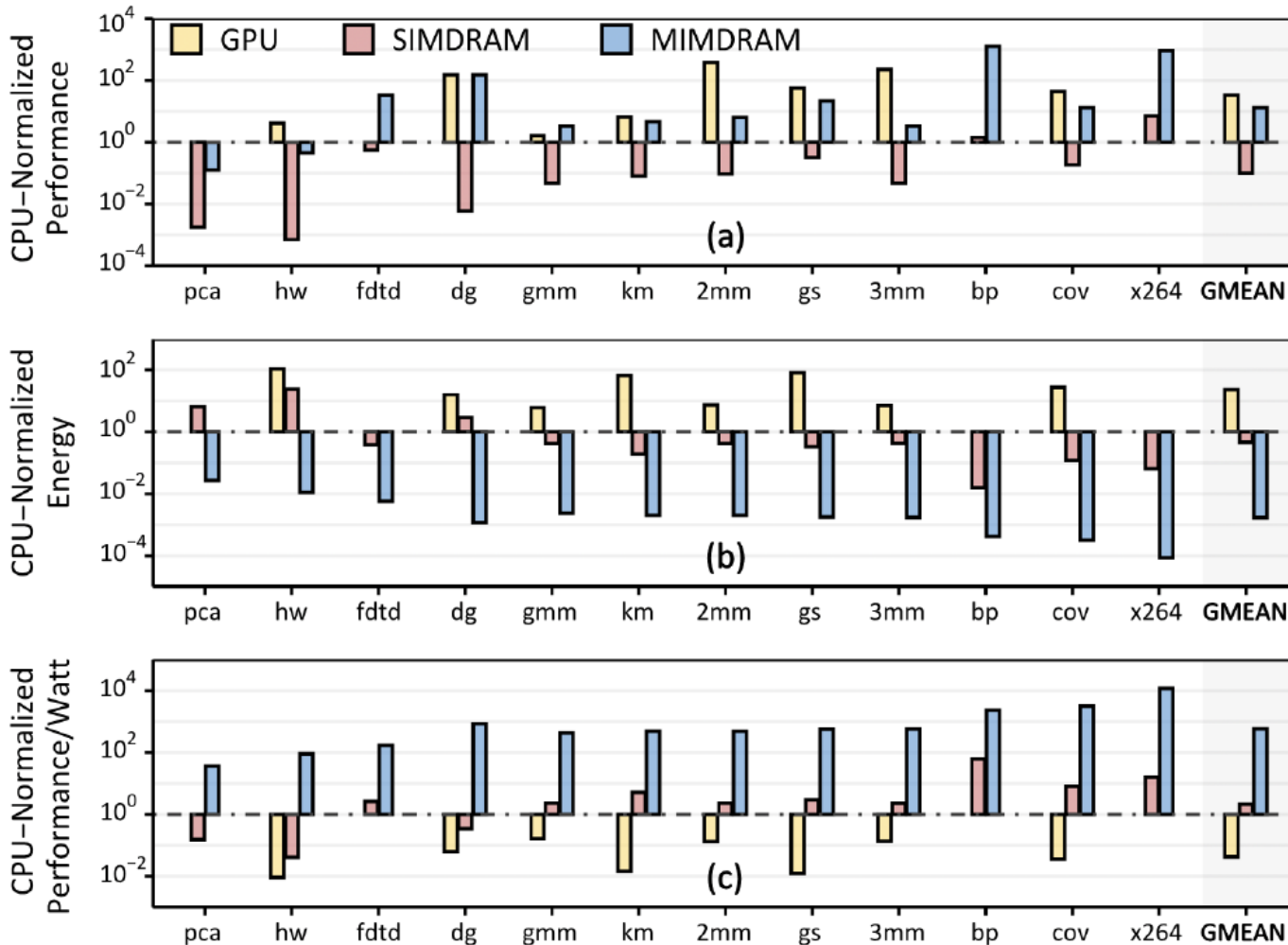
Transparently to programmer:
extract SIMD parallelism from an application, and
schedule PUD instructions while maximizing utilization



Three new LLVM-based passes targeting PUD execution



MIMDRAM Perf, Energy, Perf/Watt



582X and 13,612X the energy efficiency of CPU and GPU, respectively

Existing DRAM Chips
Are Already Quite Capable

RowClone and MAJ3 in Real DRAM Chips

- **Key Idea:** Violate DRAM timing parameters to mimic RowClone and Ambit's MAJ3 operation

ComputeDRAM: In-Memory Compute Using Off-the-Shelf DRAMs

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Real Processing Using Memory Prototype

- End-to-end RowClone & TRNG using off-the-shelf DRAM chips
- Idea: Violate DRAM timing parameters to mimic RowClone

PiDRAM: A Holistic End-to-end FPGA-based Framework for Processing-in-DRAM

Ataberk Olgun^{§†}

Juan Gómez Luna[§]

Konstantinos Kanellopoulos[§]

Behzad Salami^{§*}

Hasan Hassan[§]

Oğuz Ergin[†]

Onur Mutlu[§]

[§]ETH Zürich

[†]TOBB ETÜ

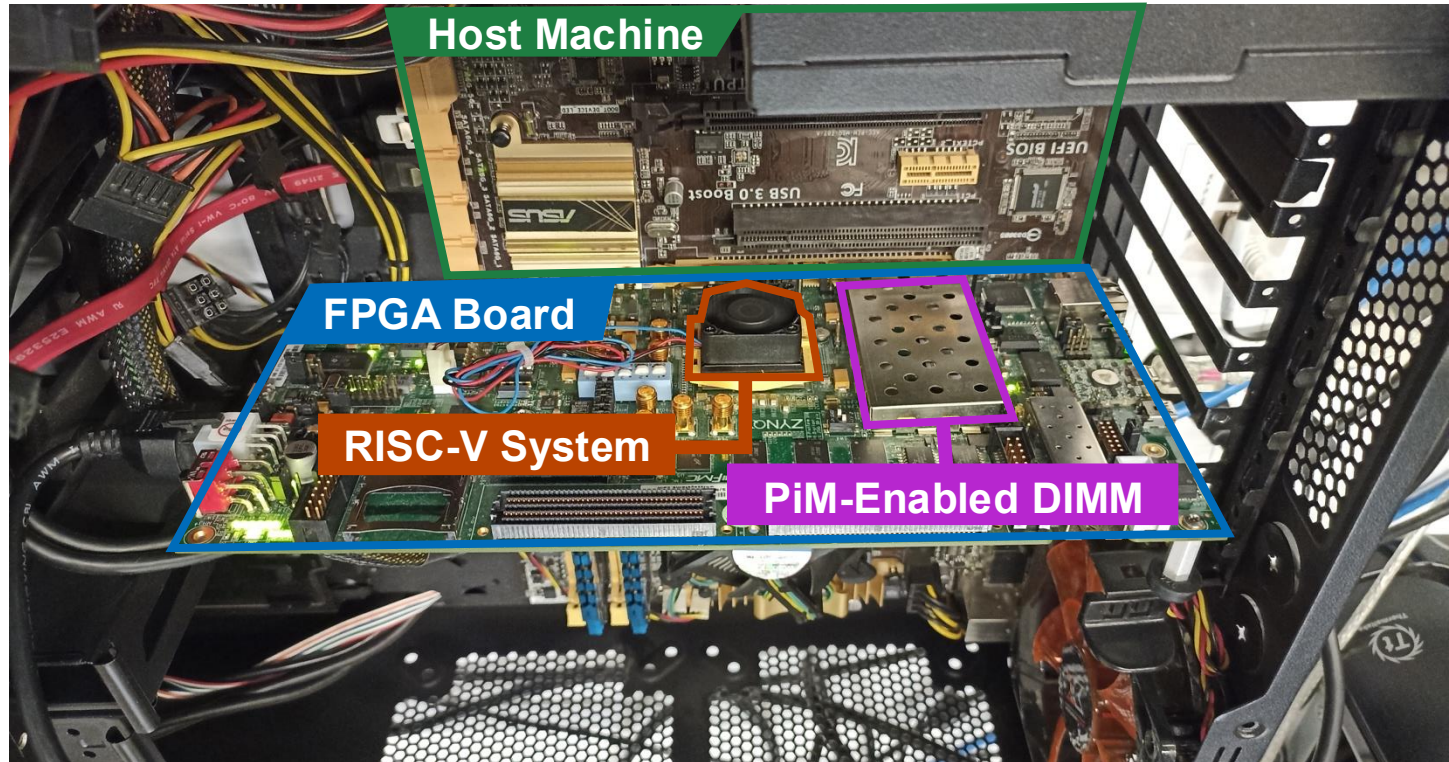
^{*}BSC

<https://arxiv.org/pdf/2111.00082.pdf>

<https://github.com/cmu-safari/pidram>

<https://www.youtube.com/watch?v=qeukNs5XI3g&t=4192s>

Real Processing Using Memory Prototype



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<https://www.youtube.com/watch?v=qeukNs5XI3g&t=4192s>

Real Processing Using Memory Prototype

☰ README.md

Building a PiDRAM Prototype

To build PiDRAM's prototype on Xilinx ZC706 boards, developers need to use the two sub-projects in this directory. `fpga-zynq` is a repository branched off of [UCB-BAR's fpga-zynq](#) repository. We use `fpga-zynq` to generate rocket chip designs that support end-to-end DRAM PuM execution. `controller-hardware` is where we keep the main Vivado project and Verilog sources for PiDRAM's memory controller and the top level system design.

Rebuilding Steps

1. Navigate into `fpga-zynq` and read the README file to understand the overall workflow of the repository
 - Follow the readme in `fpga-zynq/rocket-chip/riscv-tools` to install dependencies
2. Create the Verilog source of the rocket chip design using the `ZynqCopyFPGAConfig`
 - Navigate into `zc706`, then run `make rocket CONFIG=ZynqCopyFPGAConfig -j<number of cores>`
3. Copy the generated Verilog file (should be under `zc706/src`) and overwrite the same file in `controller-hardware/source/hdl/impl/rocket-chip`
4. Open the Vivado project in `controller-hardware/Vivado_Project` using Vivado 2016.2
5. Generate a bitstream
6. Copy the bitstream (`system_top.bit`) to `fpga-zynq/zc706`
7. Use the `./build_script.sh` to generate the new `boot.bin` under `fpga-images-zc706`, you can use this file to program the FPGA using the SD-Card
 - For details, follow the relevant instructions in `fpga-zynq/README.md`

You can run programs compiled with the RISC-V Toolchain supplied within the `fpga-zynq` repository. To install the toolchain, follow the instructions under `fpga-zynq/rocket-chip/riscv-tools`.

Generating DDR3 Controller IP sources

We cannot provide the sources for the Xilinx PHY IP we use in PiDRAM's memory controller due to licensing issues. We describe here how to regenerate them using Vivado 2016.2. First, you need to generate the IP RTL files:

- 1- Open IP Catalog
- 2- Find "Memory Interface Generator (MIG 7 Series)" IP and double click

<https://arxiv.org/pdf/2111.00082.pdf>

<https://github.com/cmu-safari/pidram>

<https://www.youtube.com/watch?v=qeukNs5XI3g&t=4192s>

More on PiDRAM

- Ataberk Olgun, Juan Gomez Luna, Konstantinos Kanellopoulos, Behzad Salami, Hasan Hassan, Oguz Ergin, and Onur Mutlu,
["PiDRAM: A Holistic End-to-end FPGA-based Framework for Processing-in-DRAM"](#)
[ACM Transactions on Architecture and Code Optimization \(TACO\)](#), March 2023.
[\[arXiv version\]](#)
Presented at the [18th HiPEAC Conference](#), Toulouse, France, January 2023.
[\[Slides \(pptx\) \(pdf\)\]](#)
[\[Longer Lecture Slides \(pptx\) \(pdf\)\]](#)
[\[Lecture Video \(40 minutes\)\]](#)
[\[PiDRAM Source Code\]](#)

PiDRAM: A Holistic End-to-end FPGA-based Framework for Processing-in-DRAM

Ataberk Olgun[§] Juan Gómez Luna[§] Konstantinos Kanellopoulos[§] Behzad Salami[§]
Hasan Hassan[§] Oğuz Ergin[†] Onur Mutlu[§]
[§]*ETH Zürich* [†]*TOBB University of Economics and Technology*

Focus on Recent Real DRAM Chip-based PuD Works

HPCA 2024

Functionally-Complete Boolean Logic in Real DRAM Chips: Experimental Characterization and Analysis

İsmail Emir Yüksel Yahya Can Tuğrul Ataberk Olgun F. Nisa Bostancı A. Giray Yağlıkçı
Geraldo F. Oliveira Haocong Luo Juan Gómez-Luna Mohammad Sadrosadati Onur Mutlu

ETH Zürich

DSN 2024

Simultaneous Many-Row Activation in Off-the-Shelf DRAM Chips: Experimental Characterization and Analysis

İsmail Emir Yüksel¹ Yahya Can Tuğrul^{1,2} F. Nisa Bostancı¹ Geraldo F. Oliveira¹
A. Giray Yağlıkçı¹ Ataberk Olgun¹ Melina Soysal¹ Haocong Luo¹
Juan Gómez-Luna¹ Mohammad Sadrosadati¹ Onur Mutlu¹

¹ETH Zürich ²TOBB University of Economics and Technology

ISCA 2025

PuDHammer: Experimental Analysis of Read Disturbance Effects of Processing-using-DRAM in Real DRAM Chips

İsmail Emir Yüksel Akash Sood Ataberk Olgun Oğuzhan Canpolat Haocong Luo
F. Nisa Bostancı Mohammad Sadrosadati A. Giray Yağlıkçı Onur Mutlu

ETH Zürich

Functionally-Complete Boolean Logic in Real DRAM Chips

Experimental Characterization and Analysis

Ismail Emir Yüksel

Yahya C. Tugrul Ataberk Olgun F. Nisa Bostancı

A. Giray Yaglıkçı Geraldo F. Oliveira Haocong Luo

Juan Gómez–Luna Mohammad Sadr Onur Mutlu

SAFARI

ETH zürich

Executive Summary

Motivation: Processing-using-DRAM can alleviate the performance and energy bottlenecks caused by **data movement**

- **Prior works** show that **existing DRAM chips** can perform **three-input majority** and **two-input AND and OR** operations

Problem: **Proof-of-concept** demonstrations on **commercial off-the-shelf (COTS)** DRAM chips do not provide

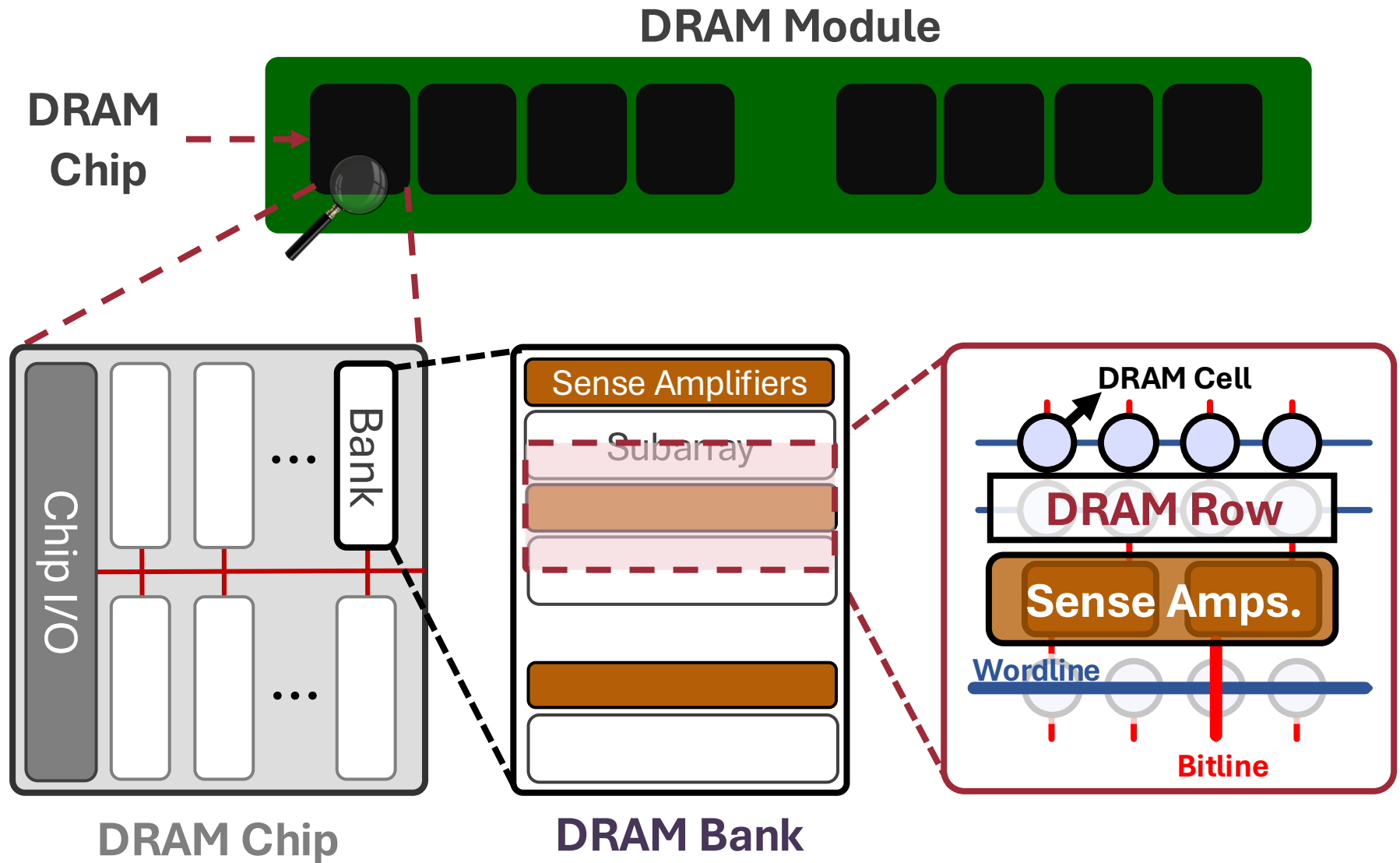
- **functionally-complete** operations (e.g., NAND or NOR)
- **NOT operation**
- **AND** and **OR** operations with **more than two inputs**

Experimental Study: **256 DDR4 chips** from **two major manufacturers**

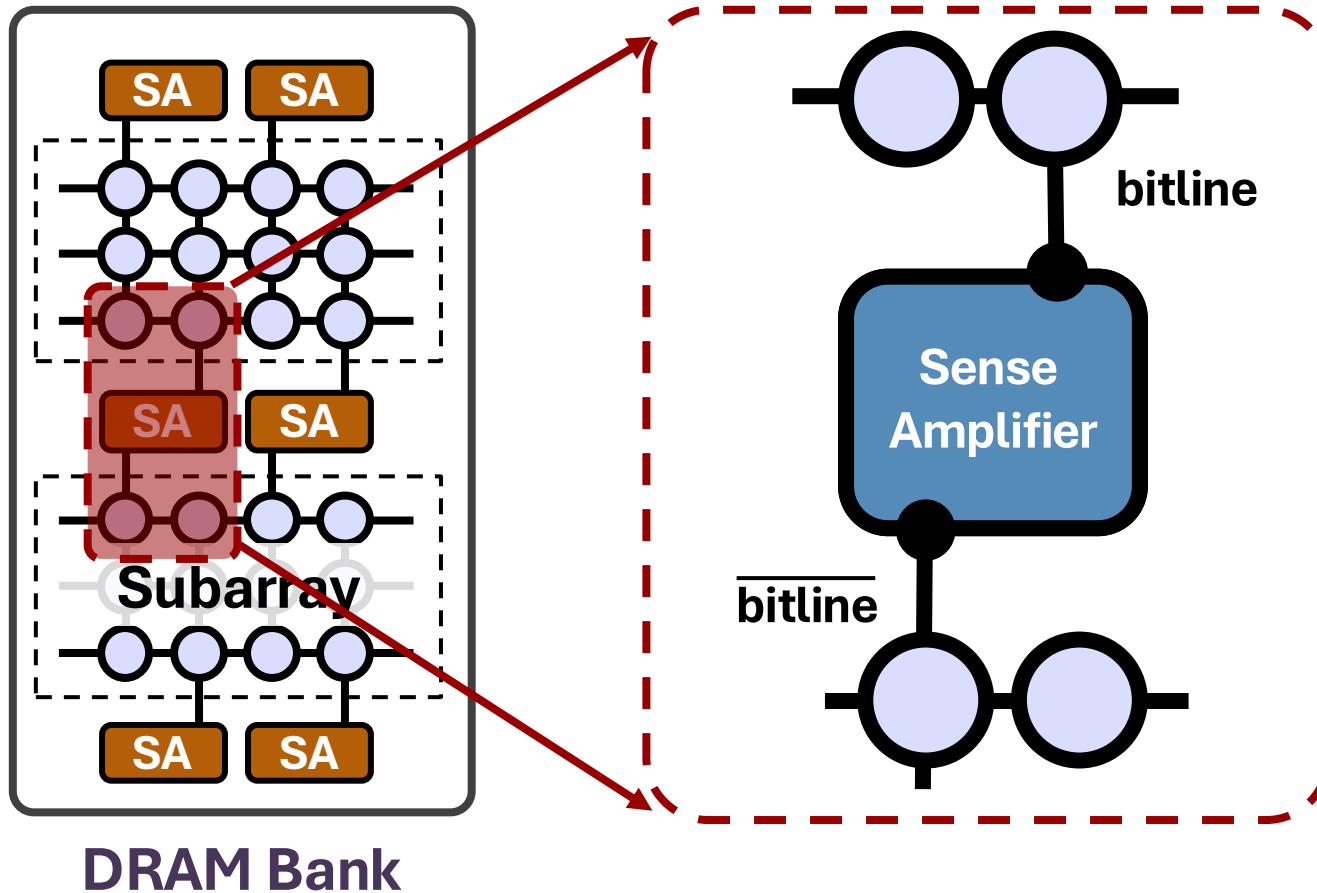
Key Results:

- COTS DRAM chips can perform **NOT** and **{2, 4, 8, 16}-input AND, NAND, OR, and NOR** operations with **very high reliability (>94% success rate)**
- **Data pattern** and **temperature** only slightly affect the reliability of these operations (**<1.98% decrease in success rate**)

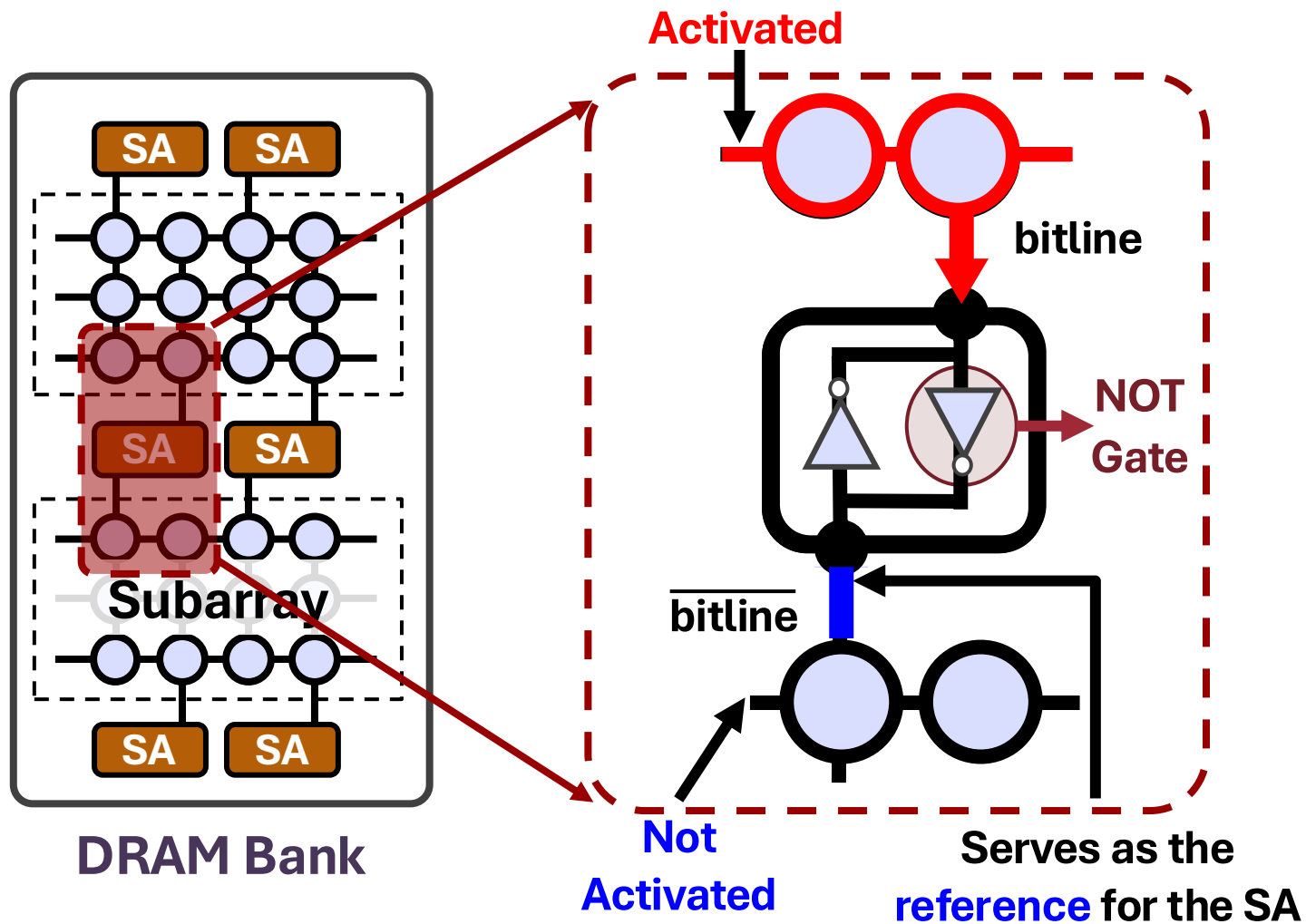
DRAM Organization



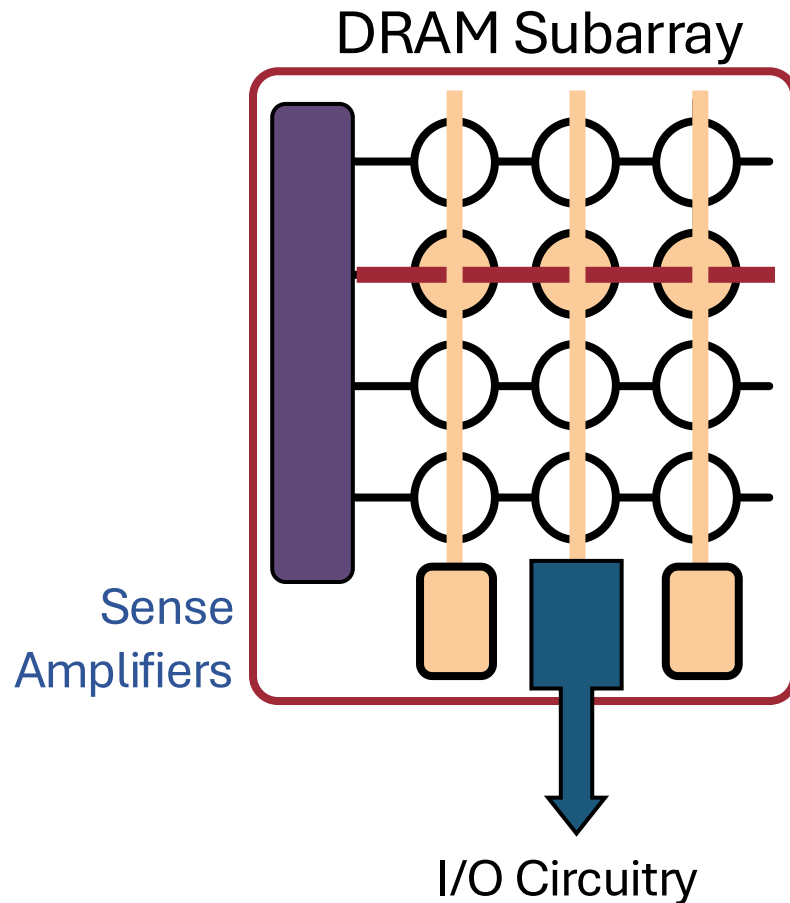
DRAM Open Bitline Architecture



DRAM Open Bitline Architecture



DRAM Operation



- 1 ACTIVATE (ACT):**
Fetch the row's content into the **sense amplifiers**
- 2 Column Access (RD/WR):**
Read/Write the target column and drive to I/O
- 3 PRECHARGE (PRE):**
Prepare the bank for a new ACTIVATE

The Capability of COTS DRAM Chips

We demonstrate that COTS DRAM chips:

1

Can **simultaneously activate** up to **48 rows** in **two neighboring subarrays**

2

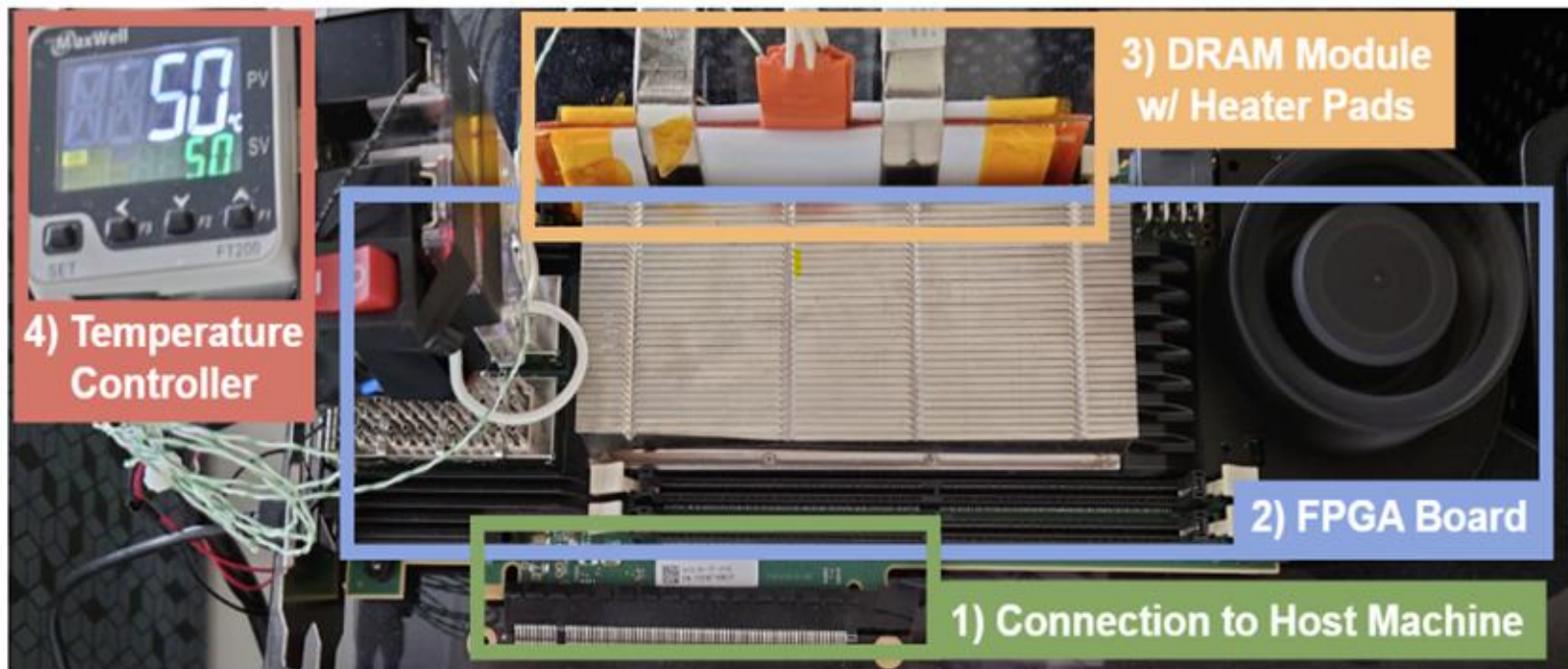
Can perform **NOT operation** with up to **32 output operands**

3

Can perform up to **16-input AND, NAND, OR, and NOR** operations

DRAM Testing Infrastructure

- Developed from [DRAM Bender \[Olgun+, TCAD'23\]](#)*
- **Fine-grained control** over DRAM commands, timings, and temperature

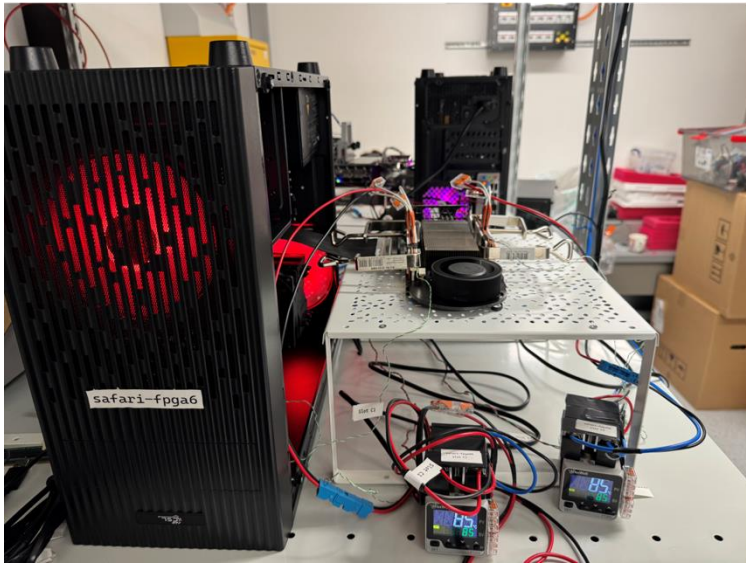


*Olgun et al., "[DRAM Bender: An Extensible and Versatile FPGA-based Infrastructure to Easily Test State-of-the-art DRAM Chips](#)," TCAD, 2023.

Laboratory for Understanding Memory



Laboratory for Understanding Memory



DRAM Chips Tested

- 256 DDR4 chips from two major DRAM manufacturers
- Covers different die revisions and chip densities

Chip Mfr.	#Modules (#Chips)	Die Rev.	Mfr. Date ^a	Chip Density	Chip Org.	Speed Rate
SK Hynix	9 (72)	M	N/A	4Gb	x8	2666MT/s
	5 (40)	A	N/A	4Gb	x8	2133MT/s
	1 (16)	A	N/A	8Gb	x8	2666MT/s
	1 (32)	A	18-14	4Gb	x4	2400MT/s
	1 (32)	A	16-49	8Gb	x4	2400MT/s
	1 (32)	M	16-22	8Gb	x4	2666MT/s
Samsung	1 (8)	F	21-02	4Gb	x8	2666MT/s
	2 (16)	D	21-10	8Gb	x8	2133MT/s
	1 (8)	A	22-12	8Gb	x8	3200MT/s

The Capability of COTS DRAM Chips

We demonstrate that COTS DRAM chips:

1

Can **simultaneously activate** up to **48 rows** in **two neighboring subarrays**

2

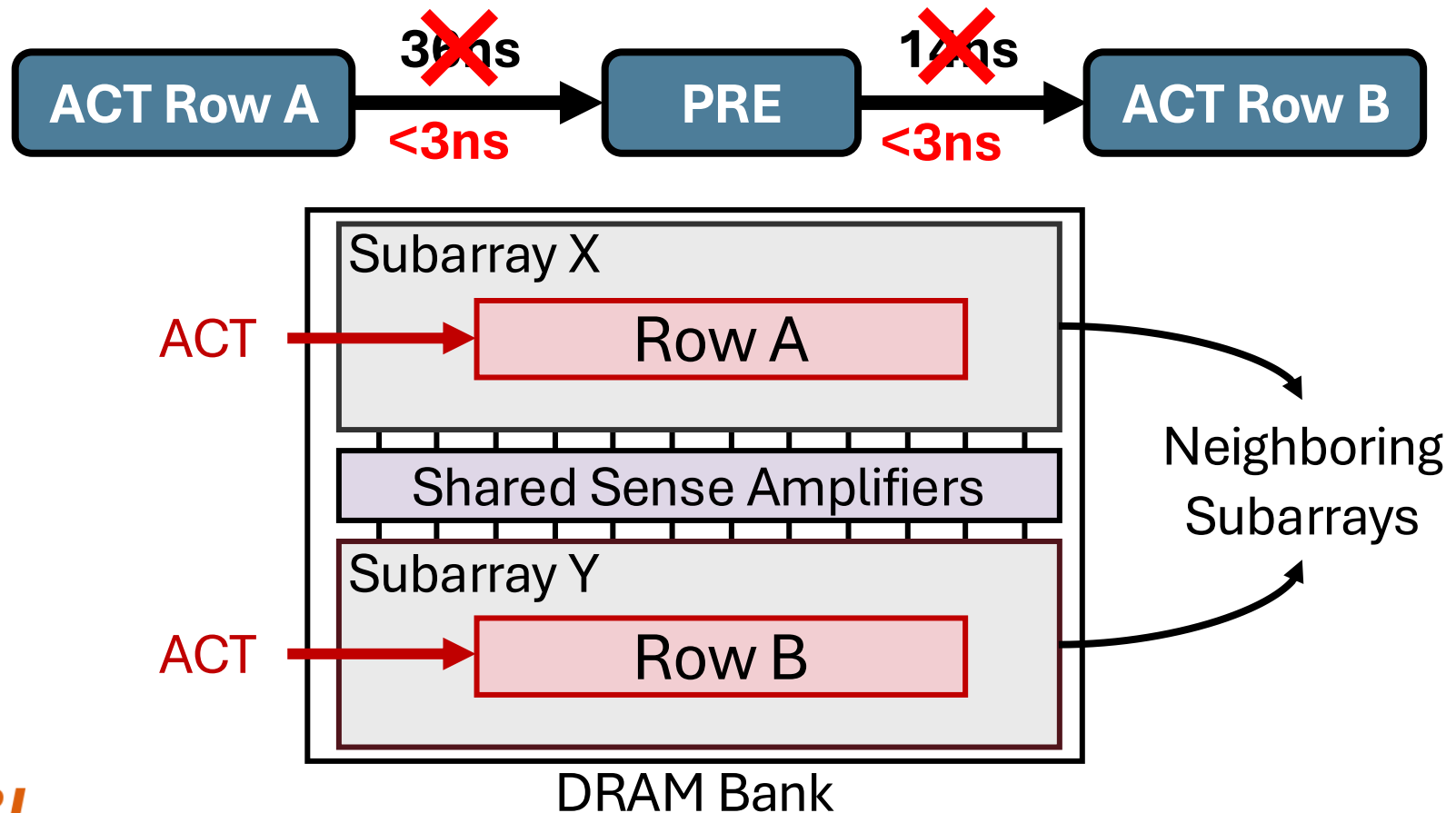
Can perform **NOT operation** with up to **32 output operands**

3

Can perform up to **16-input AND, NAND, OR, and NOR operations**

Key Observation

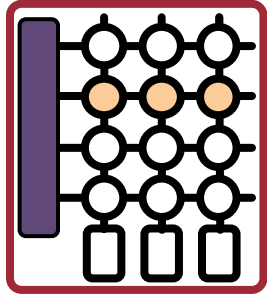
Activating two rows in **quick succession**
can **simultaneously** activate
multiple rows in neighboring subarrays



Hypothesis: Row Decoder Circuitry

Simultaneous many-row activation is possible due to the **hierarchical DRAM row decoder design**

DRAM Subarray



Row Address



Row Decoder

Wordline



Row Address (RA)



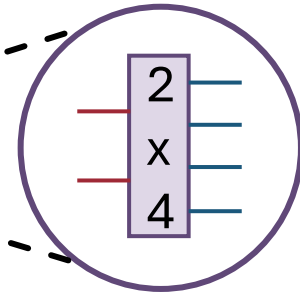
Stage 1 Decoder

Stage 2 Decoder

Stage 3 Decoder

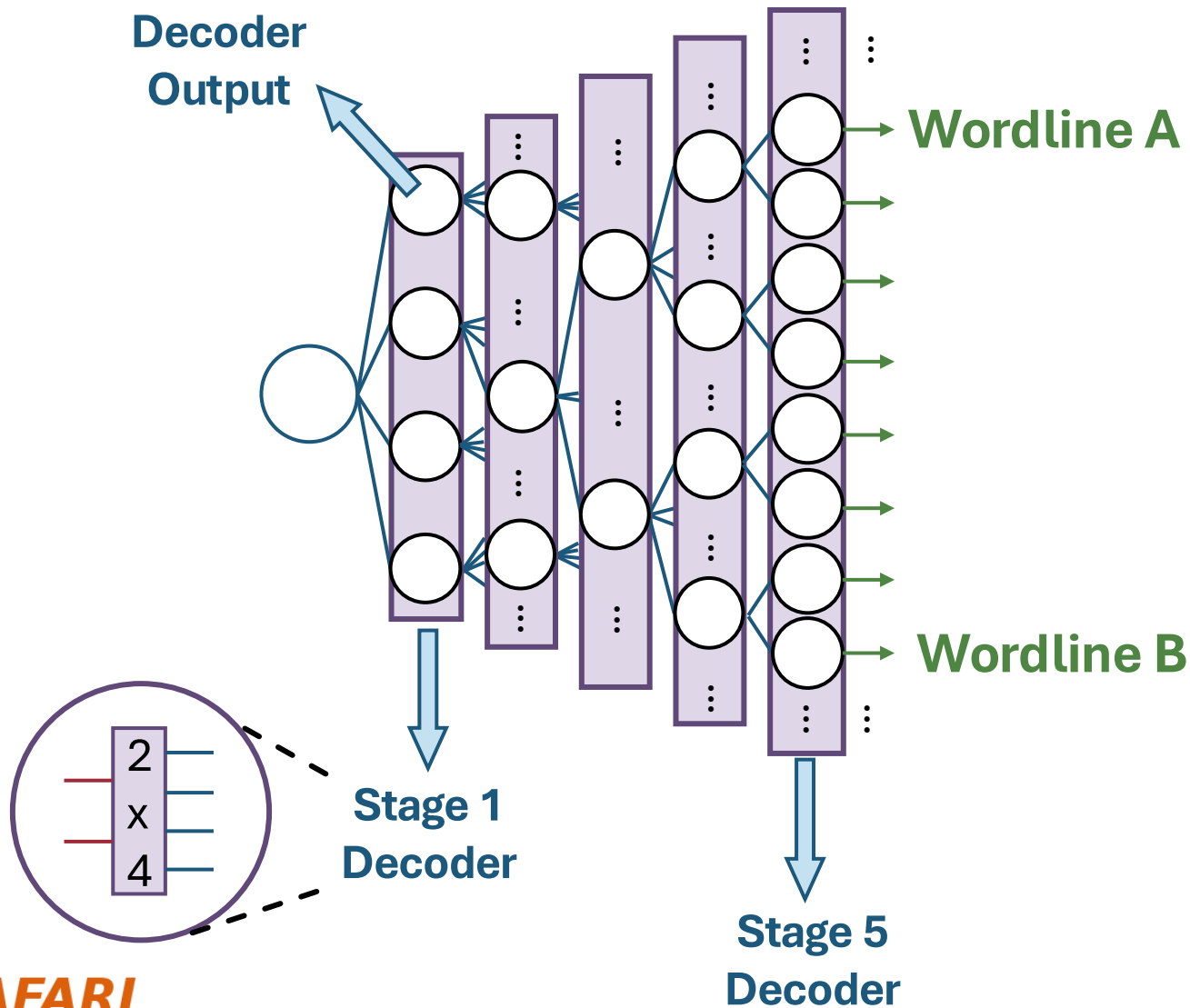
Stage 4 Decoder

Stage 5 Decoder

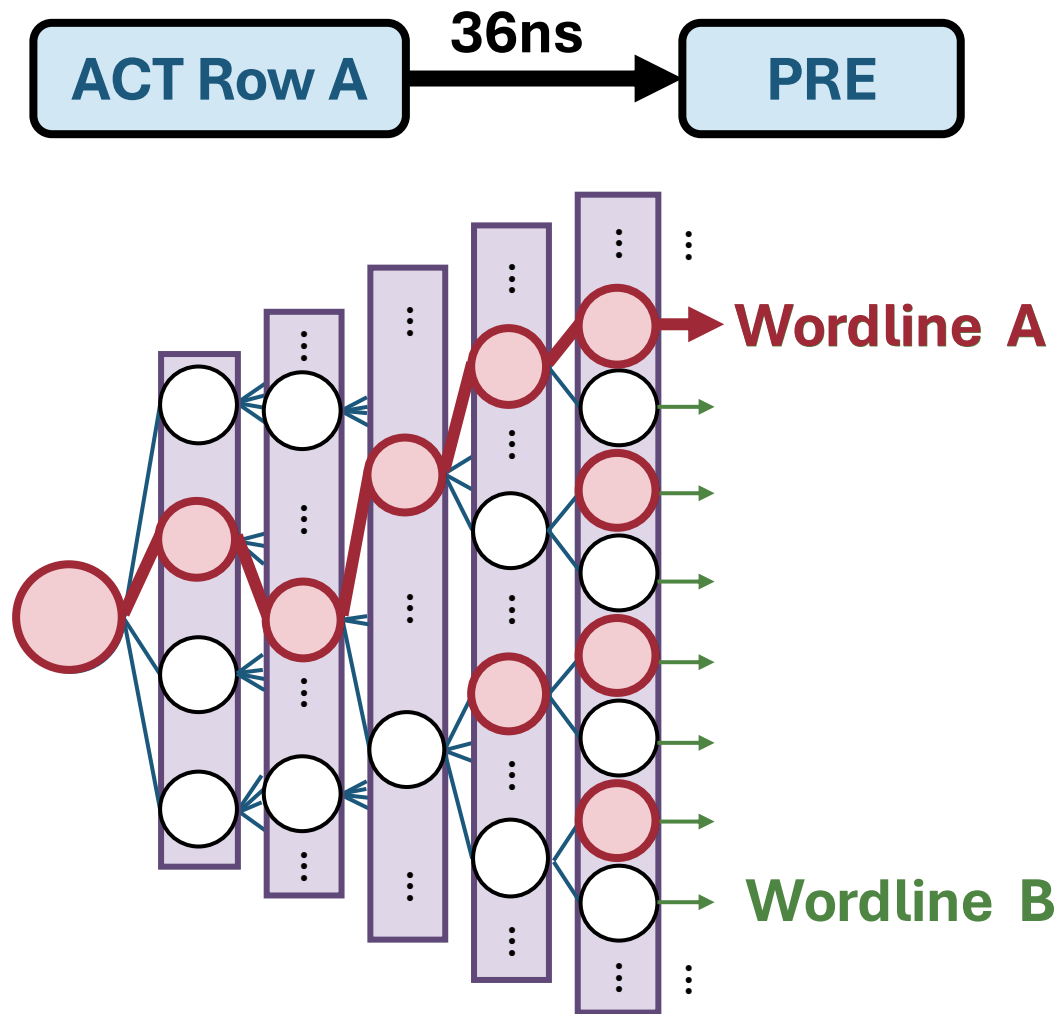


Row Decoder: A Tree Example

- We can visualize the hierarchical row decoder circuitry as a tree



Activating a Single Row



1. Decode
Row A address

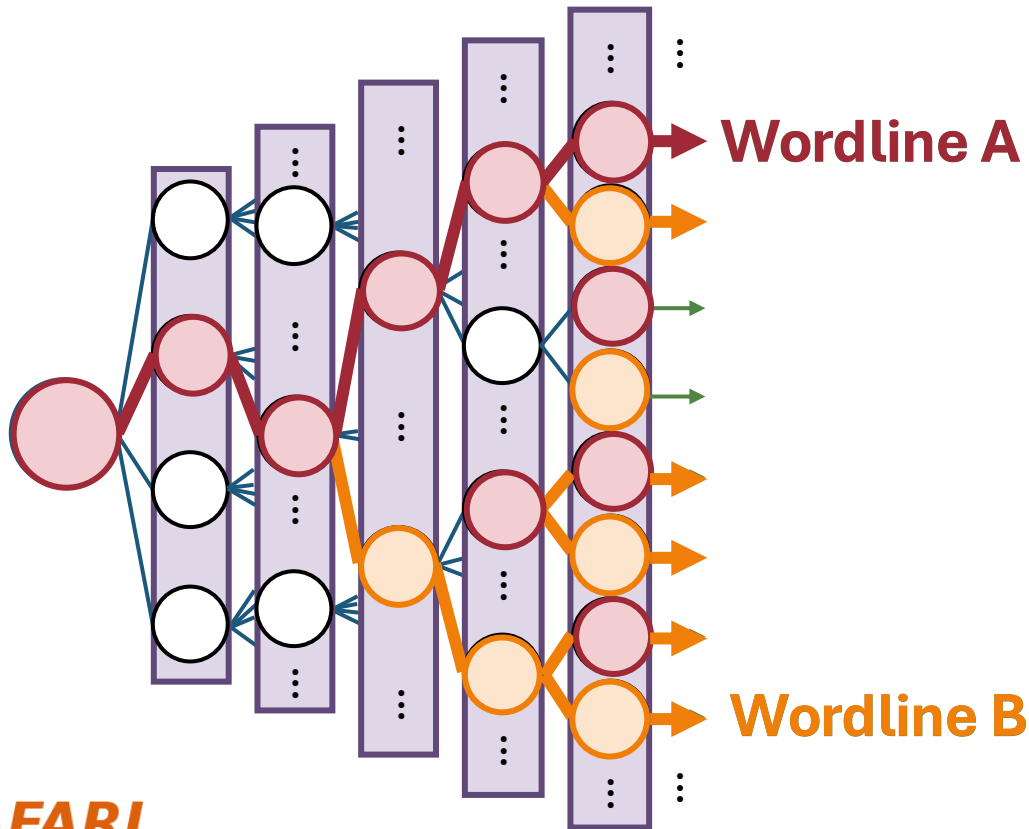
2. Assert
corresponding signals

3. Follow
asserted nodes path
from root to leaf

4. Assert wordline

Activating Many Rows: A Walkthrough

Back-to-back ACT commands with violated timings
asserts many more signals in the row decoder



1. Keep the previously
asserted signals active

2. Decode Row B &
assert **corresponding signals**

3. Follow
newly asserted nodes' path

4. Simultaneously
activate many rows

Hypothesis: Row Decoder Circuitry



Simultaneous Many-Row Activation in Off-the-Shelf DRAM Chips: Experimental Characterization and Analysis

İsmail Emir Yüksel¹ Yahya Can Tuğrul^{1,2} F. Nisa Bostancı¹ Geraldo F. Oliveira¹
A. Giray Yağlıkçı¹ Ataberk Olgun¹ Melina Soysal¹ Haocong Luo¹
Juan Gómez-Luna¹ Mohammad Sadrosadati¹ Onur Mutlu¹
¹*ETH Zürich* ²*TOBB University of Economics and Technology*

(More discussions & hypotheses in the paper)

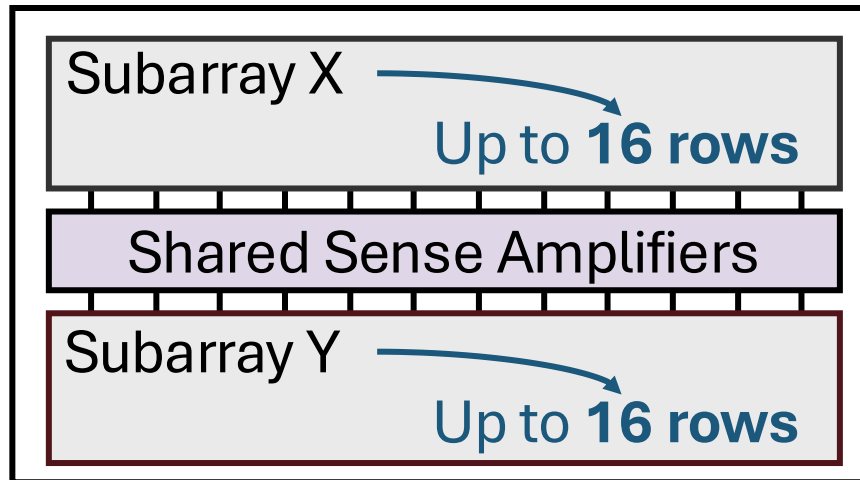
<https://arxiv.org/pdf/2405.06081>

Key Results

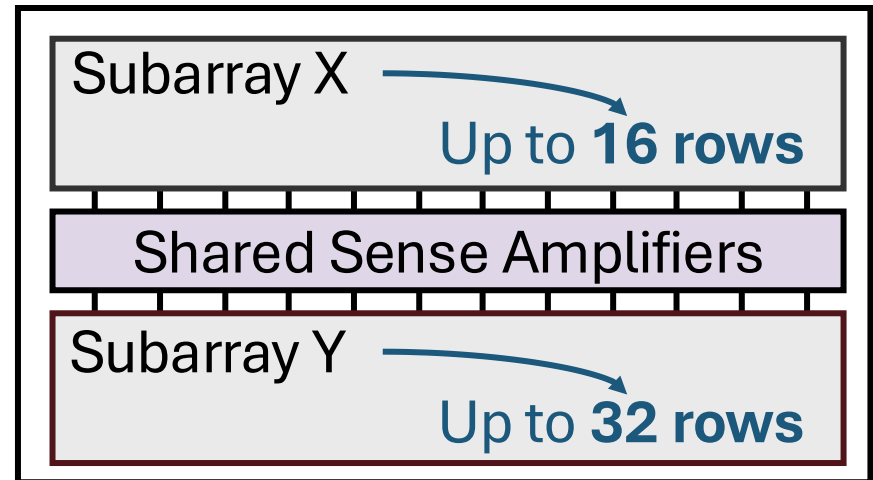
COTS DRAM chips have **two distinct** sets of activation patterns in **neighboring subarrays** when two rows are activated with **violated timings**

Exactly the same number of rows in each subarray are activated

Twice as many rows in one subarray compared to its neighbor subarray are activated



A total of **32 rows**



A total of **48 rows**

The Capability of COTS DRAM Chips

We demonstrate that COTS DRAM chips:

1

Can simultaneously activate up to 48 rows in two neighboring subarrays

2

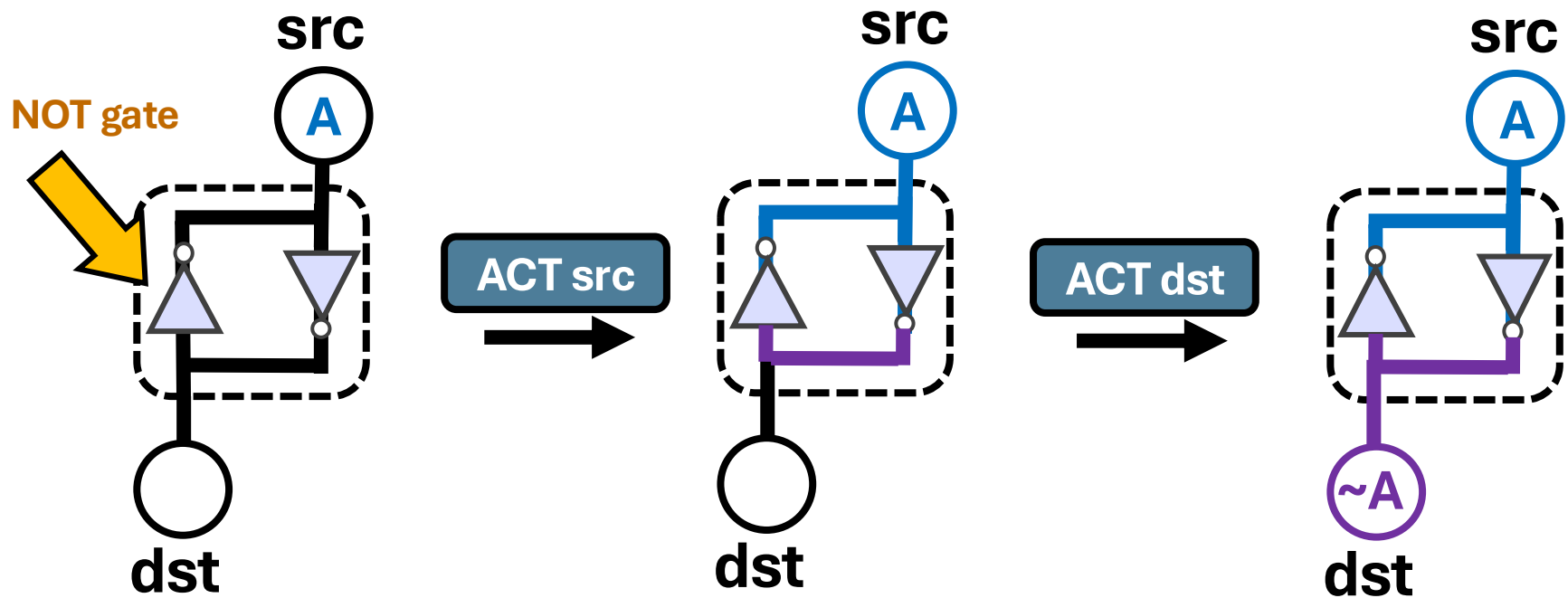
Can perform **NOT operation** with up to **32 output operands**

3

Can perform up to 16-input **AND, NAND, OR, and NOR** operations

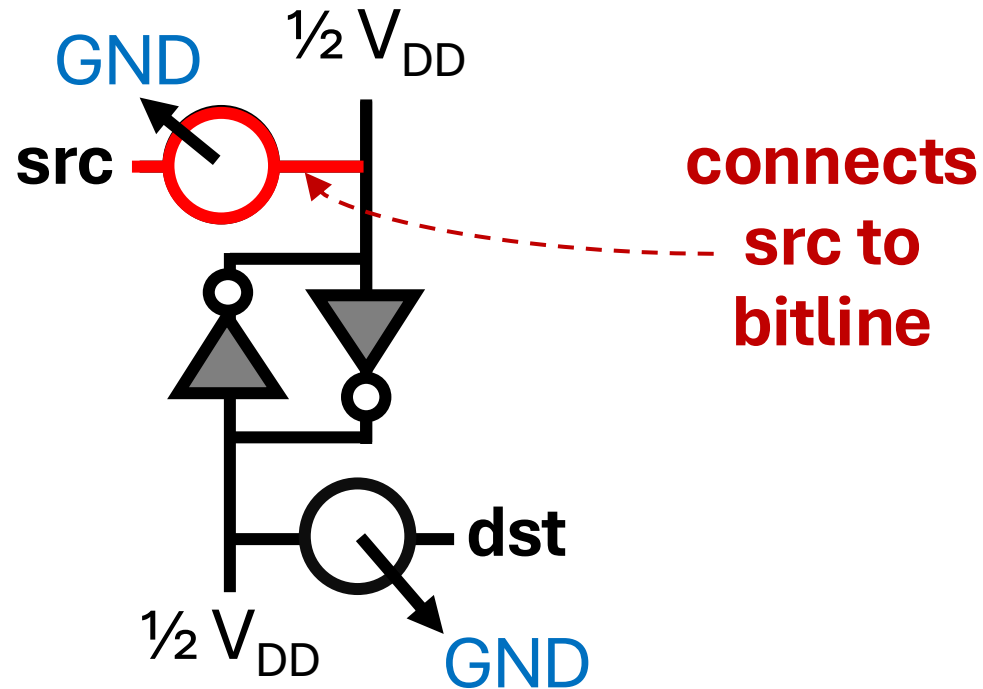
Key Idea

Connect rows in neighboring subarrays through a **NOT gate** by simultaneously activating rows

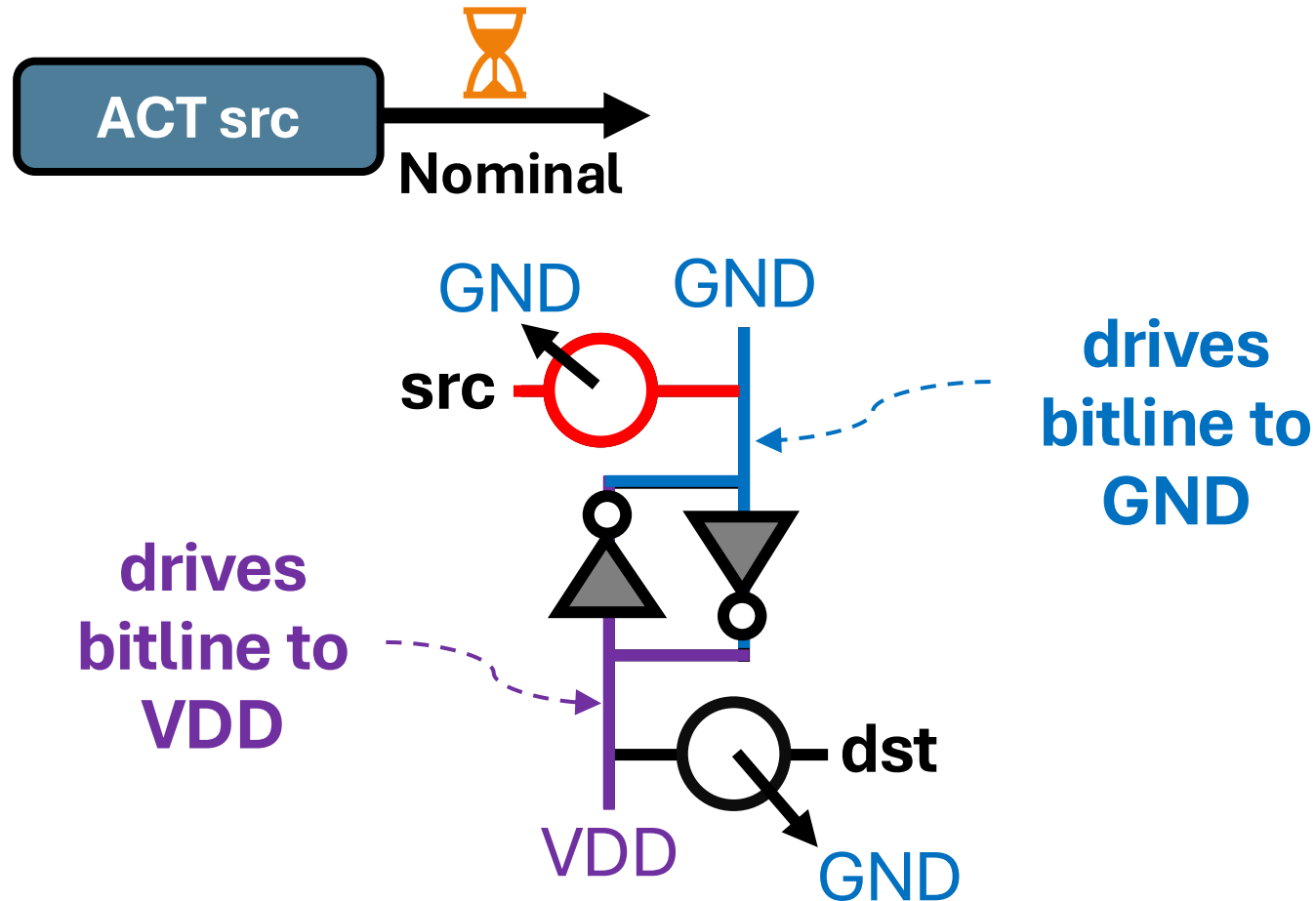


NOT Operation: A Walkthrough

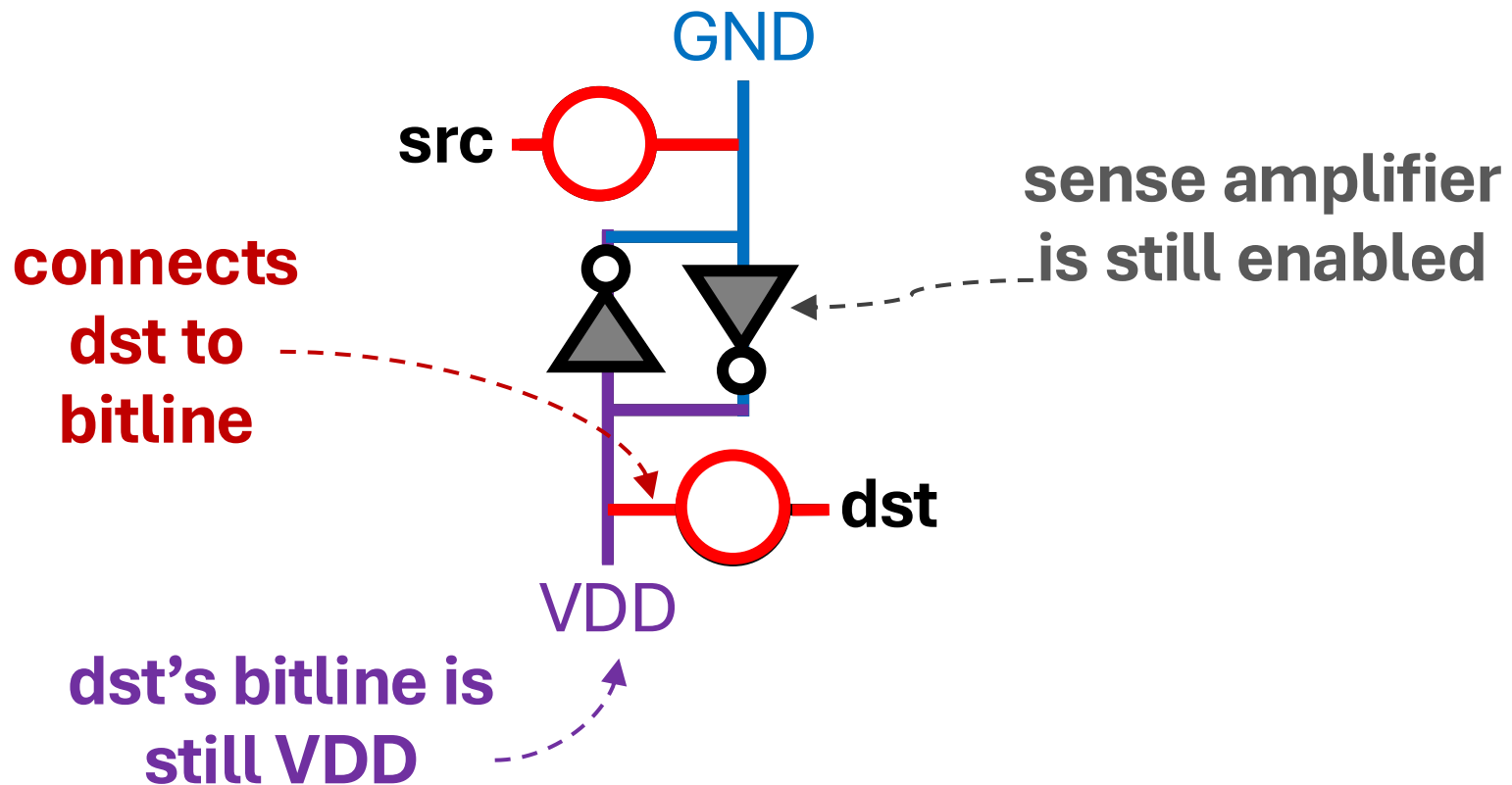
ACT src



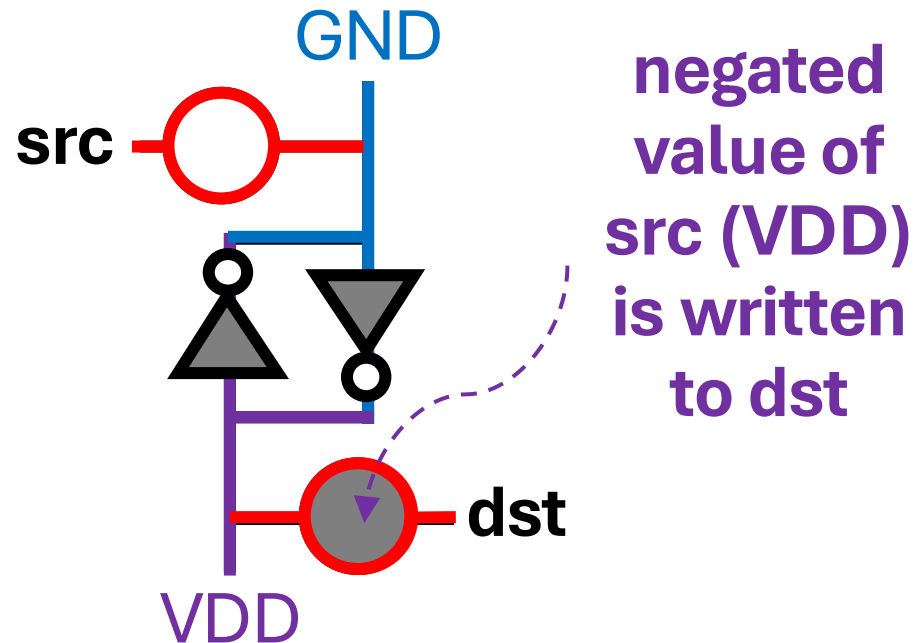
NOT Operation: A Walkthrough



NOT Operation: A Walkthrough



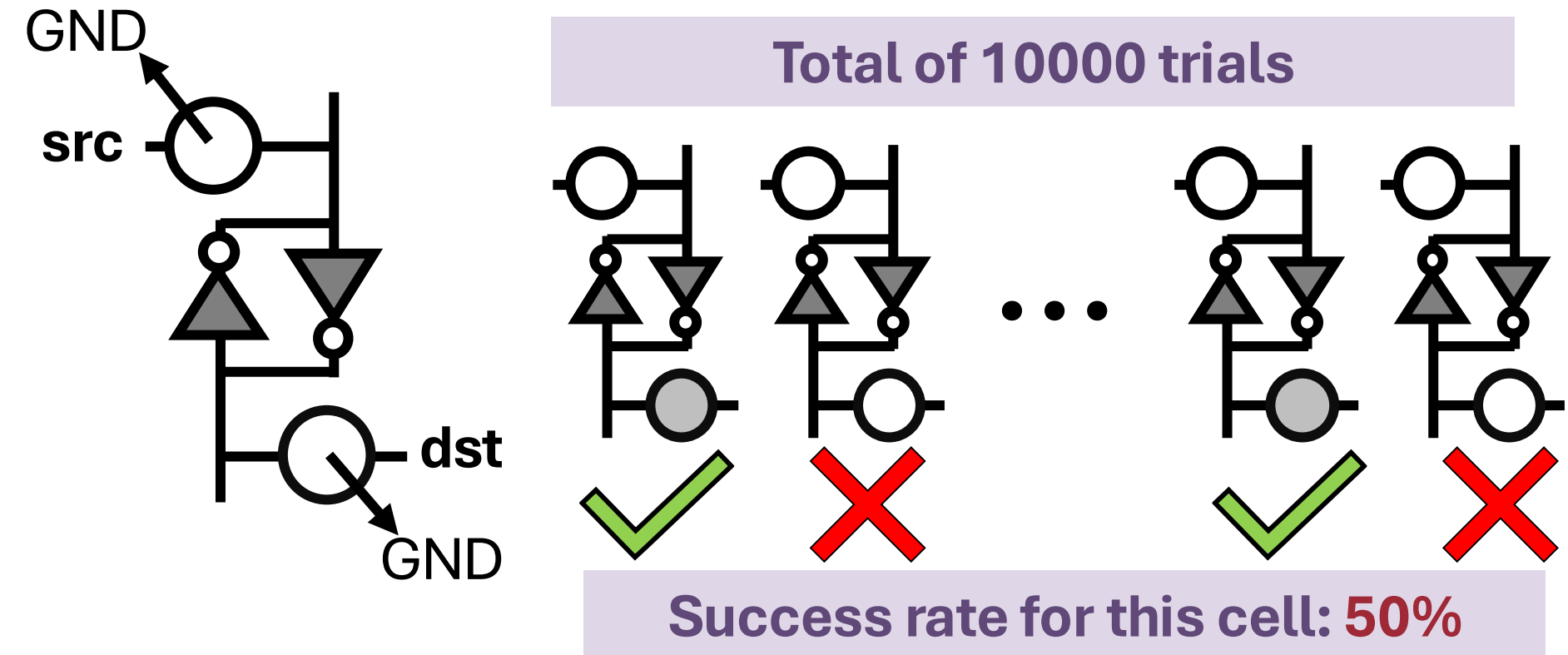
NOT Operation: A Walkthrough



Reliability Metric

Success Rate (for a DRAM cell)

Percentage of trials where the **correct output** of a tested operation is stored in the cell



Key Takeaways from In-DRAM NOT Operation

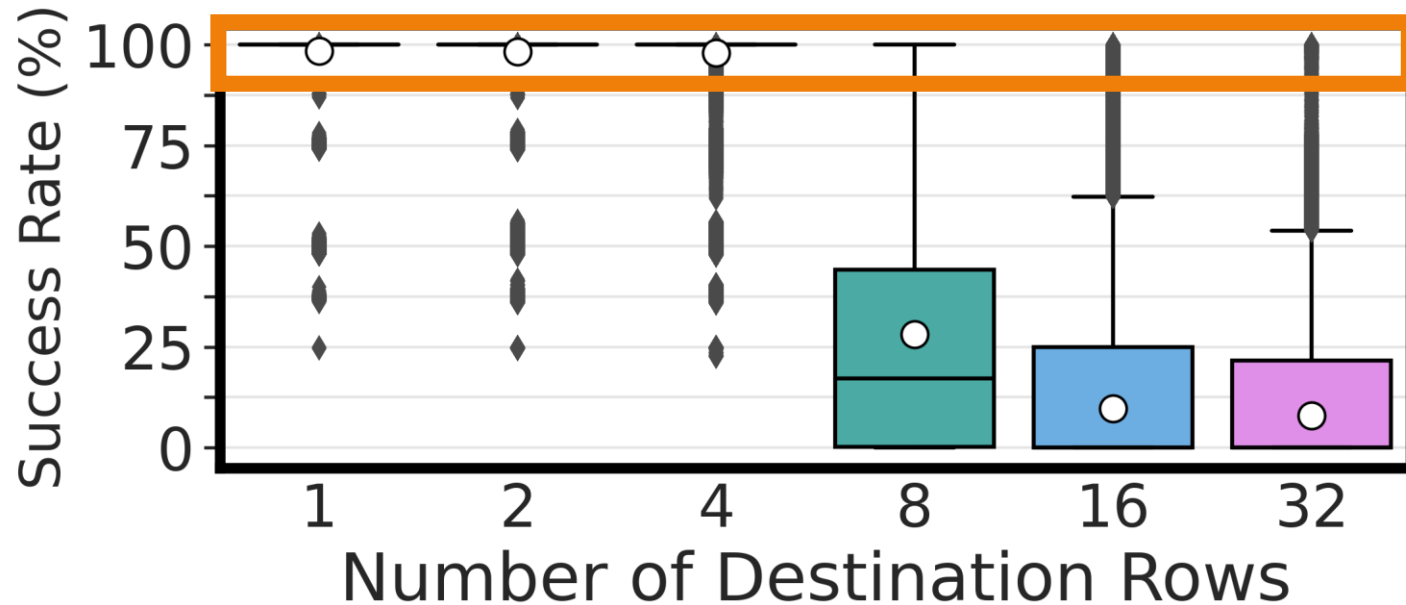
Key Takeaway 1

COTS DRAM chips can perform NOT operations with up to 32 destination rows

Key Takeaway 2

Temperature has a small effect on the reliability of NOT operations

Performing NOT in COTS DRAM Chips



There is **at least one DRAM cell** that can perform the **NOT operation** with a **100% success rate**

COTS DRAM chips can perform NOT operations with up to 32 destination rows

The Capability of COTS DRAM Chips

We demonstrate that COTS DRAM chips:

1

Can simultaneously activate up to 48 rows in two neighboring subarrays

2

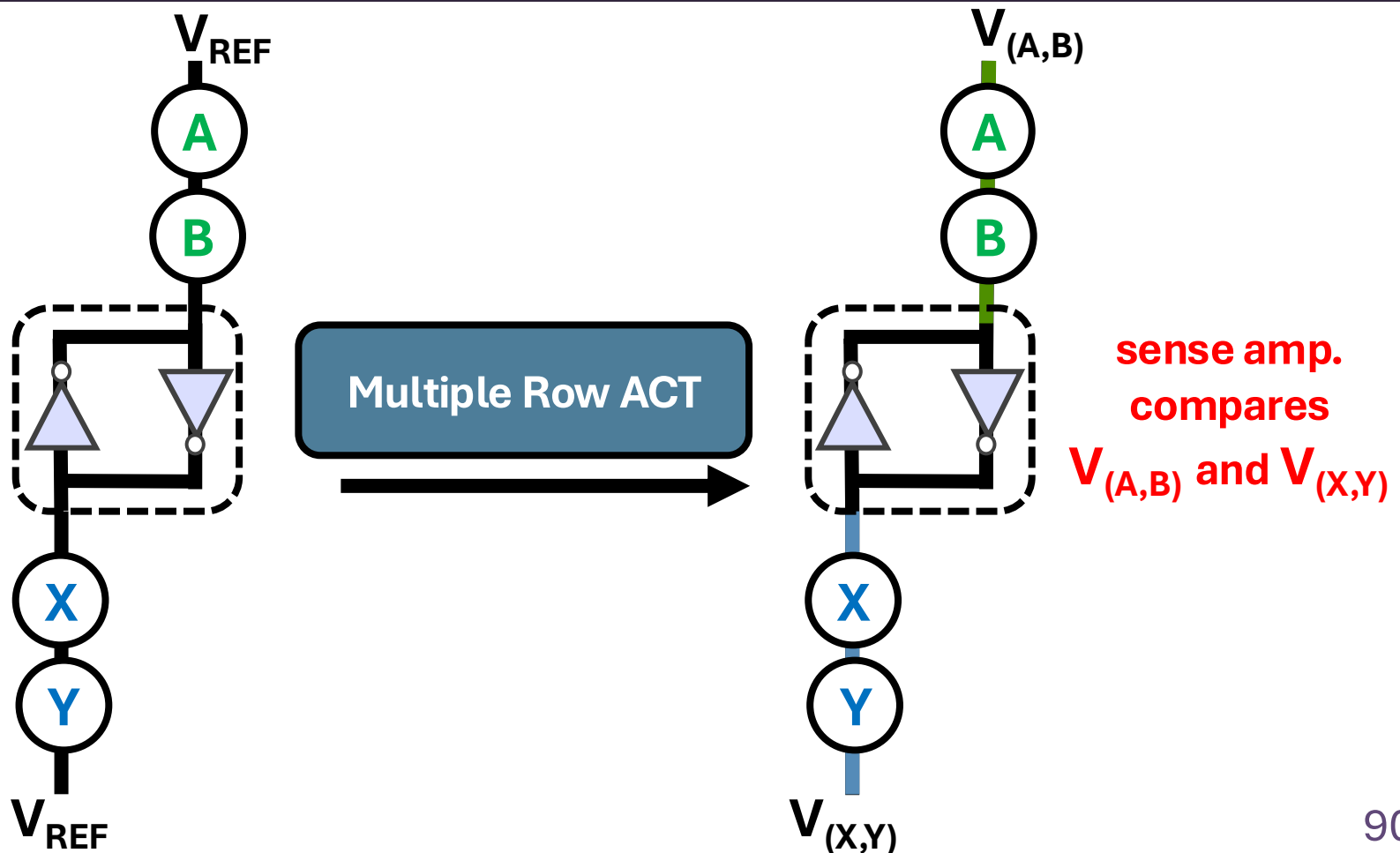
Can perform NOT operation with up to 32 output operands

3

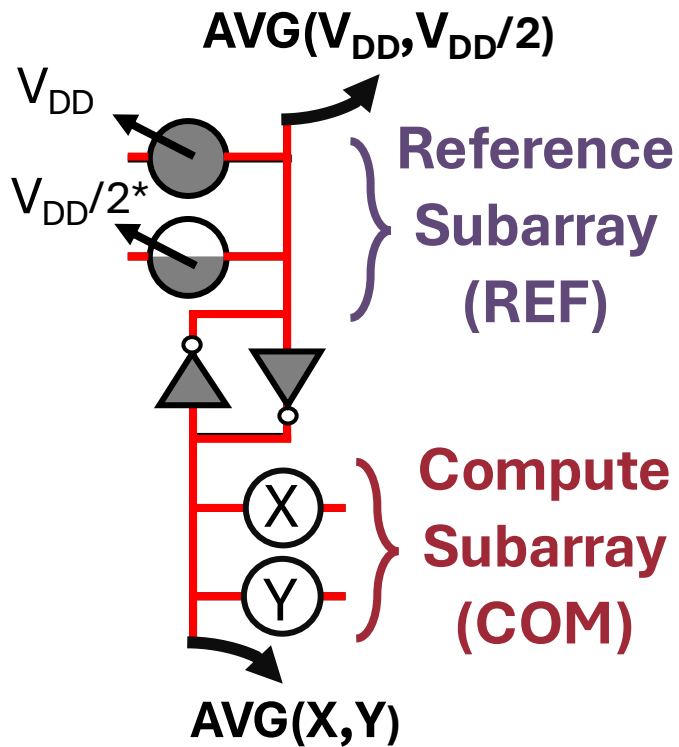
Can perform up to **16-input AND, NAND, OR, and NOR** operations

Key Idea

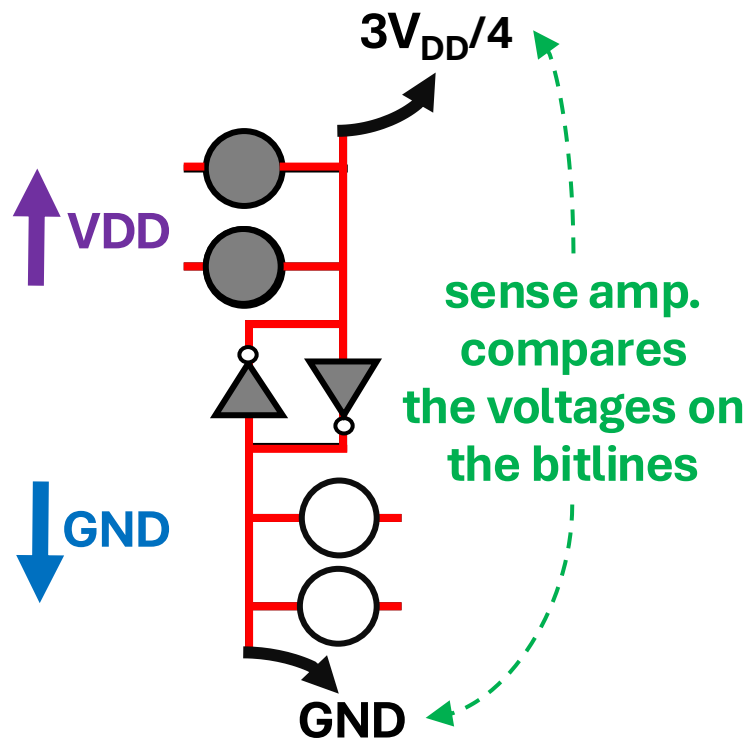
Manipulate the bitline voltage to express
a wide variety of functions using
multiple-row activation in neighboring subarrays



Two-Input AND and NAND Operations



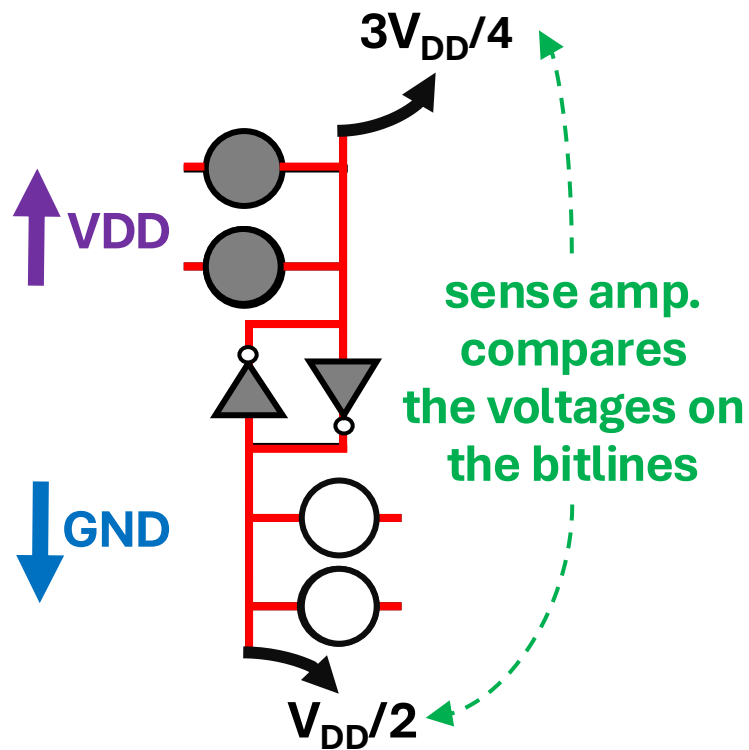
Two-Input AND and NAND Operations



$V_{DD}=1$ & $GND=0$

X	Y	COM	REF
0	0	0	1

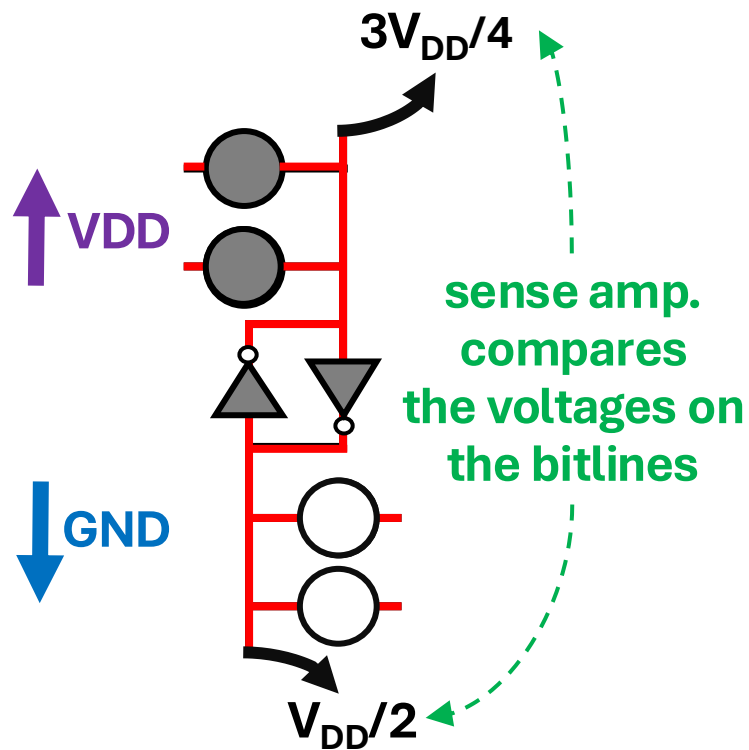
Two-Input AND and NAND Operations



$V_{DD}=1$ & $GND=0$

X	Y	COM	REF
0	0	0	1
0	1	0	1

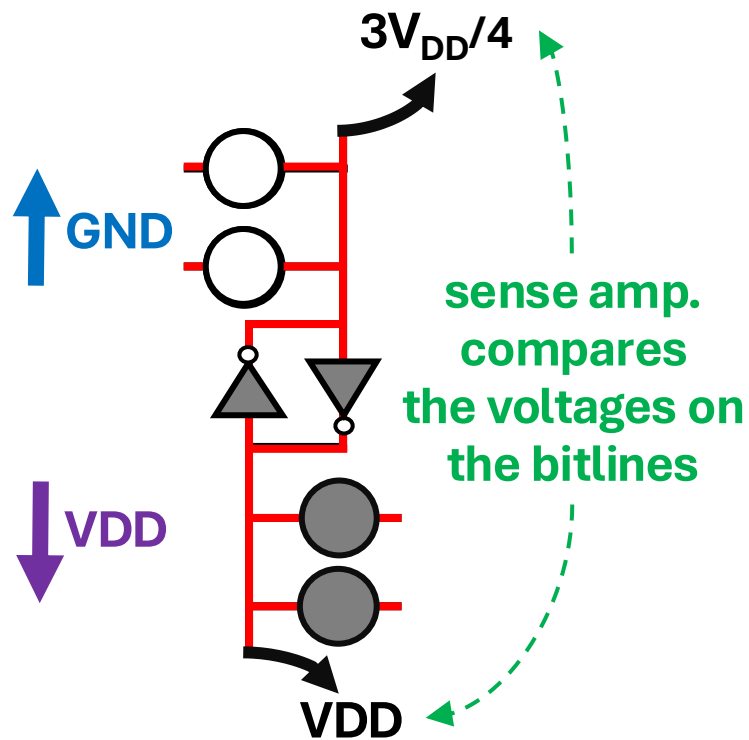
Two-Input AND and NAND Operations



$V_{DD}=1$ & $GND=0$

X	Y	COM	REF
0	0	0	1
0	1	0	1
1	0	0	1

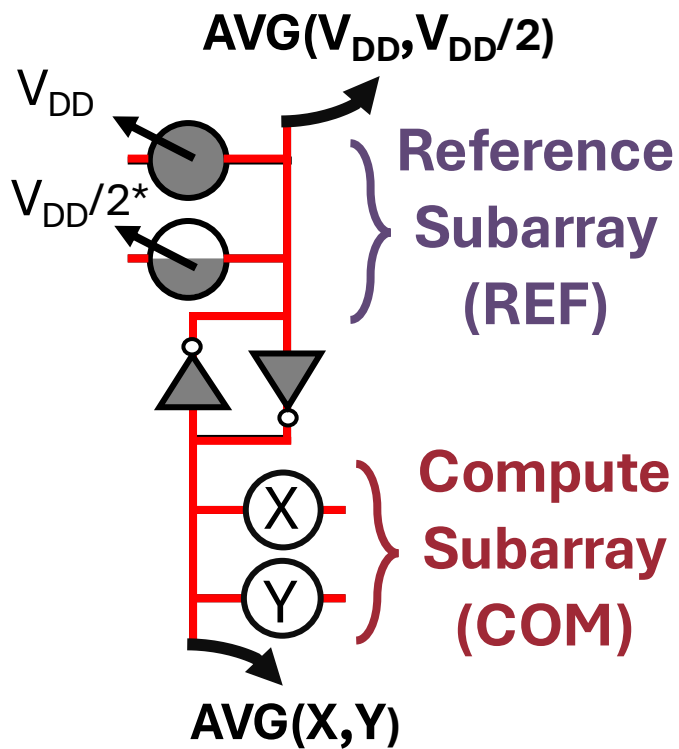
Two-Input AND and NAND Operations



$V_{DD}=1$ & $GND=0$

X	Y	COM	REF
0	0	0	1
0	1	0	1
1	0	0	1
1	1	1	0

Two-Input AND and NAND Operations



$V_{DD}=1$ & $GND=0$

X	Y	COM	REF
0	0	0	1
0	1	0	1
1	0	0	1
1	1	1	0
		AND	NAND

Key Takeaways from In-DRAM Operations

Key Takeaway 1

**COTS DRAM chips can perform
{2, 4, 8, 16}-input AND, NAND, OR, and NOR operations**

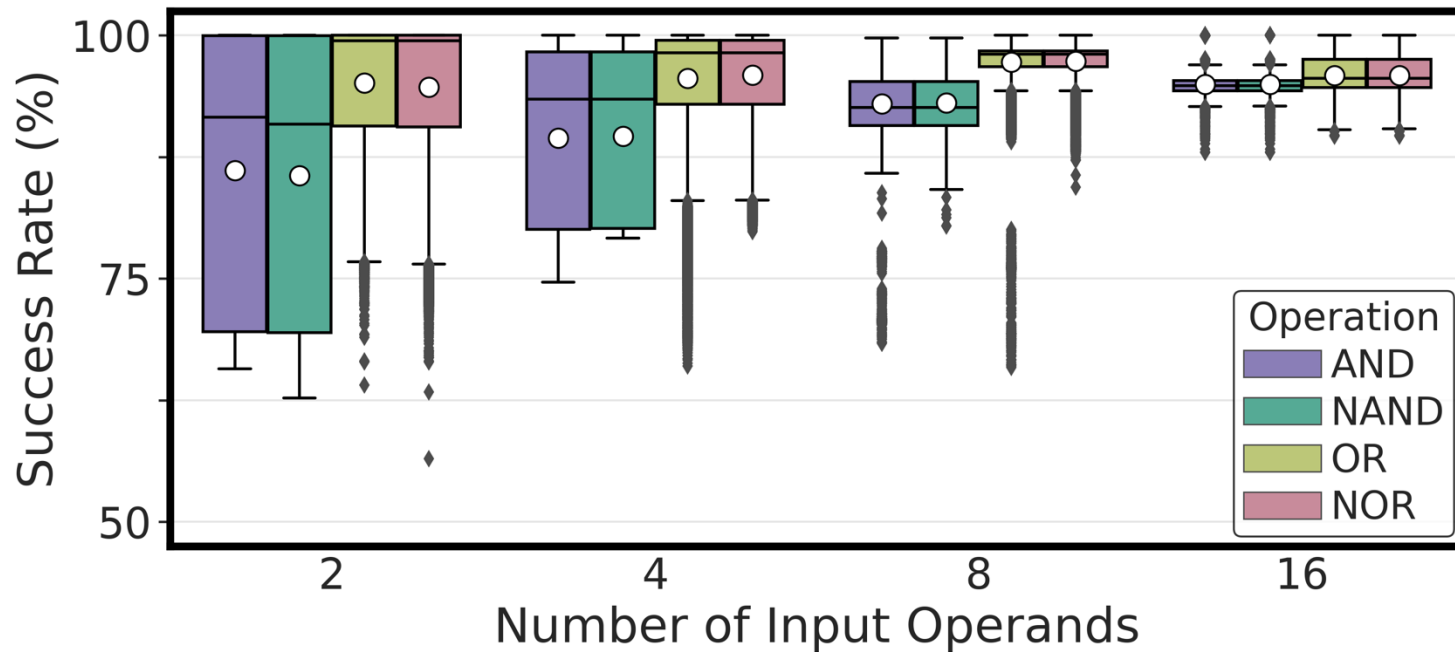
Key Takeaway 2

**COTS DRAM chips can perform
AND, NAND, OR, and NOR operations
with very high reliability**

Key Takeaway 3

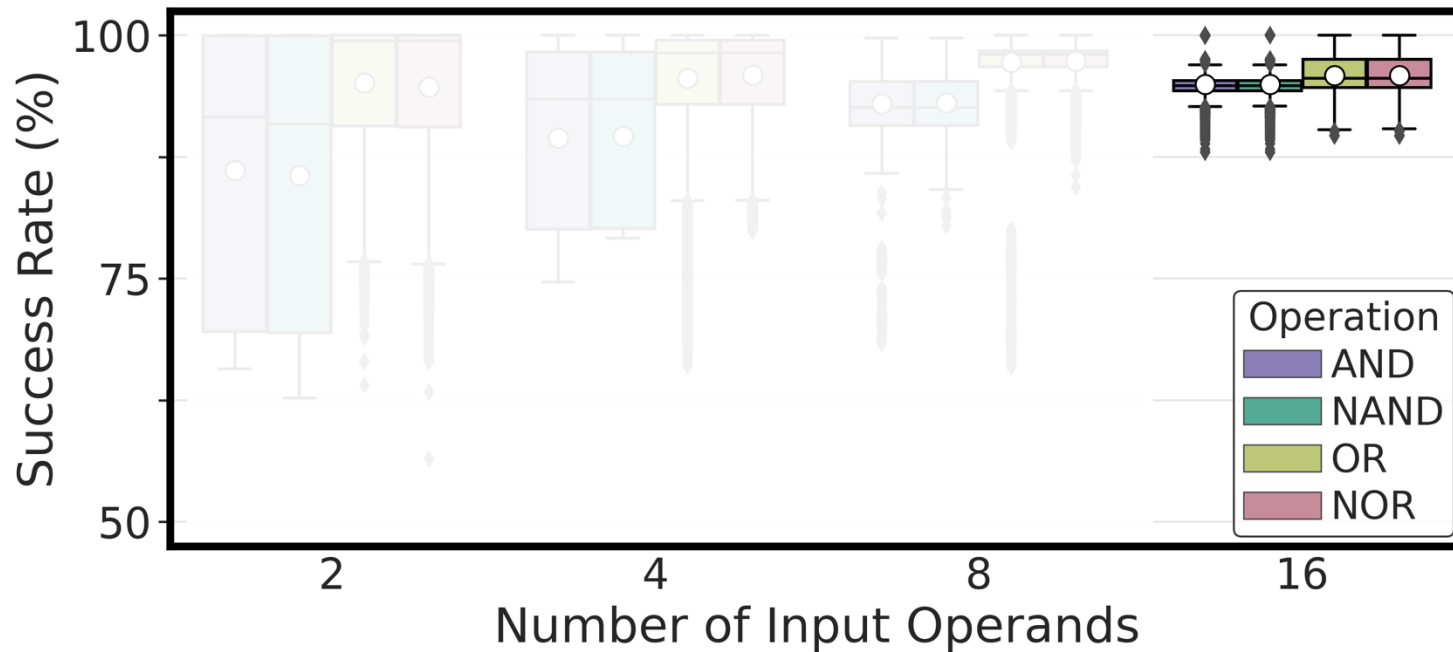
**Data pattern slightly affects
the reliability of AND, NAND, OR, and NOR operations**

Performing AND, NAND, OR, and NOR



**COTS DRAM chips can perform
{2, 4, 8, 16}-input AND, NAND, OR, and NOR operations**

Performing AND, NAND, OR, and NOR



**COTS DRAM chips can perform
16-input AND, NAND, OR, and NOR operations
with very high success rate (>94%)**

Functionally-Complete Boolean Logic in Real DRAM Chips: Experimental Characterization and Analysis

İsmail Emir Yüksel Yahya Can Tuğrul Ataberk Olgun F. Nisa Bostancı A. Giray Yağlıkçı
Geraldo F. Oliveira Haocong Luo Juan Gómez-Luna Mohammad Sadrosadati Onur Mutlu

ETH Zürich

Processing-using-DRAM (PuD) is an emerging paradigm that leverages the analog operational properties of DRAM circuitry to enable massively parallel in-DRAM computation. PuD has the potential to significantly reduce or eliminate costly data movement between processing elements and main memory. A common approach for PuD architectures is to make use of bulk bitwise computation (e.g., AND, OR, NOT). Prior works experimentally demonstrate three-input MAJ (i.e., MAJ3) and two-input AND and OR operations in commercial off-the-shelf (COTS) DRAM chips. Yet, demonstrations on COTS DRAM chips do not provide a functionally complete set of operations (e.g., NAND or AND and NOT).

We experimentally demonstrate that COTS DRAM chips are capable of performing 1) functionally-complete Boolean operations: NOT, NAND, and NOR and 2) many-input (i.e., more than two-input) AND and OR operations. We present an extensive

systems and applications [12, 13]. Processing-using-DRAM (PuD) [29–32] is a promising paradigm that can alleviate the data movement bottleneck. PuD uses the analog operational properties of the DRAM circuitry to enable massively parallel in-DRAM computation. Many prior works [29–53] demonstrate that PuD can greatly reduce or eliminate data movement.

A widely used approach for PuD is to perform bulk bitwise operations, i.e., bitwise operations on large bit vectors. To perform bulk bitwise operations using DRAM, prior works propose modifications to the DRAM circuitry [29–31, 33, 35, 36, 43, 44, 46, 48–58]. Recent works [38, 41, 42, 45] experimentally demonstrate the feasibility of executing data copy & initialization [42, 45], i.e., the RowClone operation [49], and a subset of bitwise operations, i.e., three-input bitwise majority (MAJ3) and two-input AND and OR operations in unmodified commercial off-the-shelf (COTS) DRAM chips by operating beyond

<https://arxiv.org/pdf/2402.18736.pdf>

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Functionally-Complete Boolean Logic in Real DRAM Chips: Experimental Characterization and Analysis

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Academic Code

Made with C/C++

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Contributions welcome

cs.AR 2402.18736

This repository source code of our [HPCA'24 paper](#).

About

Source code & scripts for experimental characterization and demonstration of performing NOT and up to 16-input AND, NAND, OR, and NOR operations in real DDR4 DRAM chips. Described in our HPCA'24 paper by Yuksel et al. at <https://arxiv.org/abs/2402.18736>

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101

Functionally-Complete Boolean Logic in Real DRAM Chips

Experimental Characterization and Analysis

Ismail Emir Yüksel

Yahya C. Tugrul Ataberk Olgun F. Nisa Bostancı

A. Giray Yaglıkçı Geraldo F. Oliveira Haocong Luo

Juan Gómez–Luna Mohammad Sadr Onur Mutlu

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Simultaneous Many-Row Activation in Off-the-Shelf DRAM Chips

Experimental Characterization and Analysis



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Juan Gómez–Luna Mohammad Sadr Onur Mutlu

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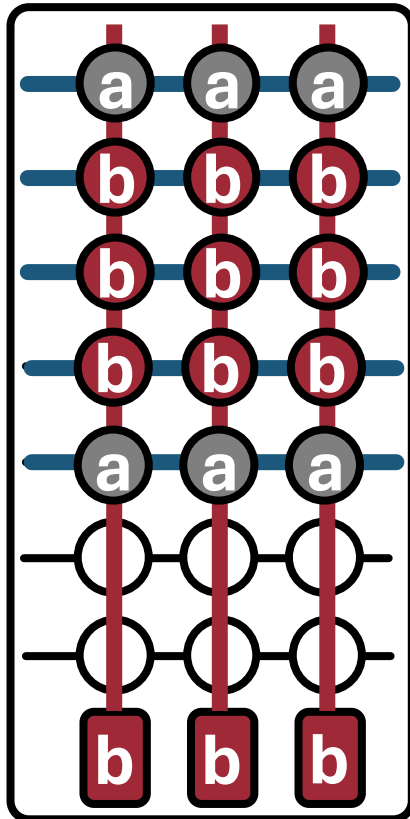
Leveraging Simultaneous Many-Row Activation

- 1** Perform **MAJX** (where $X > 3$) operations
- 2** Increase the **robustness** of MAJX operations
- 3** Copy **one row's content** to **multiple rows**

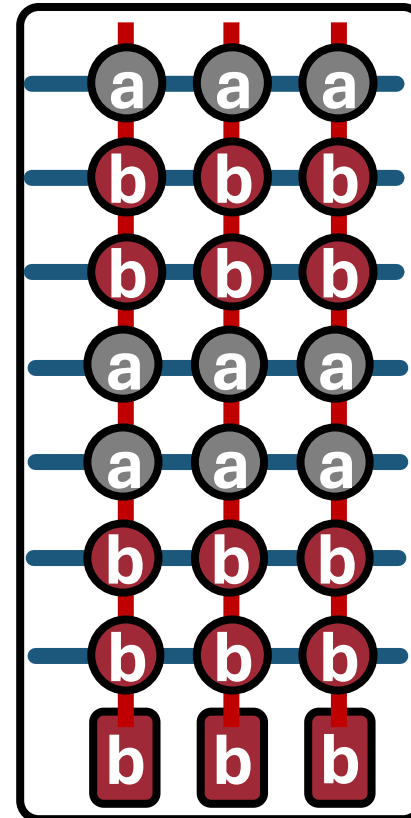
In-DRAM Majority-of-X (MAJX)

Simultaneously activate many rows to perform **MAJX (where $X > 3$)** operations

$$\text{MAJ5}(a, b, b, b, a) = b$$

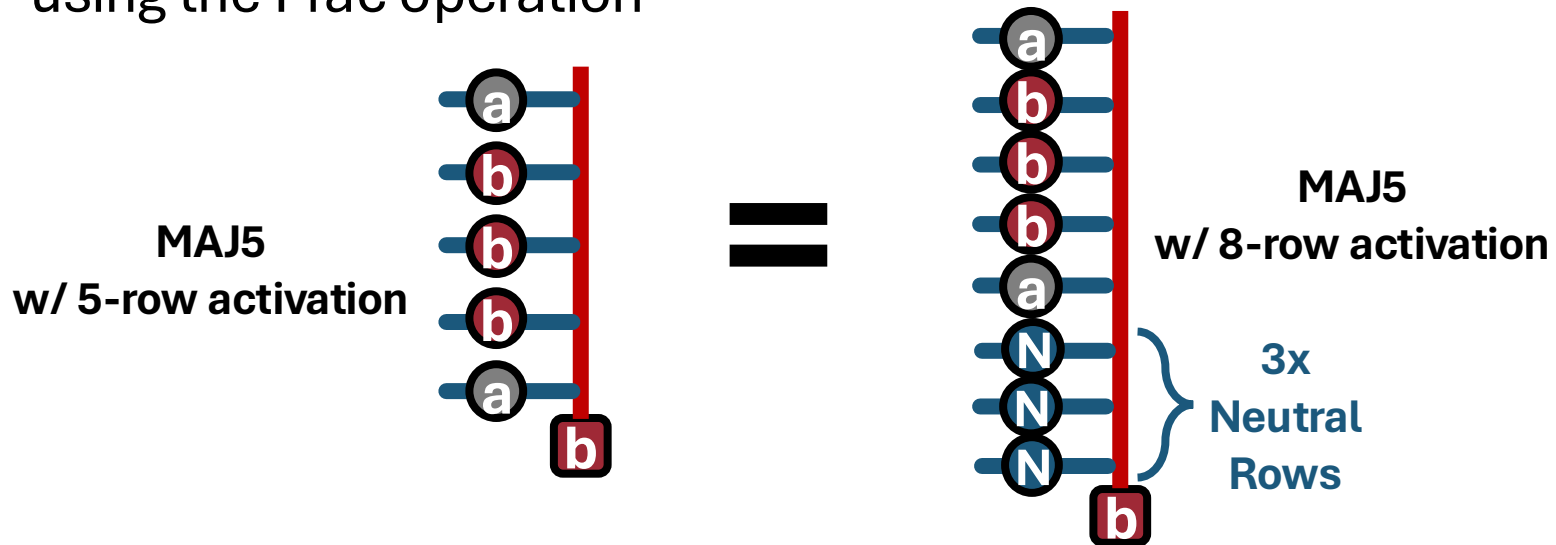


$$\text{MAJ7}(a, b, b, a, a, b, b) = b$$



MAJX in Real DRAM Chips

- For MAJX, we need to activate X rows simultaneously
- We can only simultaneously activate 2, 4, 8, 16, and 32 rows
- **Question**
 - How do we perform **MAJX** while simultaneously activating **more than X rows**?
- **Answer**
 - Making **some rows neutral** during the MAJX operation using the Frac operation*



*[Gao+MICRO'22]

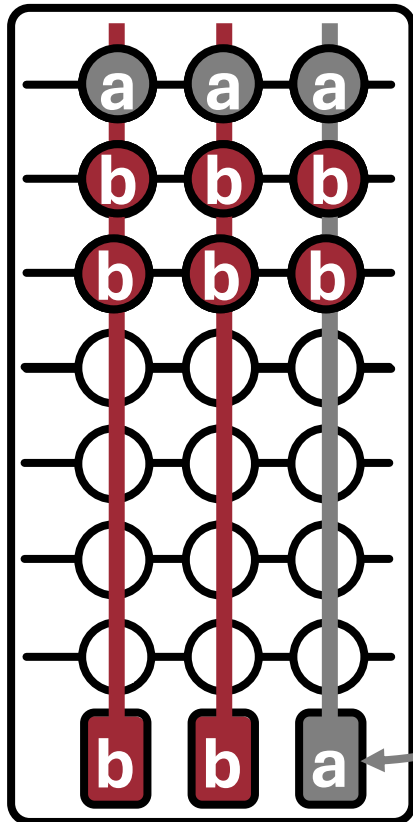
Leveraging Simultaneous Many-Row Activation

- 1 Perform MAJX (where $X > 3$) operations
- 2 Increase the robustness** of MAJX operations
- 3 Copy one row's content to multiple rows

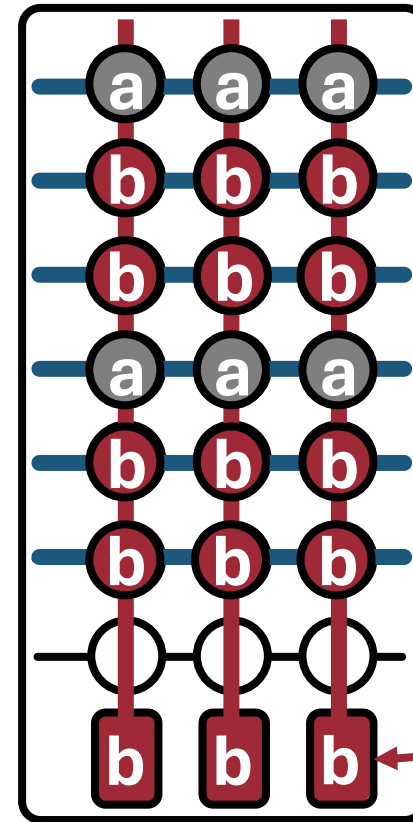
Improving the Robustness (Input Replication)

Storing **multiple copies** of MAJX input operands can **increase the robustness** of MAJX operations

$$\text{MAJ3}(a, b, b) = b$$

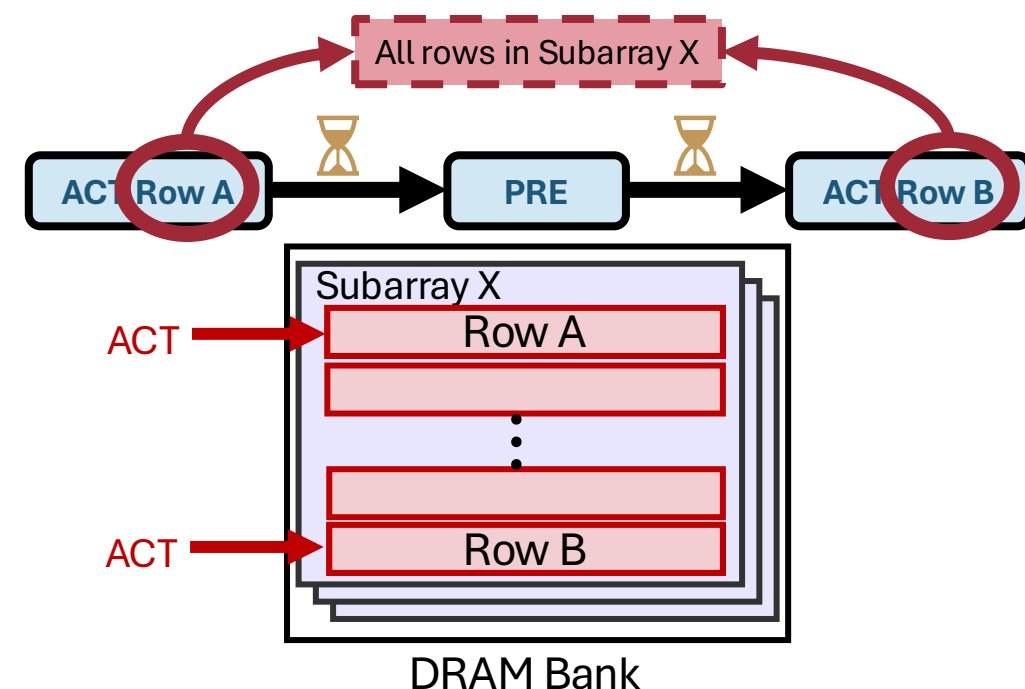


$$\text{MAJ6}(a, b, b, a, b, b) = b$$



Characterization Methodology

- Carefully sweep
 - Row addresses: Row A and Row B
 - Timing parameters: Between ACT → PRE and PRE → ACT
 - Temperature (°C): 50, 60, 70, 80, and 90
 - Wordline Voltage (V): 2.5, 2.4, 2.3, 2.2, and 2.1



Temperature



50 °C → 90 °C

Wordline Voltage



2.5V → 2.1V

Key Takeaways from MAJX Operation

Key Takeaway 1

COTS DRAM chips are capable of performing MAJ5, MAJ7, and MAJ9 operations

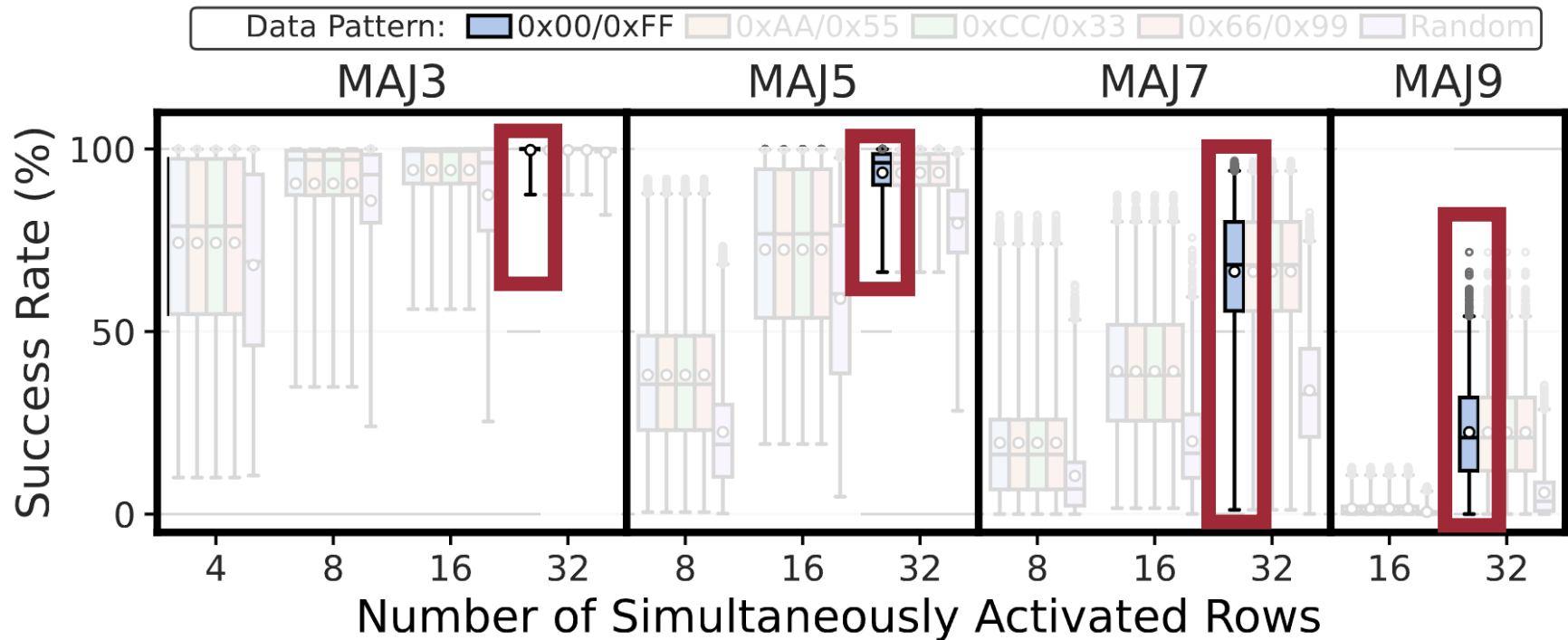
Key Takeaway 2

Storing multiple copies of MAJX's input operands significantly increases the MAJX's success rate

Key Takeaway 3

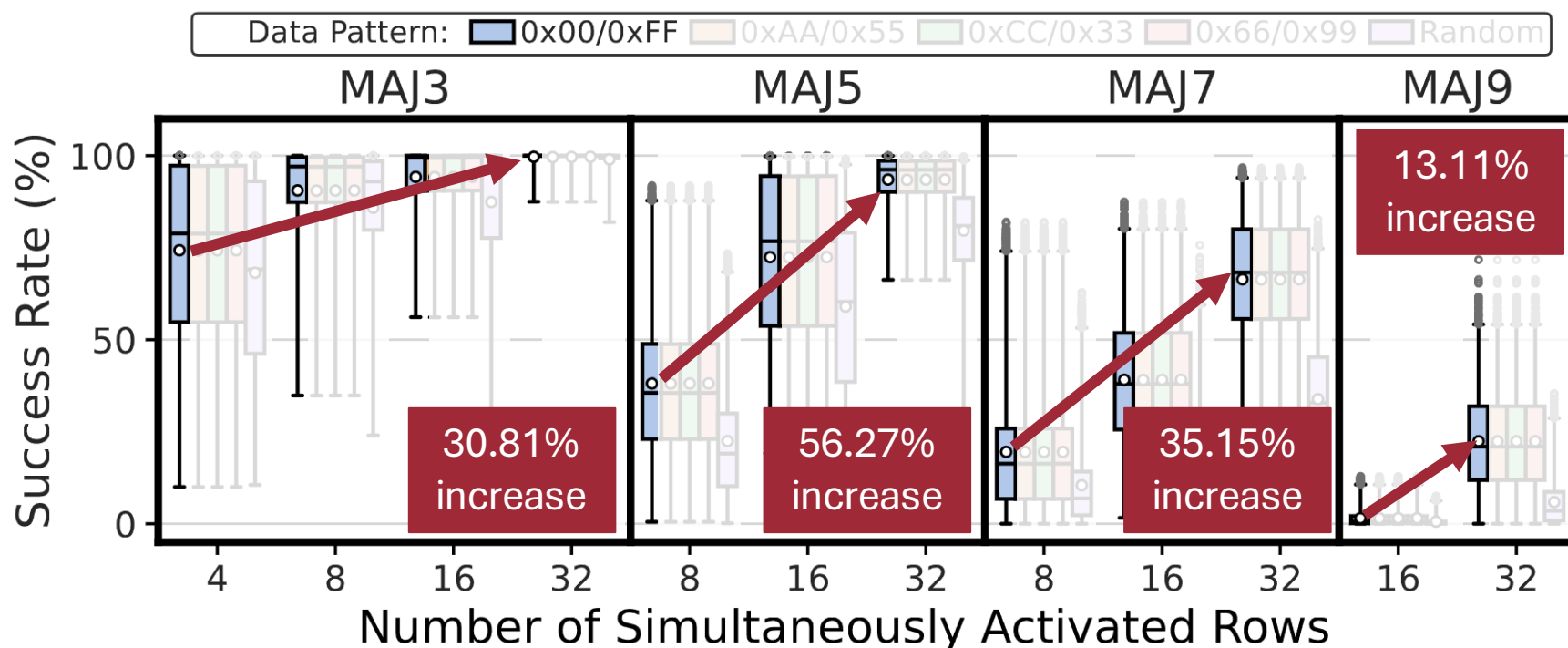
Voltage and temperature slightly affect the success rate, whereas data pattern affects significantly

Robustness of MAJX Operations



COTS DRAM chips are capable of performing MAJ5, MAJ7, and MAJ9 operations

Impact of Input Replication



Similar trend in success rate increase in all tested MAJX operations

Final average success rate MAJ3 (MAJ5): 99.68% (93.49%)

Storing multiple copies of MAJ's input operands increases the success rate of MAJ3, MAJ5, MAJ7, and MAJ9 operations

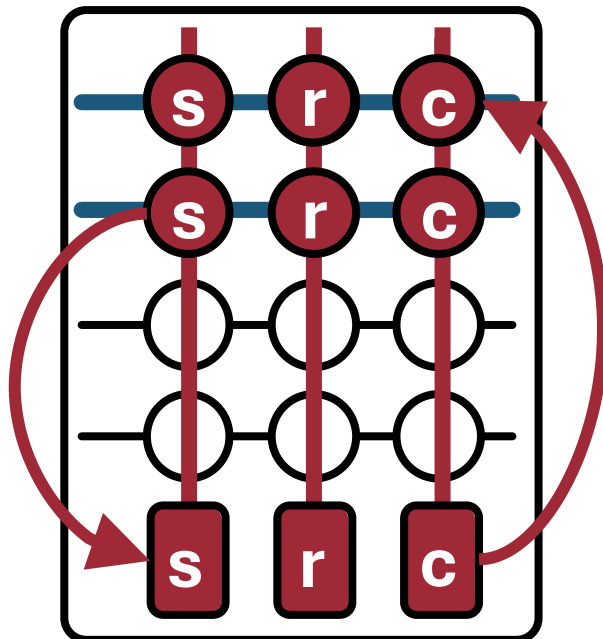
Leveraging Simultaneous Many-Row Activation

- 1 Perform **MAJX** (where $X > 3$) operations
- 2 Increase the robustness of MAJX operations
- 3 Copy **one row's content** to **multiple rows**

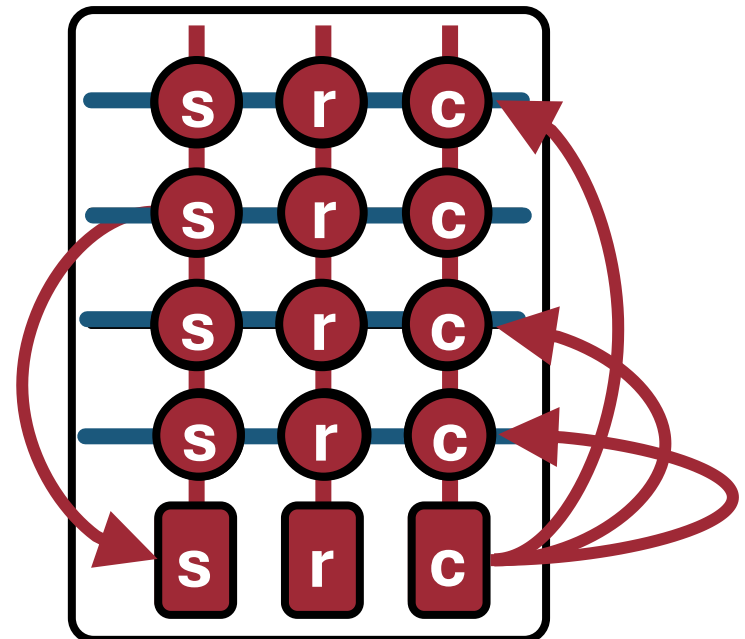
In-DRAM Multiple Row Copy (Multi-RowCopy)

Simultaneously activate many rows to copy **one row's content** to **multiple destination rows**

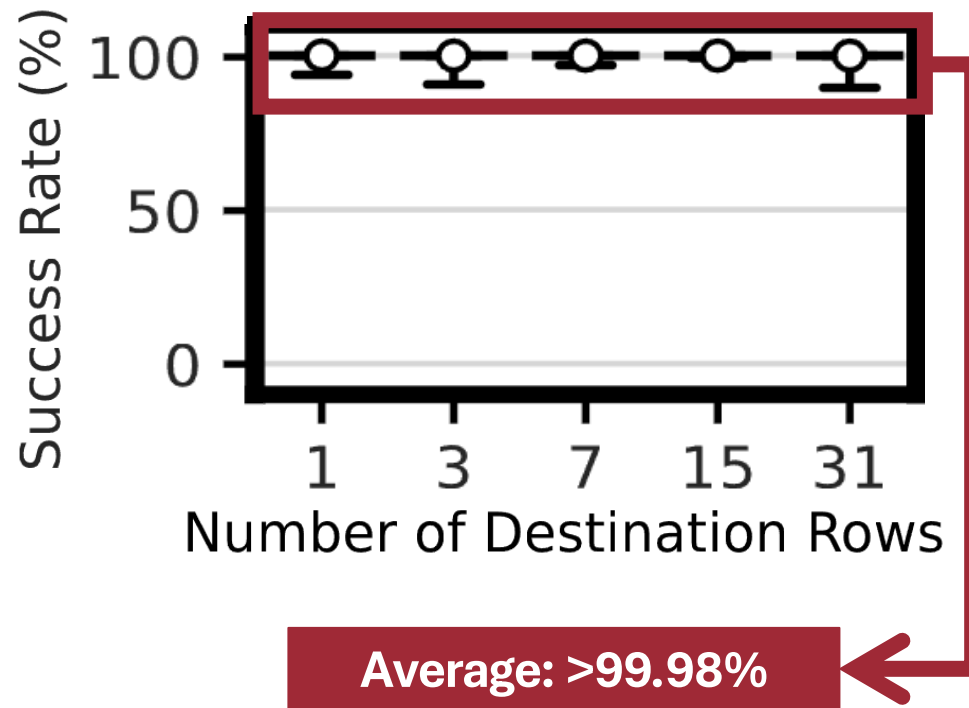
RowClone



Multi-RowCopy



Robustness of Multi-RowCopy



COTS DRAM chips can copy one row's content to up to 31 rows with a very high success rate



Code
Reproducible



Dataset
Reproducible

Simultaneous Many-Row Activation in Off-the-Shelf DRAM Chips: Experimental Characterization and Analysis

İsmail Emir Yüksel¹ Yahya Can Tuğrul^{1,2} F. Nisa Bostancı¹ Geraldo F. Oliveira¹
A. Giray Yağlıkçı¹ Ataberk Olgun¹ Melina Soysal¹ Haocong Luo¹
Juan Gómez-Luna¹ Mohammad Sadrosadati¹ Onur Mutlu¹

¹ETH Zürich ²TOBB University of Economics and Technology

*We experimentally analyze the computational capability of commercial off-the-shelf (COTS) DRAM chips and the robustness of these capabilities under various timing delays between DRAM commands, data patterns, temperature, and voltage levels. We extensively characterize 120 COTS DDR4 chips from two major manufacturers. We highlight four key results of our study. First, COTS DRAM chips are capable of 1) simultaneously activating up to 32 rows (i.e., simultaneous many-row activation), 2) executing a majority of X (MAJX) operation where $X > 3$ (i.e., MAJ5, MAJ7, and MAJ9 operations), and 3) copying a DRAM row (concurrently) to up to 31 other DRAM rows, which we call **MuLt-i-RowCopy**. Second, storing multiple copies of MAJX's input operands on all simultaneously activated rows drastically increases the success rate (i.e., the percentage of DRAM cells that correctly perform the computation) of the MAJX operation. For example, MAJ3 with 32-row activation (i.e.,*

*A subset of PIM proposals devise mechanisms that enable PUM using DRAM cells for computation, including data copy and initialization [67, 72, 77, 78, 89, 104, 127], Boolean logic [56, 64–66, 68, 70, 72, 76, 79, 122, 127–129], majority-based arithmetic [64, 66, 69, 72, 91, 127, 130, 131], and lookup table based operations [82, 106, 107, 132]. We refer to DRAM-based PUM as *Processing-Using-DRAM (PUD)* and the computation performed using DRAM cells as PUD operations.*

PUD benefits from the bulk data parallelism in DRAM devices to perform bulk bitwise PUD operations. Prior works show that bulk bitwise operations are used in a wide variety of important applications, including databases and web search [64, 67, 79, 130, 133–140], data analytics [64, 141–144], graph processing [56, 80, 94, 130, 145], genome analysis [60, 99, 146–149], cryptography [150, 151], set operations [56, 64], and hyper-dimensional computing [152–154].

<https://arxiv.org/pdf/2405.06081>

Our Work is Open Source and Artifact Evaluated



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Simultaneous Many-Row Activation in Off-the-Shelf DRAM Chips: Experimental Characterization and Analysis

Source code & scripts for experimental characterization and demonstration of 1) simultaneous many-row activation, 2) up to nine-input majority operations and 3) copying one row's content to up 31 rows in real DDR4 DRAM chips. Described in our DSN'24 paper by Yuksel et al. at <https://arxiv.org/abs/2405.06081>

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<https://github.com/CMU-SAFARI/SiMRA-DRAM>

Simultaneous Many-Row Activation in Off-the-Shelf DRAM Chips

Experimental Characterization and Analysis

Paper



GitHub



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PuDHammer

Experimental Analysis of Read Disturbance Effects of Processing-using-DRAM in Real DRAM Chips

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Akash Sood Ataberk Olgun Oğuzhan Canpolat Haocong Luo

Nisa Bostancı Mohammad Sadrosadati Giray Yağlıkçı Onur Mutlu

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Executive Summary

Motivation: Processing-using-DRAM (PuD) alleviates data movement bottlenecks

- DRAM can perform **many** PuD operations by activating **multiple DRAM rows** in quick succession or simultaneously (i.e., **multiple-row activation**)
- Modern DRAM is subject to **read disturbance** (e.g., RowHammer)
 - Repeatedly activating **even a single** row induces **bitflips** in **unaccessed** rows

Problem: No prior work studies the read disturbance effects of multiple-row activation

Goal: Understand and analyze read disturbance effects of **multiple-row activation**

Experimental Study: 316 COTS DDR4 chips from **four** major manufacturers to study read disturbance effects of multiple-row activation, which we call **PuDHammer**

- PuDHammer significantly **exacerbates** DRAM read disturbance, causing up to **158.58x reduction** in min. hammer count to induce first bitflip
- PuDHammer bypasses in-DRAM RowHammer mitigation in DDR4 and induces **1 1340x** more bitflips than RowHammer

Mitigation: We adapt Per Row Activation Counting (PRAC) for PuDHammer

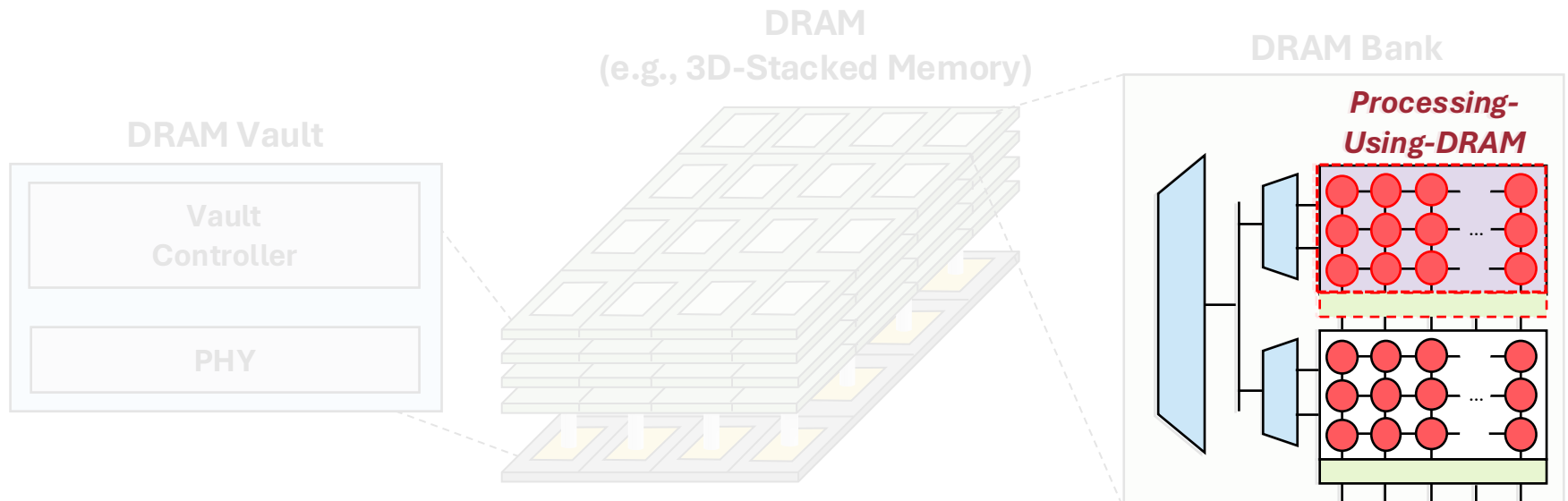
- Adapted PRAC solution incurs an average system performance overhead of **48.26%**

Processing-using-DRAM (PuD)

Multiple-row activation is a key technique to realize many PuD operations

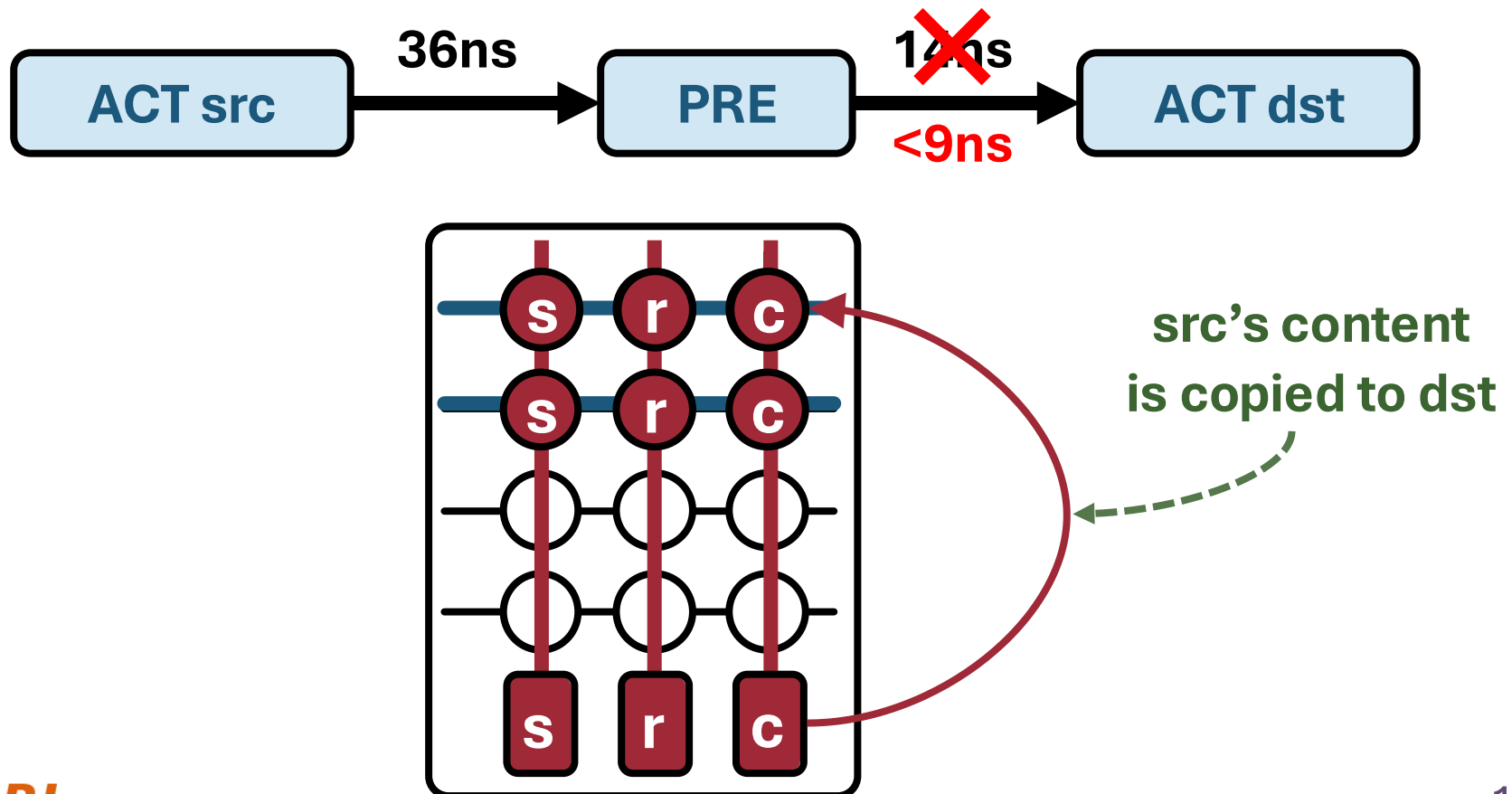
1. Consecutive Multiple-Row Activation (CoMRA)

2. Simultaneous Multiple-Row Activation (SiMRA)



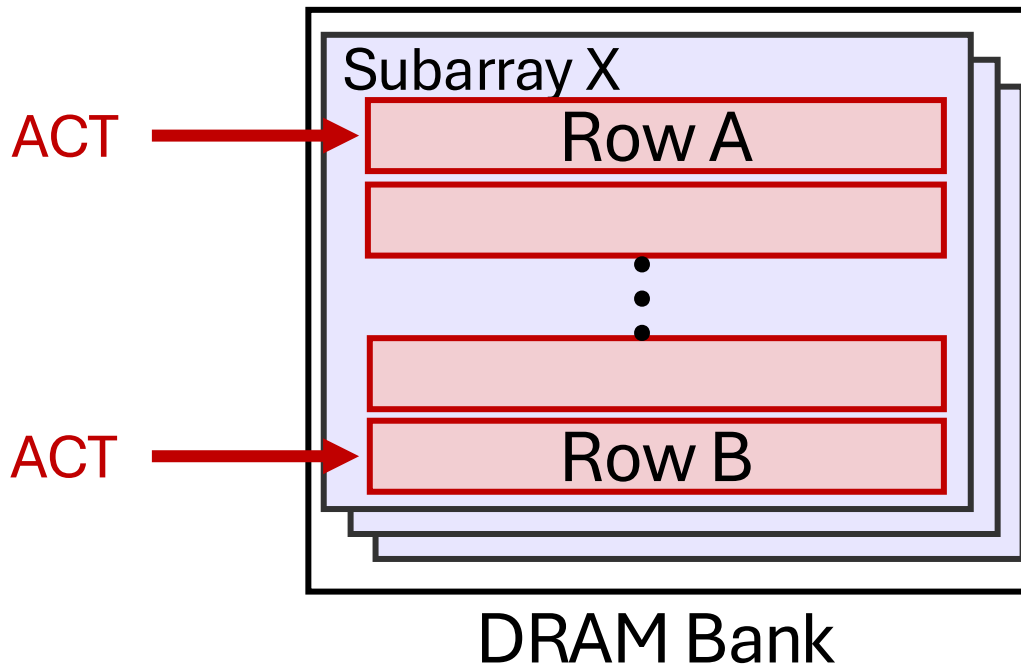
Consecutive Multiple-Row Activation

Violating timing of PRE command **greatly**
in **COTS** DRAM chips
activates two rows **consecutively**



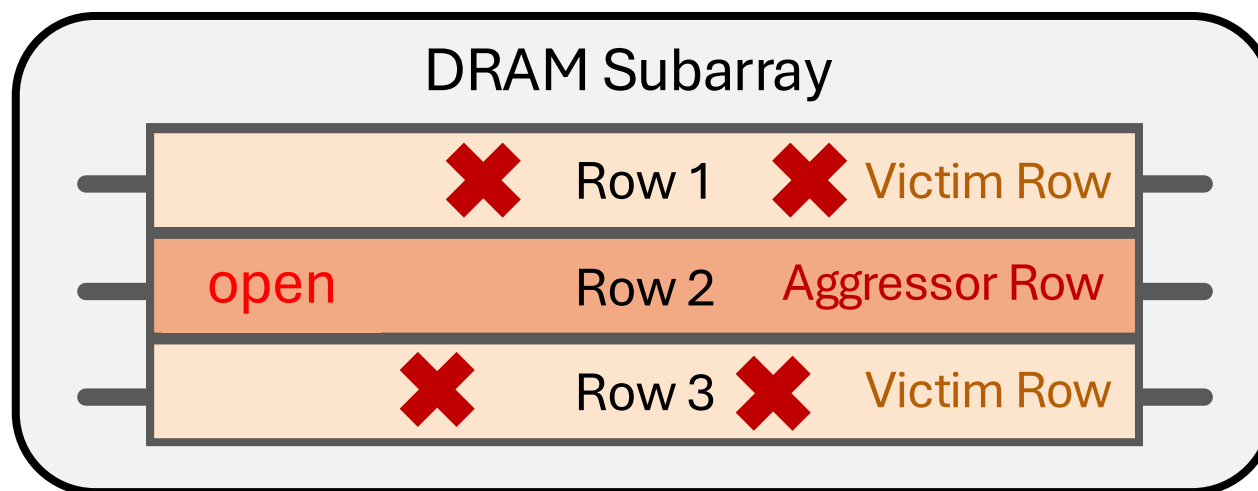
Simultaneous Multiple-Row Activation

Activating two rows in **quick succession** in **COTS** DRAM chips **simultaneously** activates **multiple rows** in a subarray



Read Disturbance in DRAM

- Unfortunately, even activating a **single DRAM row** **disturbs** the data integrity of other **unaccessed DRAM rows**
- Prominent example: **RowHammer**



Repeatedly **opening (activating)** and **closing** a DRAM row **many times** causes **RowHammer bitflips** in adjacent rows

Problem & Goal

Problem

*No prior work **investigates the read disturbance effects of multiple-row activation***

Goal

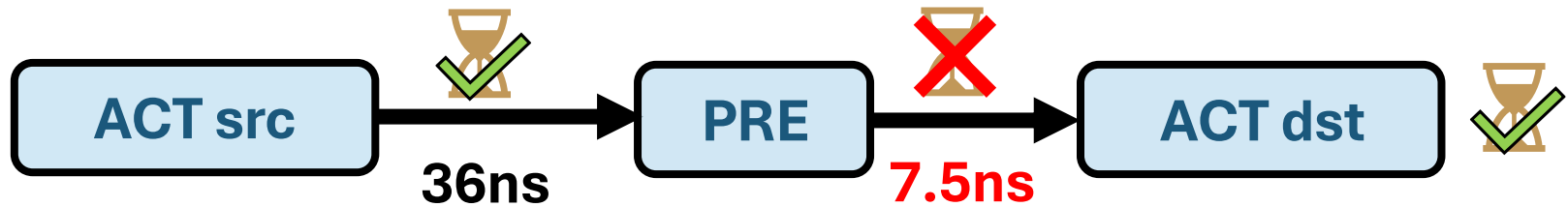
*Understand how **multiple-row activation affects read disturbance vulnerability in DRAM***

DRAM Chips Tested

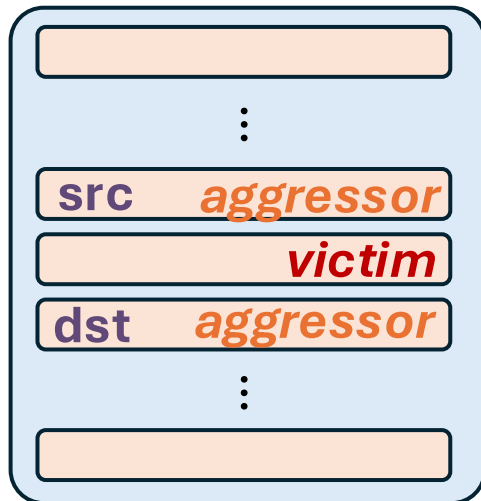
- 316 DDR4 chips from four major DRAM manufacturers
- Covers different die revisions and chip densities

Chip Mfr.	#Modules	#Chips	Die Rev.	Density	Org.
SK Hynix	1	8	A	4Gb	x8
	8	64	A	8Gb	x8
	2	16	C	16Gb	x8
	6	48	D	8Gb	x8
Micron	1	8	B	4Gb	x8
	4	32	E	16Gb	x16
	4	32	F	16Gb	x8
	2	16	R	8Gb	x8
Samsung	1	8	A	16Gb	x8
	5	40	B	16Gb	x8
	1	4	C	4Gb	x16
	1	8	C	16Gb	x8
	1	8	E	4Gb	x8
Nanya	3	24	C	8Gb	x8

Hammering with CoMRA

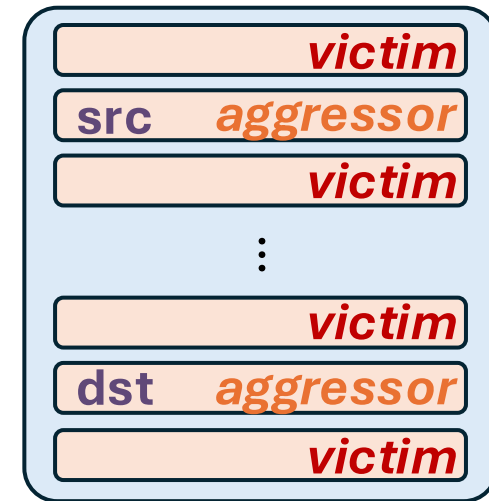


Double-Sided



DRAM Subarray

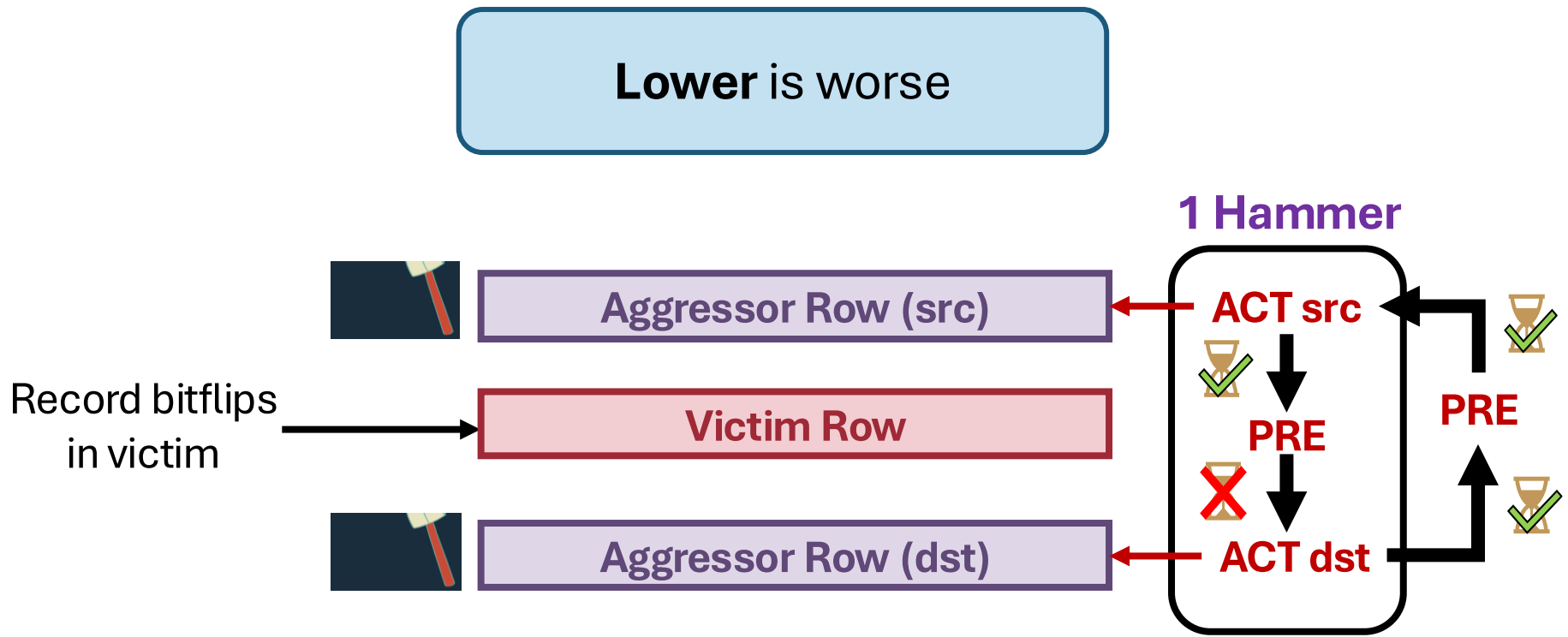
Single-Sided



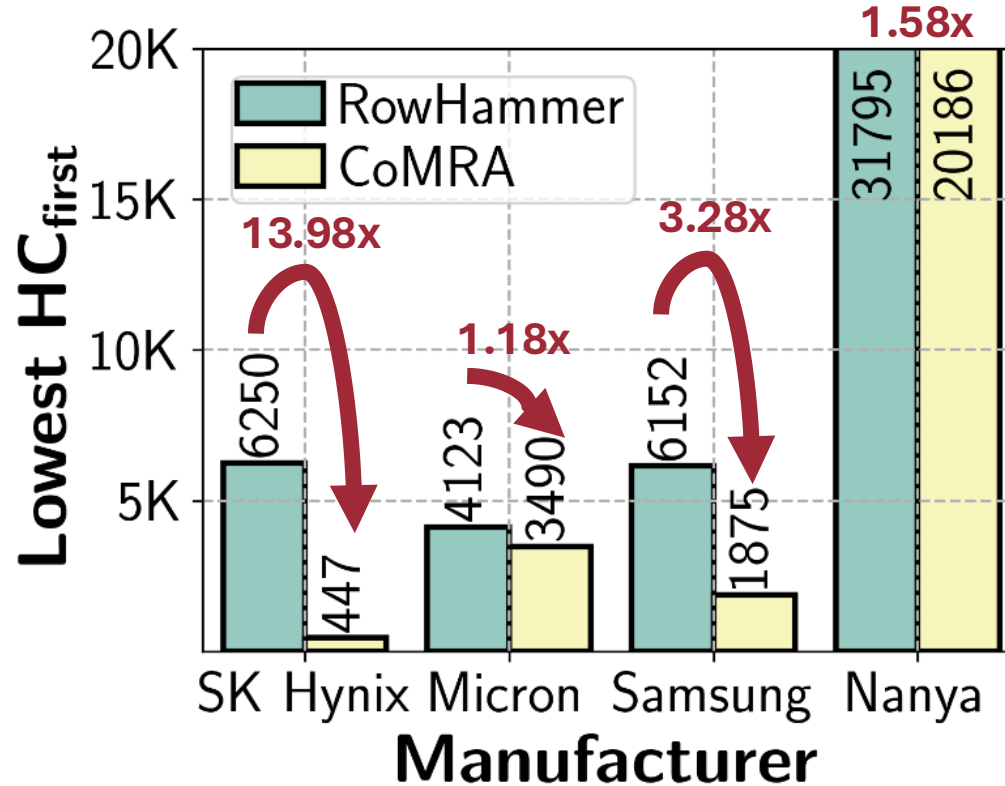
DRAM Subarray

Read Disturbance Vulnerability Metric: HC_{first}

The minimum hammer count
required to induce the **first bitflip**



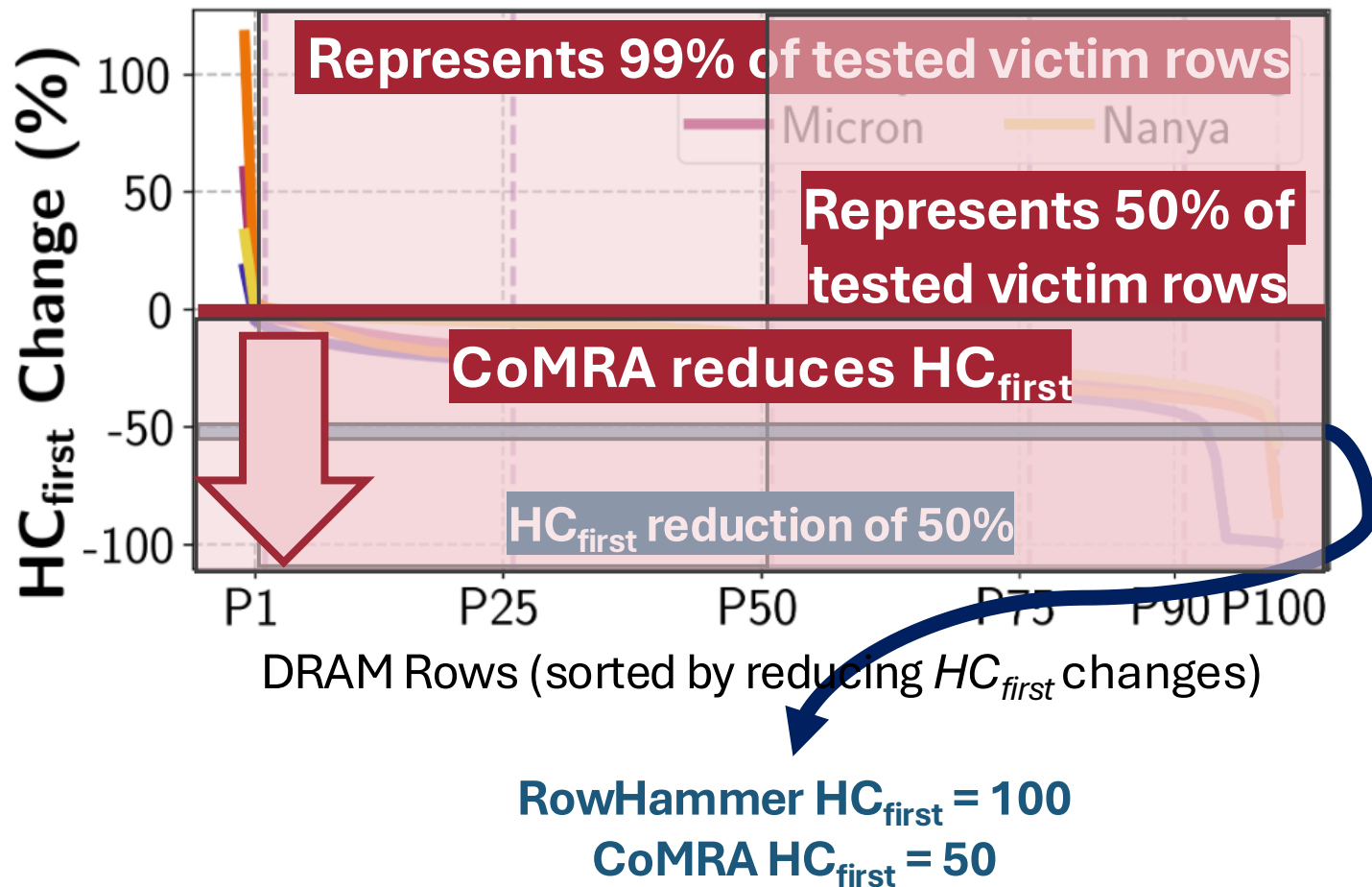
Double-Sided CoMRA vs. RowHammer (I)



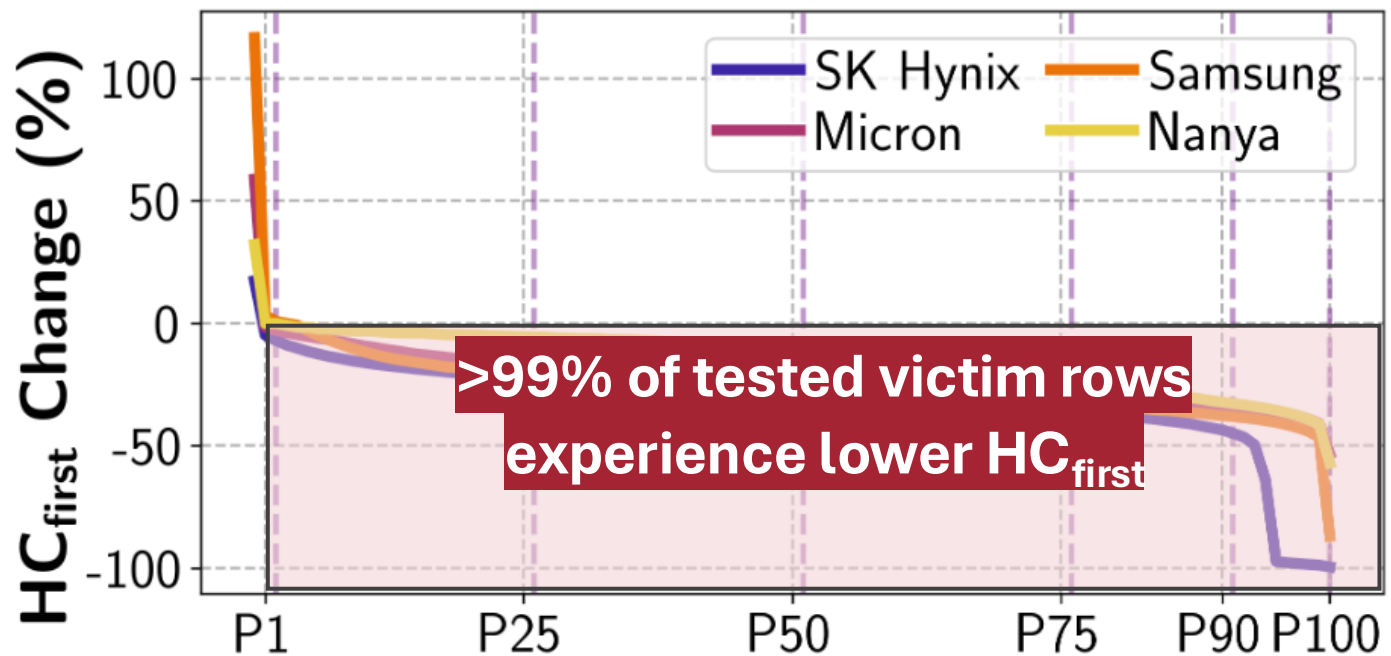
Double-sided CoMRA decreases **lowest HC_{first}** by **13.98x** compared to double-sided RowHammer

Lowest HC_{first} reduction trend consistent across all four manufacturer

Double-Sided CoMRA vs. RowHammer (II)



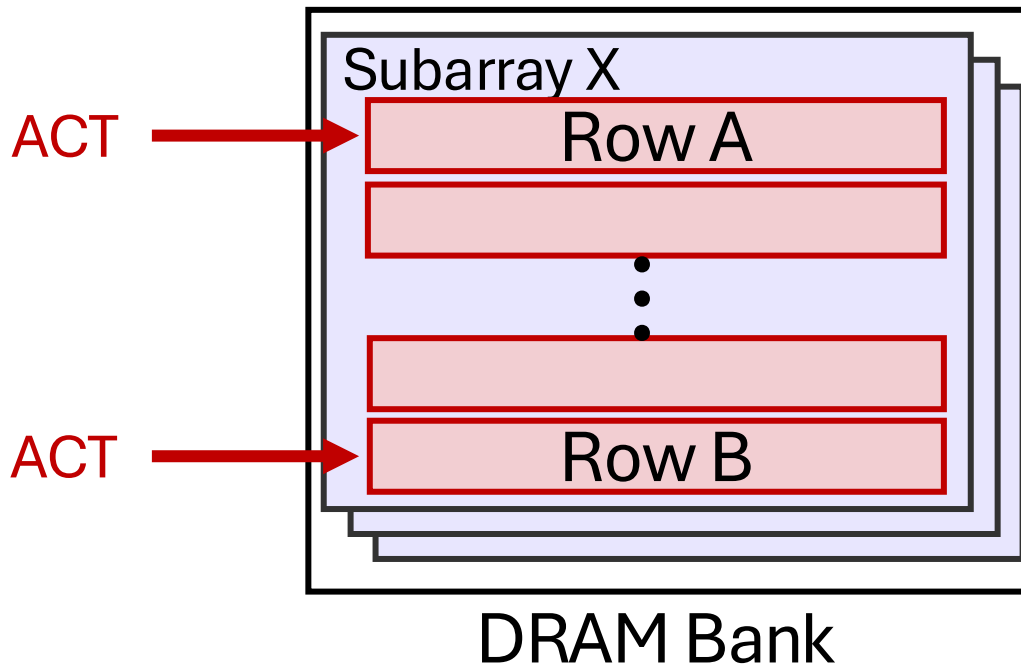
Double-Sided CoMRA vs. RowHammer (II)



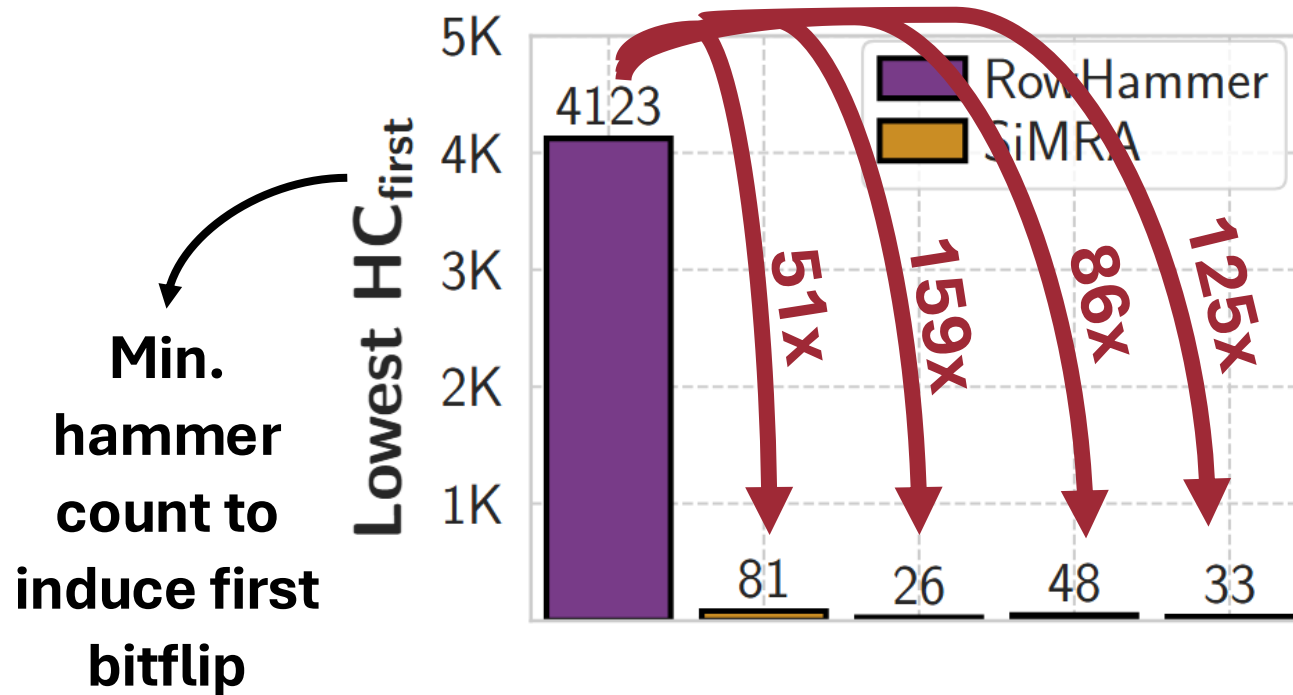
Double-sided CoMRA decreases HC_{first} for a large fraction of rows compared to double-sided RowHammer

Recall: SiMRA

Activating two rows in **quick succession** in **COTS** DRAM chips **simultaneously** activates **multiple rows** in a subarray



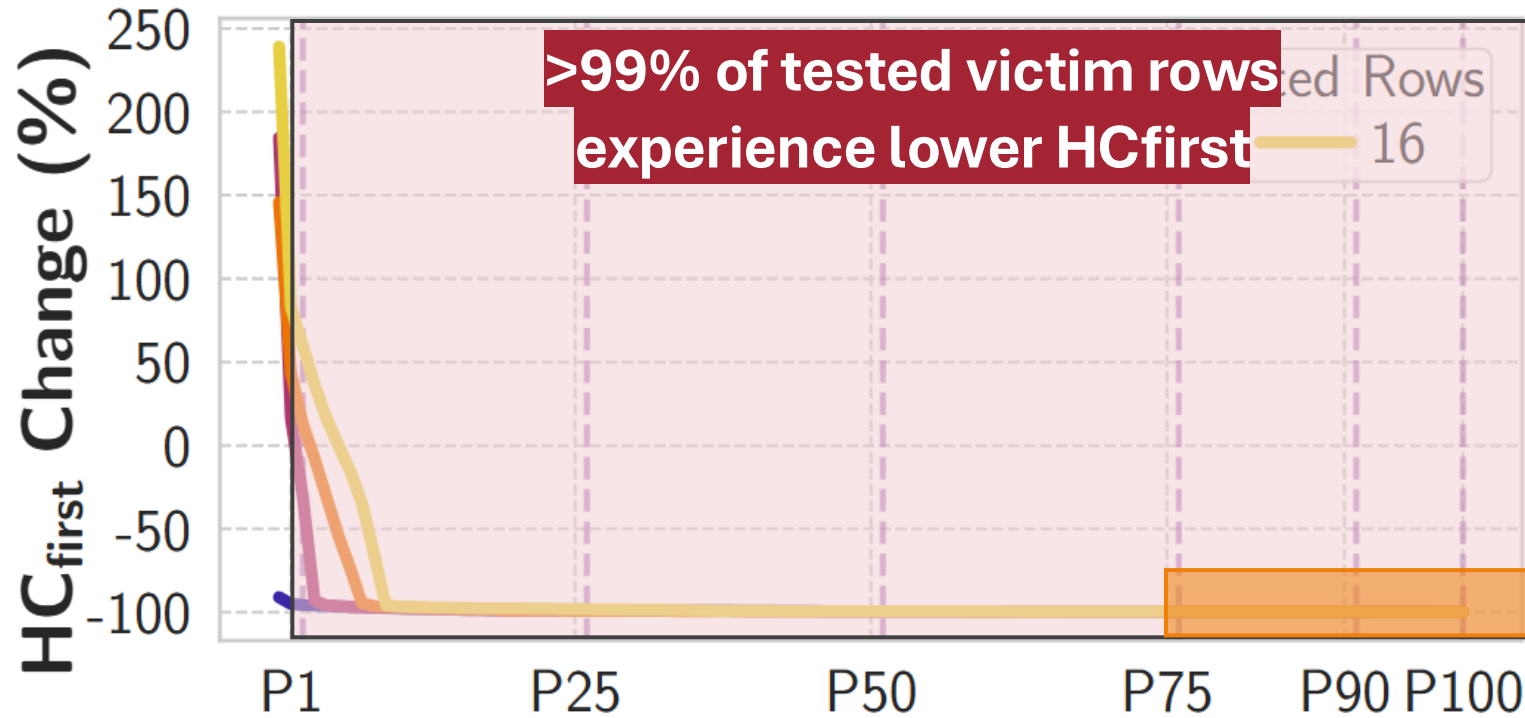
Double-Sided SiMRA vs. RowHammer (I)



Double-sided SiMRA decreases **lowest HC_{first}** by 159x compared to double-sided RowHammer

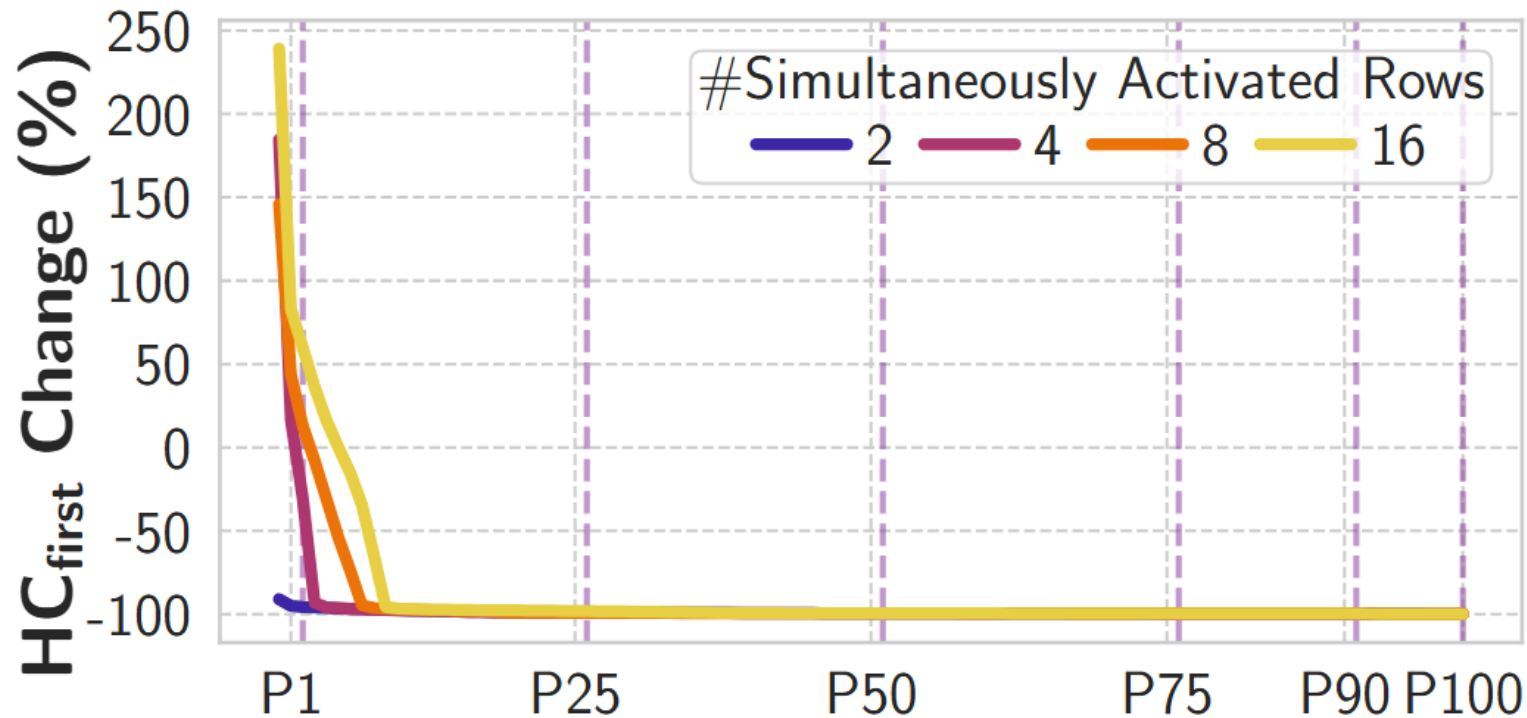
Lowest HC_{first} reduction trend consistent across all tested number of simultaneously activated rows

Double-Sided SiMRA vs. RowHammer (II)



at least 25.19%
of tested victim rows
experience >99% HC_{first} reduction

Double-Sided SiMRA vs. RowHammer (II)



Double-sided SiMRA
significantly decreases HC_{first} for a majority of rows
compared to double-sided RowHammer

Mitigating PuDHammer

1

Analyze the effectiveness of existing in-DRAM RowHammer mitigation against PuDHammer

2

Adapt RowHammer mitigations to account for PuDHammer

Mitigating PuDHammer

1

Analyze the effectiveness of existing in-DRAM RowHammer mitigation against PuDHammer

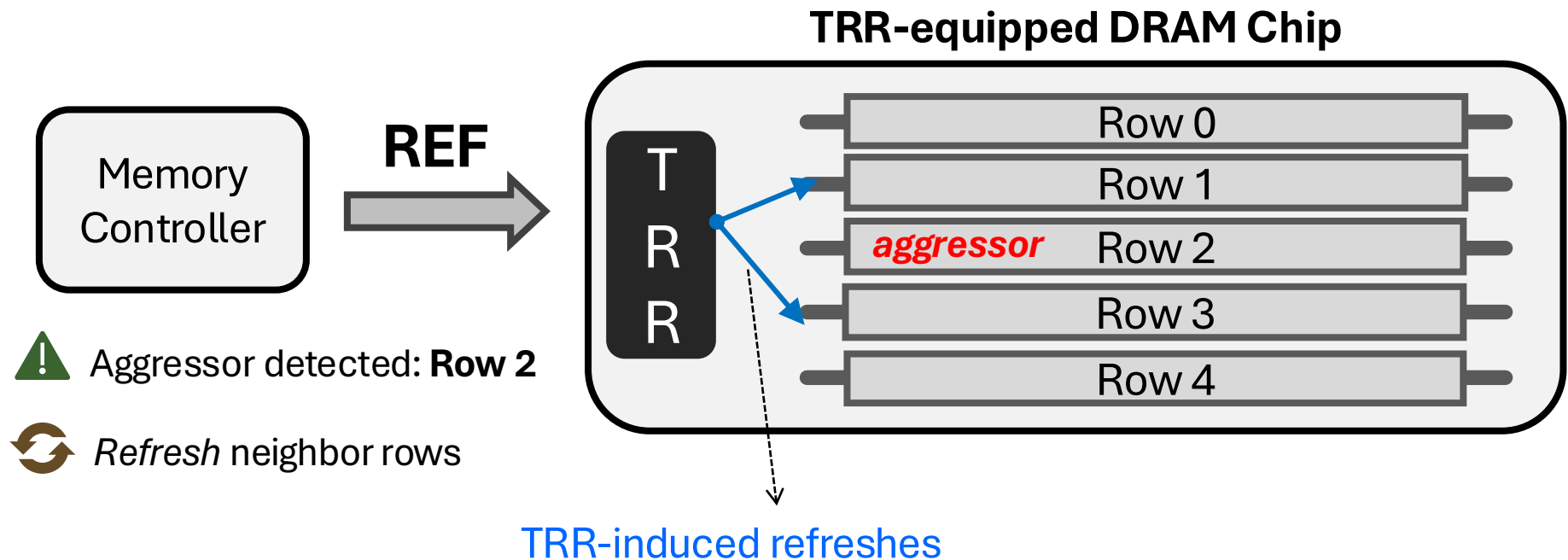
2

Adapt RowHammer mitigations to account for PuDHammer

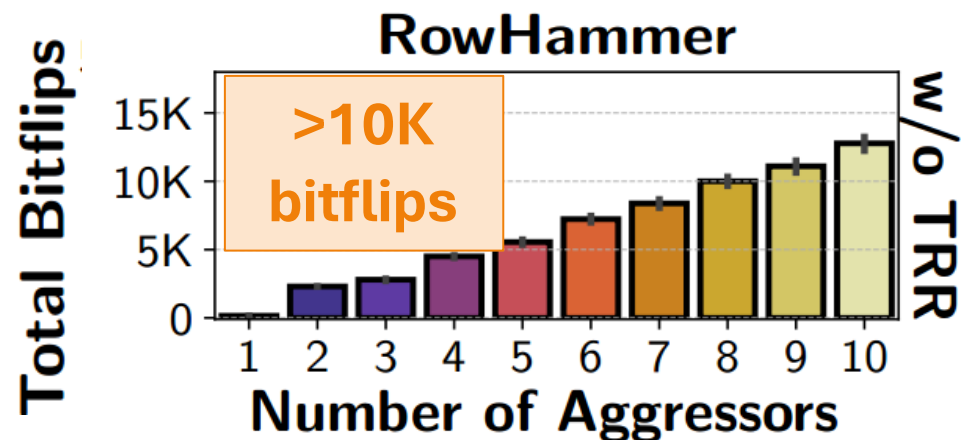
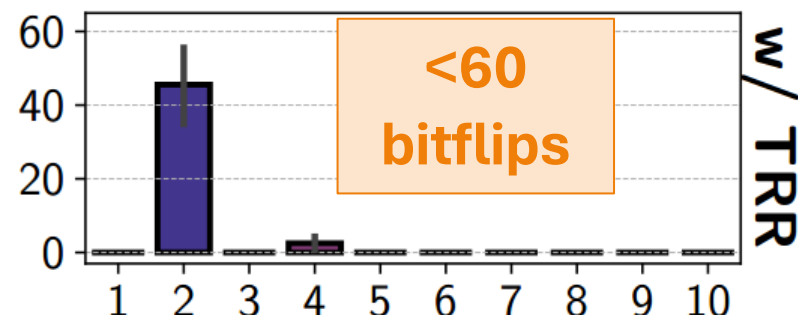
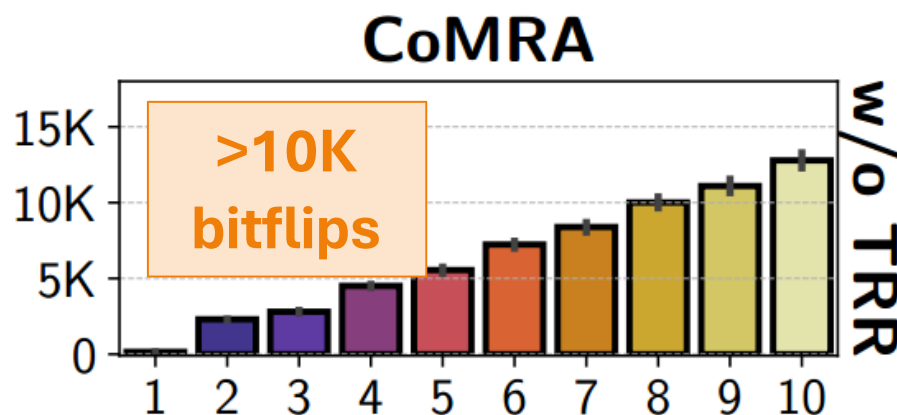
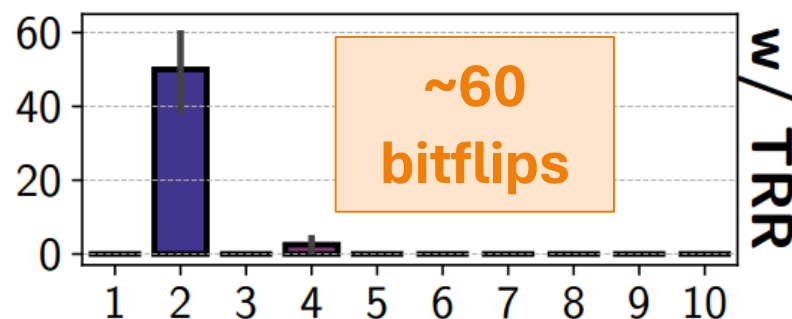
Target Row Refresh (TRR)

DRAM vendors equip their DRAM chips with a *proprietary* mitigation mechanisms known as **Target Row Refresh (TRR)**

Key Idea: TRR refreshes nearby rows upon detecting an aggressor row



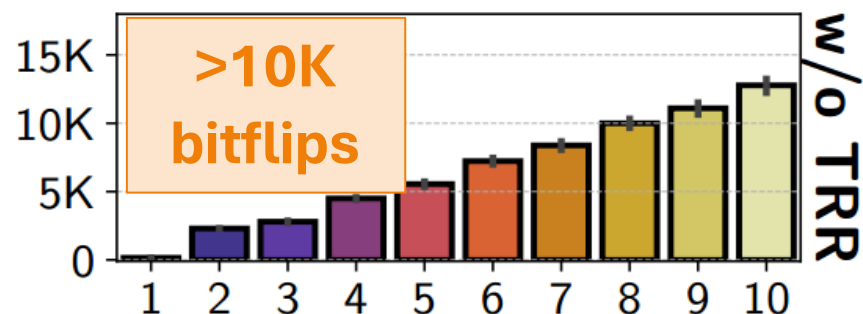
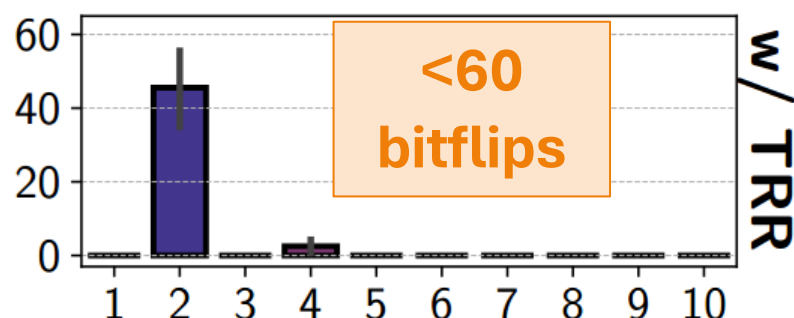
Real DRAM Chip Results



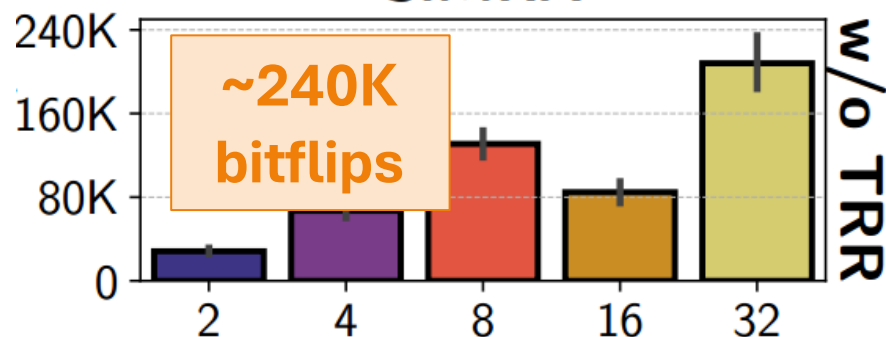
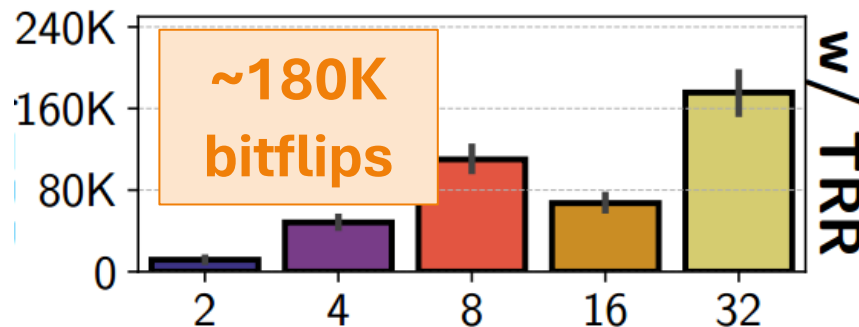
CoMRA induces 1.10x more bitflips than RowHammer on average in the presence of TRR

Real DRAM Chip Results

RowHammer



SiMRA



SiMRA induces 11340x more bitflips than RowHammer on average in the presence of TRR

Mitigating PuDHammer

1

Analyze the effectiveness of existing in-DRAM RowHammer mitigation against PuDHammer

2

**Adapt RowHammer mitigations
to account for PuDHammer**

A Naïve Approach (PRAC-Naïve)

*Reducing RowHammer threshold
to SiMRA's lowest observed HCfirst*

Weighted Counting (PRAC-WC)

*Increase counters based on the vulnerability
caused by the operation (RH, CoMRA, and SiMRA)*

Methodology

- **Environment:** Cycle-level DRAM simulator **Ramulator2** [Kim+ CAL'15, Luo+ CAL'23]

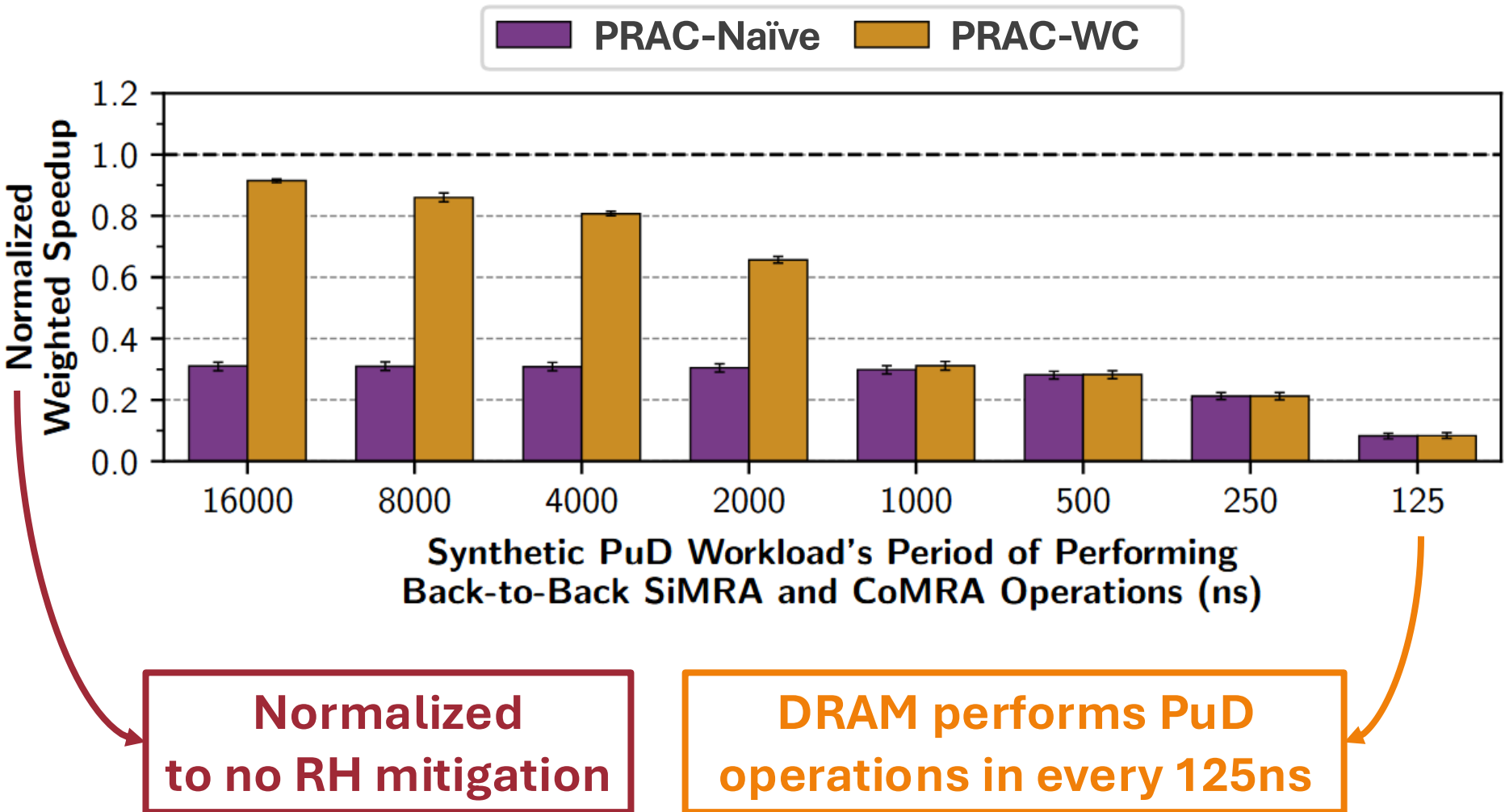
- **System Configuration:**

Processor	4-core, out-of-order, 4.2GHz clock frequency
DRAM	DDR5, 1 channel, 2 rank/channel, 8 bank groups, 4 banks/bank group, 128K rows/bank
Memory Ctrl.	64-entry read and write requests queues, Scheduling policy: FR-FCFS with a column cap of 4
PRAC	4 RFMs per Back-off
PIM Unit	1-core, issues CoMRA & SiMRA operations with a fixed interval

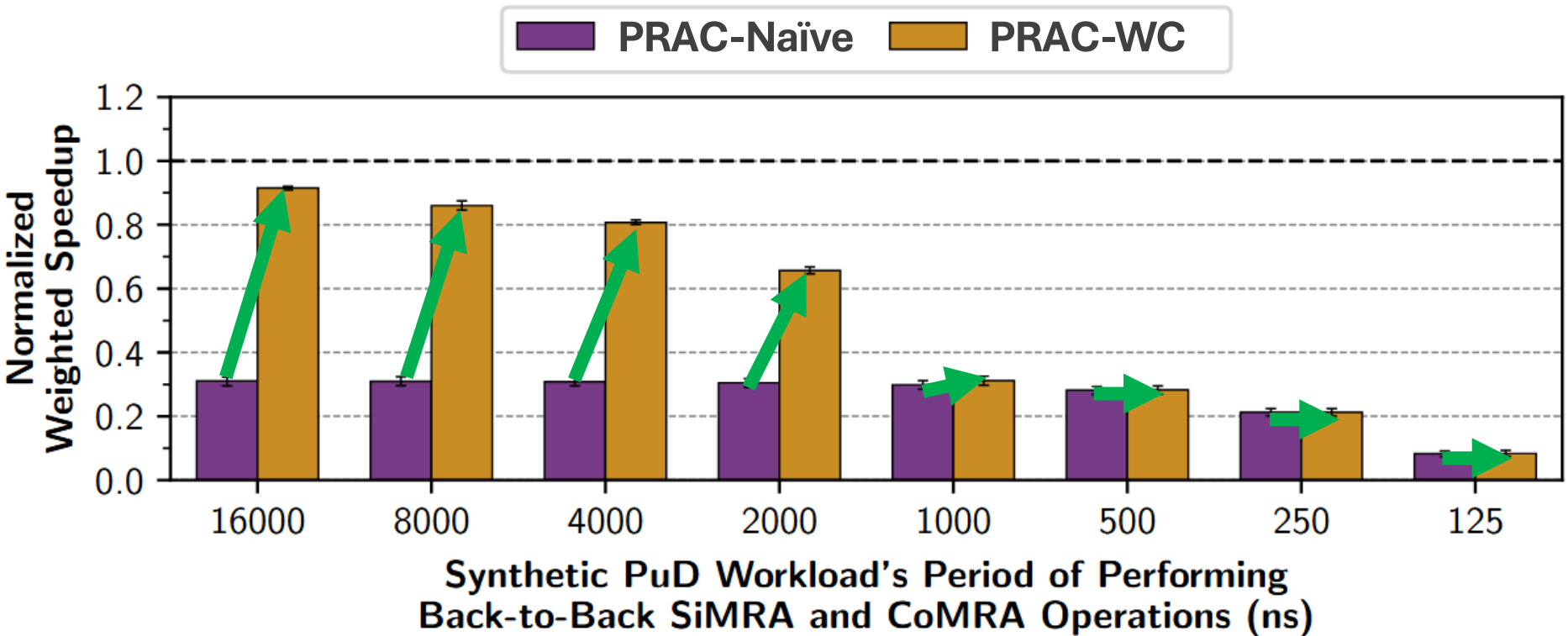
- **Workloads:**

- 60 five-core multiprogrammed workload mixes.
- Each mix is composed of
 - four workloads from five major benchmark suites and
 - one synthetic workload that periodically performs back-to-back one SiMRA with 32-row activation and one CoMRA operation

Weighted Speedup Results



Weighted Speedup Results



PRAC-WC greatly outperforms PRAC-Naïve until 2us

PRAC-WC incurs an average (maximum) performance overhead of 48.26% (98.83%)

More in the Paper

- **More characterization results**

- Temperature, spatial variation, timing parameters, access pattern, data pattern, aggressor row on time analyses for CoMRA and SiMRA
- Combined Read Disturbance Effect of RowHammer with PuD
 - Combined pattern is more effective than RowHammer alone (e.g., 1.66x reduction in HCfirst on average)

- **Details and analyses on mitigating PuDHammer**

- Discussion on how modifying DRAM chips could help mitigating PuDHammer
- More details on PRAC adaptation
 - Challenges on adapting for PuDHammer
 - An area-efficient PRAC solution
 - ..

PuDHammer: Experimental Analysis of Read Disturbance Effects of Processing-using-DRAM in Real DRAM Chips

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Processing-using-DRAM (PuD) is a promising paradigm for alleviating the data movement bottleneck using a DRAM array's massive internal parallelism and bandwidth to execute very wide data-parallel operations. Performing a PuD operation involves activating multiple DRAM rows in quick succession or simultaneously, i.e., multiple-row activation. Multiple-row activation is fundamentally different from conventional memory access patterns that activate one DRAM row at a time. However, repeatedly activating even one DRAM row (e.g., RowHammer) can induce bitflips in unaccessed DRAM rows because modern DRAM is subject to read disturbance, a worsening safety, security, and reliability issue. Unfortunately, no prior work investigates the effects of multiple-row activation, as commonly used by PuD operations, on DRAM read disturbance.

In this paper, we present the first characterization study of read disturbance effects of multiple-row activation-based PuD (which we call PuDHammer) using 316 real DDR4 DRAM chips from four major DRAM manufacturers. Our detailed characterization results covering various operational conditions and parameters (i.e., temperature, data patterns, access patterns, timing parameters,

CPU and GPU) [1, 2]. Unfortunately, this data movement is a major bottleneck that consumes a large fraction of execution time and energy in many modern applications [1–28]. Processing-using-DRAM (PuD) [29–34] is a promising paradigm that can alleviate the data movement bottleneck. PuD uses the analog operational properties of the DRAM array circuitry to enable massively parallel in-DRAM computation (i.e., PuD operations), which can be used to accelerate important applications including databases and web search [29, 30, 32, 35–43], data analytics [29, 44–48], graph processing [32, 48–51], genome analysis [52–57], cryptography [58, 59], hyper-dimensional computing [60–62], and generative AI [63–72].

*A wide variety of PuD operations (e.g., in-DRAM data copy and bulk bitwise operations) rely on a key PuD technique called *multiple-row activation*, which accesses (activates) multiple DRAM rows in quick succession or simultaneously [29–32, 40, 73–84]. Multiple-row activation is fundamentally different from conventional DRAM operations that access only a *single* DRAM row at a time.*

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